

# AirPrime RC76xx

# **Product Technical Specification**



41113440 Rev 4.0

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## Revision History

Revision Number	Release Date	Changes	
1.0	November 08, 2019	Creation	
2.0	January 03, 2020	Baseband and other software-related modifications	
2.1	January 22, 2020	<ul> <li>Modify the current consumption from 15uA to TBD</li> <li>Added FCC ID</li> </ul>	
2.2	February 05, 2020	Updated Transmit Band and Receive Band columns in Table 1-3 on page 12 Removed SDIO information Changed PSM mode values to TBD on Table 3-9 on page 35	
3.0	June 22, 2020	Updates on Functional Specifications, Technical Specifications, Interface Details, Routing Constraints and Recommendations, Pinout, and Acronyms	
3.1	July 06, 2020	Minor edits on Table 1-3	
3.2	July 07, 2020	Updated Figure 3-4 and Figure 3-5	
4.0	September 01, 2020	<ul> <li>Updates on Functional Specifications, Technical Specifications, Interface Details, Routing Constraints and Recommendations, Pad, and Acronyms</li> <li>Added RC7630 specifications</li> <li>Added Japan Regulatory approval</li> </ul>	



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## >> 1: Introduction

This document defines the high-level product features and illustrates the interfaces for the AirPrime RC76xx Embedded Modules. It covers the hardware aspects of the product series, including electrical and mechanical.

### 1.1 General Features

The AirPrime R76xx is an industrial-grade LGA 239-pad embedded module. Its wireless modem provides voice and data connectivity on the networks listed in Table 1-1.

Table 1-1: Supported Networks and Voice Capability

Variant	Network	Network Voice Support	LTE Category
RC7611	LTE	VoLTE	Cat4
RC7611-1	LIE	VOLTE	Cat1
RC7620	LTE	Circuit switch voice	Cat4
RC7620-1	UMTS (DC-HSPA+, HSPA+, HSPA, WCDMA) GSM/GPRS/EDGE	+ VoLTE	Cat1
RC7630	LTE	VoLTE	Cat4
RC7630-1	VOLTE		Cat1

To simplify cellular connectivity, the AirPrime RC76xx has been designed to support Ready-To-Connect, and an embedded SIM (eSIM) has been natively designed in the module for this purpose. To learn more about Ready-To-Connect capabilities and to know which variant already supports this feature, please get in touch with your Sierra Wireless sales representative.

GNSS functionality is available as a SKU-dependent feature.

In addition to modem features, the AirPrime RC76xx embeds several cores for maximum flexibility and security for embedded software execution, including:

A Telecom Core that natively manages 4G modem features

The following tables detail supported RF bands/connectivity.

Table 1-2: RC7611 and RC7611-1 Supported Bands/Connectivity

Technology	RF Band	Transmit Band (Tx) (MHz)	Receive Band (Rx) (MHz)	Notes
	B2	1850–1910	1930–1990	
	B4	1710–1755	2110–2155	-
	B5	824–849	869–894	
	B12	699–716	729–746	
1.75	B13	777–787	746–756	MIMO <sup>a</sup> and
LTE	B14	788–798	758–768	diversity
	B25	1850–1915	1930–1995	-
	B26	814–849	859–894	
	B66	1710–1780	2110-2200	-
	B71	663–698	617–652	1
	GPS		1575.42 ± 1.023	
GNSS <sup>b</sup>	GLONASS		1597.52–1605.92	
GINOO	Galileo		1575.42 ± 2.046	
	BeiDou		1561.098 ± 2.046	

a. Downlink MIMO 2x2b. GNSS support is SKU-dependent.

Table 1-3: RC7620 and RC7620-1 Supported Bands/Connectivity

Technology	RF Band	Transmit Band (Tx) (MHz)	Receive Band (Rx) (MHz)	Notes
	B1	1920–1980	2110–2170	
	В3	1710–1785	1805–1880	-
LTE	B7	2500–2570	2620–2690	MIMO <sup>a</sup> and diversity
LTE	B8	880–915	925–960	uiversity
	B20	832–862	791–821	-
	B28	703–748	758–803	-
LIMTO	B1	1920 – 1980	2110–2170	D: '1
UMTS	B8	880–915	925–960	Diversity
GSM/GPRS/EDGE	E-GSM 900	880–915	925–960	
GSW/GPRS/EDGE	DCS 1800	1710–1785	1805–1880	
	GPS		1575.42 ± 1.023	
GNSS <sup>b</sup>	GLONASS		1597.52–1605.92	
GNOO	Galileo		1575.42 ± 2.046	
	BeiDou		1561.098 ± 2.046	

a. Downlink MIMO 2x2b. GNSS support is SKU-dependent.

Table 1-4: RC7630 and RC7630-1 Supported Bands/Connectivity

Technology	RF Band	Transmit Band (Tx) (MHz)	Receive Band (Rx) (MHz)	Notes
	B1	1920–1980	2110–2170	
	В3	1710–1785	1805–1880	
	B5	824-849	869–894	NAINA OR THE
LTE	B7	2500–2570	2620-2690	MIMO <sup>a</sup> and diversity
LTE	B8	880–915	925–960	
	B18	815–830	860-875	
	B19	830-845	875–890	
	B21	1447.9–1462.9	1495.9–1510.9	
	GPS		1575.42 ± 1.023	
	GLONASS		1597.52–1605.92	
GNSS <sup>b</sup>	Galileo		1575.42 ± 2.046	
	BeiDou		1561.098 ± 2.046	
	QZSS		1575.42 ± 2.046	

a. Downlink MIMO 2x2b. GNSS support is SKU-dependent.

### 1.2 Interfaces

The AirPrime RC76xx provides the following interfaces and peripheral connectivity:

- UIM interface See UIM Interface on page 69.
  - eSIM See eSIM / UIM2 Interface on page 70.
- VBAT\_RF/VBAT\_BB power supply See Power Supply Ratings on page 24.
- RF See RF on page 39.
- GNSS (RF\_GNSS) See GNSS on page 49.
- ON/OFF control:
  - POWER ON N—See POWER ON N on page 63.
  - Reset signals See Reset Signals (RESET\_IN\_N and RESET\_OUT\_N) on page 78.
- USB 2.0 See USB on page 67.
- UART serial links See UART on page 68.
- GPIOs See General Purpose Input/Output (GPIO) on page 72.
- I<sup>2</sup>C See I2C Interface on page 75.
- 1.8V voltage reference See VGPIO on page 77.
- ADCs See ADC on page 79.
- Digital audio (PCM/I<sup>2</sup>S) See Digital Audio on page 79.
- SPI bus See SPI Bus on page 83.
- Antenna control See Antenna Control on page 88.
- System clock outputs See Clock on page 85.
- Test pins See Test Pins on page 88.
- Tx Activity Indicator (TX\_ON) See Tx Activity Indicator (TX\_ON) on page 89.

## 1.3 Common Flexible Form Factor (CF3)

The AirPrime RC76xx belongs to the Common Flexible Form Factor (CF3) family of WWAN modules. These modules share the same mechanical dimensions (same width and length with varying thicknesses) and footprint. The CF3 form factor provides a unique solution to a series of problems faced commonly in the WWAN module space as it:

- · Accommodates multiple radio technologies and band groupings
- Supports bit-pipe (Essential Module Series) and value-add (Smart Module Series) solutions
- Offers electrical and functional compatibility

# 1.4 Physical Dimensions and Connection Interface

The AirPrime RC76xx module is a compact, robust, fully shielded and labeled (laser-etched) module with the dimensions noted in Table 1-5.

Table 1-5: Module Dimensions<sup>a</sup>

Parameter	Nominal	Tolerance	Units
Length	23.00	±0.10	mm
Width	22.00	±0.10	mm

Table 1-5: Module Dimensions<sup>a</sup>

Parameter	Nominal	Tolerance	Units
Thickness	2.50	±0.20	mm
Weight	2.6	±1.0	g

a. Dimensions are accurate as of the release date of this document.

The AirPrime RC76xx module is an LGA form factor device. All electrical and mechanical connections are made through the 238 Land Grid Array (LGA) pads on the bottom side of the PCB. (See Figure 10-1 on page 122 for details.)

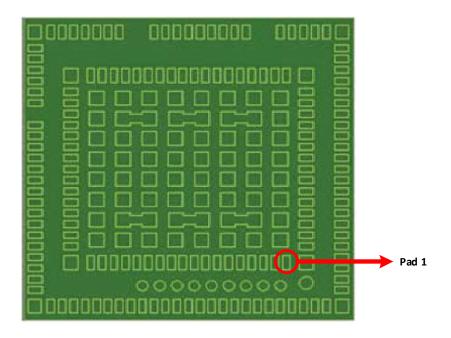


Figure 1-1: RC series module bottom view

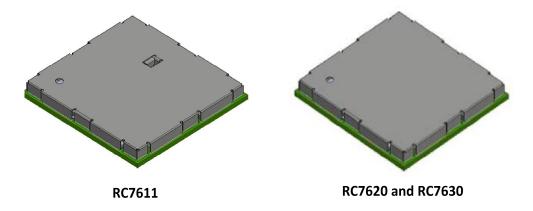


Figure 1-2: RC76 Series Shield View

The 239 pads have the following distribution:

Table 1-6: LGA Pad Types

Pad Type/Quantity		Dimensions	Pitch
Signal Pads	66 inner pads	1.0x0.5 mm	0.8 mm
Signal Faus	91 outer pads	1.0x0.3 11111	
Test Points 9 test points		0.8 mm (diameter)	1.20 mm
	64 inner pads	1.0x1.0 mm	1.83 mm/1.48 mm
Ground Pads	4 inner corner pads	1.0x1.0 mm	-
	4 outer corner pads	1.0x0.9 mm	-
Polarity Mark 1 polarity mark (Ground)		1.0 mm (diameter)	-

## >> 2: Functional Specifications

## 2.1 Architecture

The following figure presents an overview of the AirPrime RC76xx module's internal architecture and external interfaces.

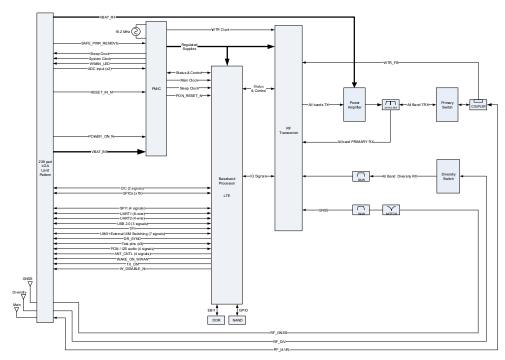


Figure 2-1: RC7611 and RC7630 Architecture Overview

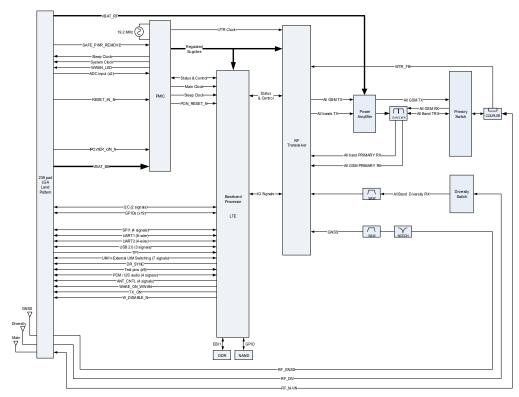


Figure 2-2: RC7620 Architecture Overview

## 2.2 Telecom Features

Table 2-1 summarizes the AirPrime RC76xx module's capabilities offered through the Telecom core.

Table 2-1: Module Capabilities

Feature	Description		
Electrical	<ul> <li>3.4–4.3V supply voltage (VBAT_BB, VBAT_RF):</li> <li>Single supply, VBAT_BB tied to VBAT_RF or</li> <li>Dual supplies, single supply each for VBAT_BB and VBAT_RF</li> </ul>		
Voice (Digital Audio)	<ul> <li>PCM/I<sup>2</sup>S digital audio interface</li> <li>Supports Enhanced Full Rate (EFR), Full Rate (FR), Half Rate (HR), and both Narrow-Band and Wide-band Adaptive Multirate (AMR-NB and AMR-WB) vocoders</li> <li>MO and MT calling</li> <li>Echo cancellation and noise reduction</li> <li>Emergency calls (112, 110, 911, etc.)</li> <li>Incoming call notification</li> <li>DTMF generation</li> <li>Internal codec driver for WM8944</li> </ul>		
SMS	<ul> <li>SMS MO and MT</li> <li>CS and PS support</li> <li>SMS saving to UIM card or ME storage</li> <li>SMS reading from UIM card or ME storage</li> <li>SMS sorting</li> <li>SMS concatenation</li> <li>SMS Status Report</li> <li>SMS replacement support</li> <li>SMS storing rules (support of AT+CNMI, AT+CNMA)</li> </ul>		
Supplementary services	<ul> <li>Call Barring</li> <li>Call Forwarding</li> <li>Call Hold</li> <li>Caller ID</li> <li>Call Waiting</li> <li>Multi-party service</li> <li>USSD</li> <li>Automatic answer</li> </ul>		

## 2.2.1 Network Technology Specifications

## 2.2.1.1 LTE Specifications

The following table describes LTE specifications for AirPrime RC76xx modules.

Table 2-2: Supported LTE Specifications

Standard	Feature Description		
R13	<ul> <li>eDRX (Extended Discontinuous Reception) to extend battery life in devices that do not require frequent network access</li> <li>PSM (Power Saving Mode) to reduce power consumption</li> </ul>		
R10	<ul> <li>Release 10 mandatory LTE features</li> <li>Data rates: <ul> <li>RC7611-1—Cat 1 FDD (up to 10 Mbps downlink, 5 Mbps uplink)</li> <li>RC7611—Cat 4 FDD (up to 150 Mbps downlink, 50 Mbps uplink)</li> </ul> </li> <li>1.4 MHz, 3 MHz, 5 MHz, 10 MHz, 15 MHz and 20 MHz RF bandwidth</li> <li>IPv6, QoS</li> <li>NAS &amp; RRC standalone security</li> <li>Commercial Mobile Alert System (CMAS)</li> <li>ETWS (Earthquake Tsunami Warning System) notification</li> <li>Inter-frequency/bandwidth mobility</li> <li>DRX cycle while in: <ul> <li>Connected mode</li> <li>Idle mode</li> </ul> </li> <li>UE IRAT support for Self Organizing Networks and Automatic Neighbor Relation (SON AR)</li> </ul>		
System Determination	<ul> <li>Frequency Scan and System Selection within LTE</li> <li>LTE BPLMN support</li> <li>LTE Connected mode OOS</li> <li>System selection across RATs, Standalone Security, Dedicated EPS Bearer Management and Dormancy</li> <li>256 UPLMN and 256 OPLMN entries in UIM support</li> <li>Carrier Specific BSR Requirements</li> </ul>		
Data	<ul> <li>Data call throttling</li> <li>Default IPv4 bearer activation at attach/IPv4 data call</li> <li>NW and UE initiated QoS</li> <li>Dual IP and IPv4/IPv6 continuity</li> <li>IPv4/IPv6 session continuity</li> <li>W/G IP session continuity</li> <li>Emergency services—LTE NAS Support for Control Plane LTE Positioning Protocol</li> </ul>		

## 2.2.1.2 GSM/GPRS/EDGE Specifications

The following table describes GSM/GPRS/EDGE specifications for AirPrime RC7620 modules.

Table 2-3: Supported GSM Specifications

Standard	Feature Description		
GPRS	Packet-switched data:  DTM (simple class A) operation  GPRS Multislot class 10 (with backoff <sup>a</sup> )—Four Rx slots (maximum), two Tx slots (maximum), five active slots total  Coding schemes—CS1–CS4  GEA1, GEA2, and GEA3 ciphering  WCDMA/GERAN system selection		
EDGE	<ul> <li>E2 power class for 8 PSK</li> <li>DTM (simple class A), multislot class 12</li> <li>EGPRS—Multislot class 12 (with backoff<sup>a</sup>)—Four Rx slots (maximum), four Tx slots (maximum), five active slots total</li> <li>Coding schemes—MCS1–MCS9</li> <li>BEP reporting</li> <li>SRB loopback and test modes A and B</li> <li>8-bit and 11-bit RACH</li> <li>PBCCH support</li> <li>One-phase/two-phase access procedures</li> <li>Link adaptation and IR</li> <li>NACC, extended UL TBF</li> <li>PFC/PFI (Packet Flow Context/Packet Flow Identifier) support - allows identity tagging of RLC blocks to identify separate QoS streams at the radio link layer</li> <li>GPRS/EDGE MSC12-EDA - permits allocation of more than two uplink timeslots for GPRS/EDGE</li> <li>Enh DL RLC/MAC Segmentation - permits reception of MAC control messages that exceed one radio block capacity in length</li> <li>Enhanced Ext UL TBF - dummy block transmission is punctured for current saving purposes</li> <li>2G PS handover - packet-switched equivalent of CS handover to ensure faster cell change and improved throughput</li> <li>WCDMA/GERAN</li> <li>Band Scan: Run-time Configurable RRC Band Scan Order</li> <li>Power and Network Optimizations: Frame Early Termination for Power Optimization</li> <li>Protocols: MRAB-Pack-1 Enhancements - reduces multi-RAB call drops</li> <li>GPRS/EDGE - Class 33 (296 kbps downlink, 236.8 kbps uplink)</li> <li>CSD (Circuit-switched data bearers)</li> <li>Release 4 GERAN Feature Package 1</li> <li>SAIC / DARP Phase 1</li> </ul>		

Table 2-3: Supported GSM Specifications (Continued)

Standard	Feature Description		
EDGE	<ul> <li>Latency reduction</li> <li>Repeated FACCH, Repeated SACCH</li> <li>A-GPS support</li> <li>GPRS ROHC</li> <li>Enhanced Operator Name String (EONS)</li> <li>Enhanced Network Selection (ENS)</li> </ul>		

a. Backoff is firmware dependent. 2G power backoff level is 3dB at the maximum power level as per 3GPP standards.

## 2.2.1.3 WCDMA Specifications

The following table describes WCDMA specifications for AirPrime RC7620 modules.

Table 2-4: Supported WCDMA Specification

Standard	Feature Description		
R99	<ul> <li>All modes and data rates for WCDMA FDD, with the following restrictions:</li> <li>The downlink supports the following specifications:</li> <li>Up to four physical channels, including the broadcast channel (BCH), if present</li> <li>Up to three dedicated physical channels (DPCHs)</li> <li>Spreading factor (SF) range support from 4 to 256</li> <li>The uplink supports the following specifications:         <ul> <li>One physical channel, eight TrCH, and 16 TrBks starting at any frame boundary</li> <li>A maximum data rate of 384 kbps</li> <li>Full SF range support from 4 to 256</li> </ul> </li> <li>PS data rates of 384 kbps DL and 384 kbps UL</li> </ul>		
R8 HSDPA	<ul> <li>PS data speeds up to 42 Mbps (UE category 24) on the downlink</li> <li>HS-DSCH (HS-SCCH, HS-PDSCH, and HS-DPCCH)</li> <li>Maximum of 15 HS-PDSCH channels, both QPSK and 16 QAM modulation</li> <li>Support for 3GPP-defined features: <ul> <li>R99 transport channels</li> <li>Maximum of four simultaneous HS-SCCH channels</li> <li>CQI and ACK/NACK on HS-DPCCH channel</li> <li>All incremental redundancy versions for HARQ</li> <li>Configurable support for power classes 3 or 4, per TS 25.101</li> <li>TFC selection limitation on UL factoring in transmissions on the HS-DPCCH, per TS 25.133</li> </ul> </li> <li>Switching between HS-PDSCH and DPCH channel resources, as directed by the network</li> <li>Network activation of compressed mode by SF/2 or HLS on the DPCH for conducting inter-frequency or inter-radio access technology (RAT) measurements when the HS-DSCH is active</li> </ul>		

Table 2-4: Supported WCDMA Specification (Continued)

Standard	Feature Description		
R8 HSDPA	<ul> <li>STTD on both associated DPCH and HS-DSCH simultaneously</li> <li>CLTD mode 1 on the DPCH when the HS-PDSCH is active</li> <li>STTD on HS-SCCH when STTD or CLTD mode 1 are configured on the associated DPCH</li> <li>SCH-IC support</li> <li>HS-DSCH DRX support</li> </ul>		
R6 HSUPA	<ul> <li>E-DCH data rates of up to 5.76 Mbps for 2 ms TTI (UE category 6) uplink</li> <li>Support for 3GPP-defined features:         <ul> <li>E-AGCH, E-RGCH, and E-HICH channels for downlink; E-RGCH and E-HICH supports serving and non-serving radio links, with up to four radio links in the E-DCH active set</li> <li>All HARQ incremental redundancy versions and maximum number of HARQ retransmissions</li> <li>Uplink E-DCH channel with support for up to four E-DPDCH channels</li> <li>HSUPA channels run simultaneously with R99 and HSDPA channels</li> </ul> </li> <li>STTD on all HSUPA downlink channels</li> <li>CLTD mode 1 on HS-PDSCH and DPCH along with HSUPA channels</li> <li>Switch between HSUPA channels and DPCH channel resources, as directed by the network</li> <li>Handover using compressed mode with simultaneous E-DCH and HS-DSCH interactive, background, and streaming QoS classes</li> <li>CSD fallback</li> <li>DPCCH DTX support</li> </ul>		

## 2.2.2 Modem Specifications

Table 2-5: Supported Modem Specifications

Standard	Feature Description		
Data	<ul> <li>IPHC protocol as RFC 2509</li> <li>Stateless DHCPv4 protocol to get P-CSCF and DNS addresses</li> <li>IPv4/IPv6</li> <li>Dual IP on single QMAP PDN</li> <li>Multi-QMAP PDN Data Call</li> </ul>		

## 2.3 Multi-Core Processing Capabilities

The AirPrime RC76xx is a powerful multiple-core system that includes:

- One QDSP6 core, embedding Telecom firmware with integrated cellular voice, VoLTE, data and wireless Internet connectivity
- One Cortex A7 core entirely dedicated to customer application and natively provided with ThreadX operating system

## >> 3: Technical Specifications

### 3.1 Environmental

The environmental specifications for operation and storage of the AirPrime RC76xx are defined in Table 3-1.

Table 3-1: Environmental Specifications

Parameter	Range	Operating Class
Ambient Operating Temperature	-30°C to +70°C	Class A
Ambient Operating Temperature	-40°C to +85°C	Class B
Ambient Storage Temperature	-40°C to +85°C	-
Ambient Humidity	95% or less	-

Class A is defined as the operating temperature range within which the device:

- Shall exhibit normal function during and after environmental exposure.
- Shall meet the minimum requirements of 3GPP or appropriate wireless standards.

Class B is defined as the operating temperature range within which the device:

- Shall remain fully functional during and after environmental exposure
- Shall exhibit the ability to establish any of the device's supported call modes (SMS, Data, and emergency calls) at all times even when one or more environmental constraint exceeds the specified tolerance.
- Unless otherwise stated, full performance should return to normal after the excessive constraint(s) have been removed.

## 3.2 Power Supply Ratings

The AirPrime RC76xx operates using DC power supplied via the VBAT\_RF and VBAT\_BB signals. Power supply options are:

- A single regulated DC power supply (3.7V nominal)
- Two regulated DC power supplies (3.7V nominal), one each for VBAT\_BB and VBAT\_RF

Table 3-2: Power Supply Pins

Pin	Name	Direction	Function	Notes
63, 158	VBAT_BB	Input	Baseband power supply	63—Must be used 158—Optional
61, 62, 157	VBAT_RF	Input	RF power supply	61/62—Must be used 157—Optional

Table 3-3: C	Operating	<b>Conditions</b>
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Parameter		Min	Тур	Max	Units	Notes
Power supply voltage <sup>a</sup> , <sup>b</sup>		3.4	3.7	4.3	V	Must be within min/max values over all operating conditions (including voltage ripple, drop, and transient).
Power supply ripp	le	-	-	100	${\rm mV_{pp}}$	See Figure 3-1 on page 25.
Power supply voltage drop		-	-	250	mV <sub>pp</sub>	See Figure 3-1 on page 25 and Common and Separate Power Supply Examples on page 26.
Power supply voltage transient (overshoot/undershoot)		-	-	300	mV <sub>pp</sub>	See Figure 3-1 on page 25.
	LTE, UMTS	1.0	1.5		А	Typical value varies and depends on output power, band, and operating
Output current rating <sup>c</sup>	GSM	2.2	3.0	-	A	voltage. See Current Consumption on page 35 for values measured under normal operating condi- tions.  Max value measured over 100 µs period.

- a. Power supply voltage outside the required range may affect call quality (dropped calls, data transfer errors, etc.)
- b. For Absolute Maximum Ratings, see Table 3-28 on page 53.
- These values include a margin. For information on current consumption, see Current Consumption.

Customer should characterize the ripple, drop, and transient response (overshoot/undershoot) of the power supply delivery system at the module input under full transmit power in AirPrime RC76xx modules. To minimize voltage variation, add suitable capacitors to the supply line as close as possible to the module — depending on the power supply design, these capacitors may range from tens to several thousand  $\mu F$ .

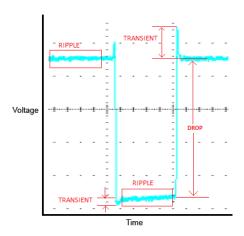


Figure 3-1: Power Supply Characteristics

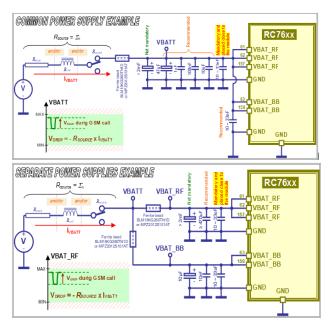


Figure 3-2: Common and Separate Power Supply Examples

## 3.2.1 Under-Voltage Lockout (UVLO)

The power management section of the AirPrime RC76xx includes an under-voltage lockout circuit that monitors supply and shuts down when VBAT\_BB falls below the threshold.

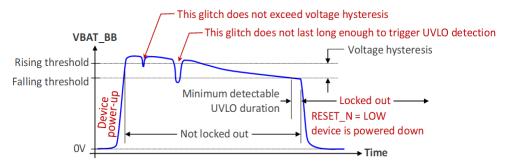


Figure 3-3: Under-Voltage Lockout (UVLO) Diagram

The AirPrime RC76xx will power down and remain off until VBAT\_BB returns to the valid range and the ON/OFF signal is active.

Note: If the device experiences six consecutive UVLO events less than 45 seconds apart (approximately) and a host-initiated power down or reset has not occurred, the device enters a mode in which only the DM port enumerates on the USB.

Table 3-4: UVLO Specifications

Parameter	Min	Тур	Max	Units
Threshold voltage, falling	2.225	2.4	2.80	V
Threshold voltage, accuracy	-5	-	+5	%
Hysteresis	-	425	-	mV
UVLO detection interval	-	1.0	-	μs

#### 3.2.2 Sudden Power Loss

Any sudden power loss of the embedded module during operating mode will increase the EFS crash risk, even in the power on or power down sequence. It is strongly recommended to remove the power only after the module is in power down mode.

## 3.2.3 Power Consumption States

The AirPrime RC76xx has four basic power states: Active, Sleep, Power Saving Mode (PSM), and Off. As the module transitions between power states, the range of available device functionality adjusts appropriately, as described in Table 3-5 on page 28 and Figure on page 29.

In the Active state, the module is ON with the application processor running. In Sleep state, the processor suspends its activity, reducing power consumption. The Active state has more than one power mode to reduce power consumption. Power Saving Mode (PSM; network-dependent) may be enabled to achieve the lowest possible average power consumption.

Table 3-5: Supported Power States

State	Description
Active	<ul> <li>Module is fully powered (ThreadX can be run in the Application Core; modem is on) and operating in one of the following modes:</li> <li>Full function (WWAN radio active; GNSS radio can be turned on/off)—Highest power consumption.</li> <li>Idle mode (WWAN radio on; Module registered on network, but no active connection; GNSS radio can be turned on/off)</li> <li>Airplane mode (WWAN radio off; GNSS radio can be active if allowed by PRI)</li> <li>eDRX (Extended Discontinuous Reception)—eDRX mode provides a 'flexible sleep' for the modem, which significantly reduces energy consumption. For eDRX details, see Extended Discontinuous Reception (eDRX) on page 33.</li> </ul>
Sleep	<ul> <li>Lower power consumption than Active state, but higher than PSM.</li> <li>Application Core is sleeping; modem is in DRX/eDRX. The processor monitors signals (triggers) that can 'wake' the module—see Wakeup Interrupt (Sleep State) on page 75 for details.</li> <li>Sleep state can be entered based on USB-SS (if USB is connected to the module), UART_DTR, wake_lock(), configured GPIOs, and QMI exchanges from the modem.</li> </ul>
PSM (Power Saving Mode)	3GPP Release 12 introduced network support of PSM. PSM allows the module to negotiate, with the network, an extended period during which registration context with the network is retained while the module is unreachable. During the negotiated period, the module enters a very low-power dormant state.  After the specified period, the modem and application processors boot up and the module sends a TAU (Tracking Area Update) to the network.  After sending the TAU, the module remains active to allow any pending data to be exchanged with the network. Then, after a negotiated period of inactivity, the module automatically returns to PSM to repeat the cycle.  For PSM details, see Power Saving Mode (PSM) on page 30.
OFF	Module is OFF (module is not powered)  Power the module to go to:  • Active state (POWER_ON_N is asserted) - This is a low level signal to turn on the module.  or  • OFF (POWER_ON_N is de-asserted) - The module is not turned on and will keep the same status.

Table 3-6: PSM Wakeup Sources

Туре	Description
TAU timer	Periodic TAU—PSM Cycle Timer (T3412) Configurable timer specifying PSM sleep duration. Applies to PSM only.
Wakeup timer	Derived from TAU timer (value is automatically set slightly shorter than TAU timer to ensure module boot completes before TAU timer expires)
RESET_IN_N	Resets the module with POWER_ON_N ON.  Note: If RESET_IN_N is used when POWER_ON_N is OFF, an emergency power off occurs—see  Emergency Power Off on page 65
POWER_ON_N	Wakes the module when asserted (transitions from OFF to ON).

Figure 3-4 illustrates the current consumption requirements of the different power states and the possible transitions between power states. For specific values, see Current Consumption on page 35

Note: Illustration not to scale. Values are based on the RC7611. Refer to Current Consumption for specific consumption values per variant.

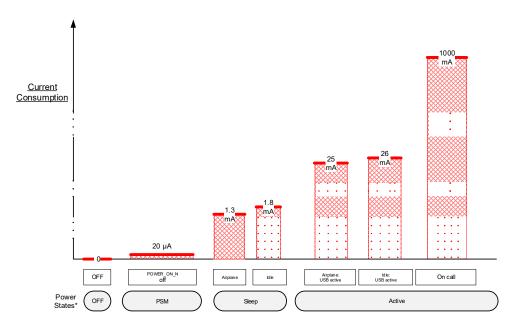


Figure 3-4: Overview of Current Consumption and Power States

Note: \*Refer to Table 3-5

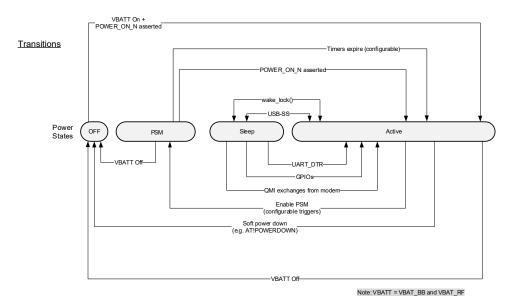


Figure 3-5: Power State Transitions

## 3.2.4 Power Saving Mode (PSM)

Power Saving Mode (PSM) is a 3GPP feature that allows the RC76xx to minimize power consumption by registering on a PSM-supporting LTE network, entering a very low power 'dormant' state for a pre-configured duration (via a periodic TAU (Tracking Area Update) timer), and then booting up for a short period to transmit/receive data, before re-entering PSM. During the dormant period, the module remains unreachable by the network until woken by a configured wakeup source (POWER\_ON\_N, RESET\_IN\_N) or the expiry of the periodic TAU timer.

Note: When using PSM, the POWER\_ON\_N signal must be floating. If this signal is grounded, it will automatically trigger a wake. In PSM, the previous pins states are maintained. To avoid extra power-consumption, the host should place the signals connected to the module in high impedance or floating.

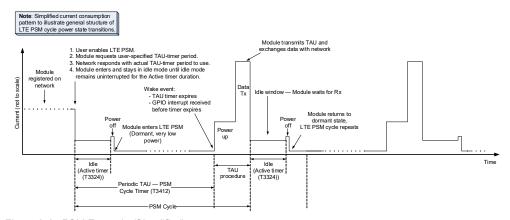


Figure 3-6: PSM Example (Simplified)

Typical candidates for PSM are systems (such as monitors and sensors) that:

- Require long battery life (low power consumption)
- Tolerate very long latency for mobile-terminated SMS/data
- Do not use mobile-terminated voice
- Send and/or receive data infrequently and periodically (e.g. on a given schedule of once every few hours, days, weeks, etc.)

For example, a module connected to a sensor can be configured to:

- Wake periodically to transmit collected data to a server or network entity.
- Wait a short (configured) period of time to receive transmissions (e.g 60 seconds) and then return to its dormant state.

Table 3-6 on page 28 describes the available triggers for waking an RC76xx from PSM. These triggers are configured using the methods described in Table 3-7.

Table 3-7: PSM-Related Application User Commands/Interfaces

Туре	Command/Interface <sup>a</sup>	Description
AT	+CPSMS	<ul> <li>3GPP-defined command (3GPP TS27.007 Release 12) that allows direct control of all LTE PSM parameters, and is useful for advanced users wanting to test/ experiment with different options. This command is limited to networks that support PSM.</li> <li>It is not expected that every user must be fully versed in the details of PSM to take advantage of its capabilities.</li> <li>Use this command to: <ul> <li>Enable/disable LTE PSM.</li> </ul> </li> <li>Configure Period TAU timer (T3412) with a requested maximum duration of the dormant period.</li> <li>Configure Active timer (T3324) with a requested 'idle mode time' (the duration the module remains idle before going dormant)</li> <li>This command follows the 3GPP TS 27.007, Release 12 specification, with exceptions noted for certain parameters.</li> </ul> <li>Note: The requested timer values are negotiated with the network and the final negotiated values take effect immediately, then persist across power cycles (e.g. after a power cycle, the settings will be used during network attach).</li>
	! POWERMODE	Custom Sierra Wireless command that allows application developers to enable PSM without the complexity of the <b>AT+CPSMS</b> syntax.
	! POWERWAKE	Custom Sierra Wireless command used to configure PSM timers (TAU time, active time) in seconds. Note that only timer values supported by the 3GPP standard are allowed.
	-	s recommends not combining the use of <b>+CPSMS</b> and <b>!POWERWAKE</b> . These tional overlap, which may result in unexpected effects.

 $a. \quad \text{For AT command details, refer to [1] Air Prime RC76xx AT Command Reference, available at $http://source.sierrawireless.com.} \\$ 

#### **PSM Process Example**

The following example describes how the module uses PSM (as shown in Figure on page 30):

- 1. Module registers on an LTE network.
- **2.** User enables PSM via AT command or API library function, specifying the desired TAU timer and Active timer periods, and optional wakeup sources.
- 3. Module submits the PSM request (including desired TAU timer) to the network.
- **4.** Network responds and indicates whether PSM is supported and (if it is) indicates the actual TAU timer to use.

- **5.** If the network supports PSM:
  - a. Module enters idle mode (waiting for Rx from network).
  - **b.** When module has remained idle for the Active timer period, module powers off (except for maintaining timer and interrupts) and enters PSM.
  - **c.** Module remains in PSM for the specified period or until a configured trigger (POWER\_ON\_N, RESET\_IN\_N) wakes it.

Note: If traffic must be transmitted when the module is in the sleep portion of the cycle, the module can initiate data/SMS/voice session immediately.

- **d.** Module powers up before TAU timer expires, then transmits TAU and/or exchanges data with network.
- e. Module enters idle mode and cycle repeats.

Note: When the module is powered up, the PSM request can be re-issued with different timers and triggers to adjust the PSM behavior. These new settings take effect immediately.

#### **Important Notes**

- Carefully select the PSM Periodic-TAU timer and Active Time values to match the intended use case(s) for the module:
  - Periodic TAU PSM Cycle timer (T3412) Note that while the module is dormant (for the duration of this timer, unless woken by a user-configured ADC or GPIO interrupt, or POWER\_ON\_N or RESET\_IN\_N), it will be completely unreachable by the network.
  - Active Time (Idle mode time after transmission (T3324)) Make sure to set the Active timer high enough to provide appropriate delay-tolerance for mobile-terminated/network-originated transmissions to be received.
- When using multiple devices, consider scheduling the modules to wake at different times so that the network does not get flooded by all modules waking and transmitting simultaneously.

#### 3.2.5 Active State to PSM Transition

If the module will be used in situations where it needs to be active very infrequently (for example, in a remote monitoring station that must transmit data periodically—e.g. on a regular schedule ranging from days to weeks or more), PSM may be used to reduce power consumption much more than is possible in Sleep state. Refer to Figure on page 29 for transition conditions. If the module does not enter PSM, the request must be explicitly repeated—the module will not attempt to enter PSM automatically.

## 3.2.6 Extended Discontinuous Reception (eDRX)

The RC76xx supports eDRX, which is a 'flexible sleep' active mode that allows for longer sleep duration ( $T_{I-eDRX}$ ) and a significant decrease in power consumption compared to regular DRX ( $T_{I-DRX}$ ).

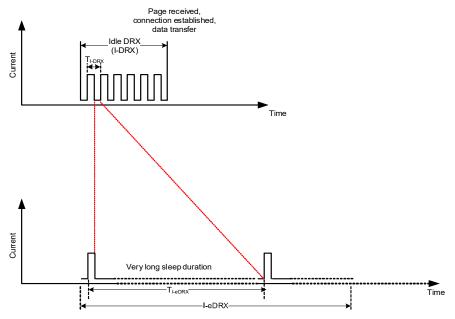


Figure 3-7: eDRX Example (Simplified)

Specifically, the RC76xx supports eDRX, which extend the DRX cycle (the paging cycle comprised of a paging window during which the module is awake and able to receive or transmit on the network, and a sleep period during which the network cannot wake the module) by increasing the sleep duration beyond the DRX maximum of 2.56 seconds:

 I-eDRX (Idle mode eDRX) — The sleep duration of the DRX cycle can be set up to 44 minutes for LTF-M.

Note: If traffic must be transmitted when the module is in the sleep portion of the cycle, the module can initiate data/SMS/voice session immediately.

Table 3-8 describes the available methods for configuring eDRX.

Table 3-8: eDRX-Related Commands<sup>a</sup>

Туре	Command	Description	
AT	+CEDRXS	Enable/disable eDRX, and configure related settings	
АТ	+CEDRXRDP	Display current eDRX settings	

 $a. \quad \text{For AT command details, refer to [1] Air Prime \ RC76xx \ AT \ Command \ Reference, available \ at \ http://source.sierrawireless.com.}$ 

#### **eDRX Process Example**

- Use the AT+CEDRXS command to configure the desired eDRX behavior.
- · During the network attachment process:
  - eDRX request and settings are sent to the network
  - Network responds and indicates whether eDRX is supported for the connection and may adjust the eDRX parameters.
- If eDRX is supported by the network:
  - While in active mode (connected), the sleep duration is used if supported, otherwise the regular DRX sleep duration is used.
  - While in idle mode, the I-eDRX sleep duration is used if supported, otherwise the network uses the standard LTE I-DRX value.

#### **Important Notes**

- The sleep duration must be carefully selected to match the intended use case(s) for the module. While the module is asleep, it will be unreachable by the network. The duration should provide appropriate delay-tolerance for mobile-terminated/network-originated transmissions to be received.
- Due to the extended sleep time compared to regular DRX, eDRX is not suitable for most mobile-terminated voice connections.
- Network-side store and forward is supported Packets will be stored until the module is reachable.

## 3.2.7 Current Consumption

The following tables describe the AirPrime RC76xx module's current consumption under various power states. Typical values are measured at nominal supply voltage, nominal ambient temperature, and with a conducted  $50\Omega$  load on the antenna port.

Table 3-9: RC7611 Current Consumption Values

Power State	Parameter	Parameter			Max.b	Units	
Active			<u> </u>	<u>'</u>	_		
	B2	210 <sup>d</sup>	700 <sup>e</sup>	980 <sup>e</sup>	mA		
	B4	B4			1000 <sup>e</sup>	mA	
	B5	B5			700 <sup>e</sup>	mA	
	B12		190 <sup>d</sup>	610 <sup>e</sup>	700 <sup>e</sup>	mA	
LTE Data to a second	B13		190 <sup>d</sup>	680 <sup>e</sup>	800 <sup>e</sup>	mA	
LTE Data transfer <sup>c</sup>	B14		190 <sup>d</sup>	700 <sup>e</sup>	800 <sup>e</sup>	mA	
	B25		210 <sup>d</sup>	720 <sup>e</sup>	980 <sup>e</sup>	mA	
	B26	B26			700 <sup>e</sup>	mA	
	B66	220 <sup>d</sup>	700 <sup>e</sup>	1000 <sup>e</sup>	mA		
	B71	190 <sup>d</sup>	600 <sup>e</sup>	700 <sup>e</sup>	mA		
Idle—LTE	<ul><li>Registered</li><li>Paging cycle=256</li></ul>	USB active	25	26	39	mA	
Airplane mode	Radio off	USB active	25	25	36	mA	
Sleep		,	-				
Idle—LTE	<ul><li>Registered</li><li>Paging cycle=256</li></ul>	USB-SS	1.7	1.8	6	mA	
Idle—LTE eDRX <sup>f</sup>	Period: 40.96 sec	USB-SS	1.5	1.8	4	mA	
Airplane mode	Radio off	USB-SS	1	1.3	4	mA	
Low Power Mode							
PSM	Non-active		15	20	30	uA	
Off	Non-active	3	6	10	uA		
GNSS <sup>g</sup>			,		<u>.</u>		
Acquisition (Airplane m	ode, cold start)		23	25	35	mA	
Tracking (Registered)			23	25	35	mA	

a. Input 3.7V, normal temperature

b. Input 3.4V, 70°C

c. Bandwidth 10 MHz, UP/DL RB=50, enable throughput, modulation:QPSK

d. Tx min.

e. Tx max.

- f. eDRX test condition: eDRX setting: at+cedrxs=1,4,"0011", eDRX period = 40.96 sec, PTW = 5.12 sec, DRX cycle = 64 ms, For details on AT commands, see AirPrime RC76xx AT Command Reference.
   g. GNSS current consumption values are for the GNSS radio only. For total consumption, add the GNSS value to the consumption for
- the mode being used.

Table 3-10: RC7620 Current Consumption Values

Power State	Parameter	Min. <sup>a</sup>	Typ. <sup>a</sup>	Max. <sup>b</sup>	Units		
Active							
GSM/GPRS/	E-GSM 900	160 <sup>c</sup>	600 <sup>d</sup>	2160 <sup>d,e</sup> 1020 <sup>d,f</sup>	mA		
EDGE data transfer	DCS 1800	150 <sup>c</sup>	560 <sup>d</sup>	1278 <sup>d,e</sup> 665 <sup>f</sup>	mA		
HSDPA data	B1	180 <sup>c</sup>	803 <sup>d</sup>	1140 <sup>d</sup>	mA		
transfer <sup>g</sup>	B8	150 <sup>c</sup>	550 <sup>d</sup>	840 <sup>d</sup>	mA		
	B1	240 <sup>c</sup>	790 <sup>d</sup>	850 <sup>d</sup>	mA		
	В3	240 <sup>c</sup>	740 <sup>d</sup>	900 <sup>d</sup>	mA		
LTE Data transfer <sup>h</sup>	В7	300 <sup>c</sup>	770 <sup>d</sup>	980 <sup>d</sup>	mA		
LTE Data transfer	B8	210 <sup>c</sup>	620 <sup>d</sup>	700 <sup>d</sup>	mA		
	B20	210 <sup>c</sup>	750 <sup>d</sup>	850 <sup>d</sup>	mA		
	B28	210 <sup>c</sup>	670 <sup>d</sup>	710 <sup>d</sup>	mA		
Idle—GSM/ GPRS/EDGE	<ul><li>Registered</li><li>MFRM=9</li><li>USB active</li></ul>	25	25	36	mA		
Idle—WCDMA	<ul><li>Registered</li><li>DRX=8</li><li>USB active</li></ul>	25	25	36	mA		
Idle—LTE	<ul><li>Registered</li><li>Paging cycle=256</li><li>USB active</li></ul>	25	26	39	mA		
Airplane mode <sup>j</sup>	<ul><li>Radio off</li><li>USB active</li></ul>	25	25	36	mA		
Sleep							
Idle—GSM/ GPRS/EDGE	<ul><li>Registered</li><li>MFRM=9</li><li>USB-SS</li></ul>	1.7	1.8	4	mA		
Idle—WCDMA	<ul><li>Registered</li><li>DRX=8</li><li>USB-SS</li></ul>	1.6	1.8	4	mA		

Table 3-10: RC7620 Current Consumption Values (Continued)

Power State	Parameter	Min. <sup>a</sup>	Typ. <sup>a</sup>	Max. <sup>b</sup>	Units			
Idle—LTE	<ul><li>Registered</li><li>Paging cycle=256</li><li>USB-SS</li></ul>	1.7	1.8	6	mA			
Idle—LTE eDRX <sup>k</sup>	<ul><li>Period = 40.96 sec</li><li>USB-SS</li></ul>	1.5	1.8	4	mA			
Airplane mode <sup>j</sup>	<ul><li>Radio off</li><li>USB-SS</li></ul>	1	1.3	4	mA			
Low Power Mode								
PSM	Non-active	15	20	30	uA			
Off	Non-active	3	6	10	uA			
GNSS <sup>I</sup>	GNSS <sup>I</sup>							
GNSS	Acquisition (Airplane mode, cold start)	23	25	35	mA			
	Tracking (Registered)	23	25	35	mA			

a. Input 3.7V, normal temperature

b. Input 3.4V, 70°C

c. Tx min.

d. Tx max.

e. At GSM conducted 4 slot max Tx output power, measured at peak current on supported DC range.

f. At GSM conducted 4 slot max TX output power, measured at average current on supported DC range.

g. At WCDMA conducted max Tx output power. (see Table 3-27)

h. Bandwidth 10 MHz, UP/DL RB=50, enable throughput, modulation:QPSK

j. Only the radio is turned off. Other functions use default setting.
k. eDRX test condition: eDRX setting: at+cedrxs=1,4,"0011", eDRX period = 40.96 sec, PTW = 5.12 sec, DRX cycle = 64 ms, For details on AT commands, see AirPrime RC76xx AT Command Reference.

GNSS current consumption values are for the GNSS radio only. For total consumption, add the GNSS value to the consumption for the mode being used.

Table 3-11: RC7630 Current Consumption Values

Power State	Parameter		Min. <sup>a</sup>	Typ. <sup>a</sup>	Max.b
Active					
	B1		TBD	TBD	TBD
	В3		TBD	TBD	TBD
	B5		TBD	TBD	TBD
LTE Data transfer <sup>c</sup>	B7		TBD	TBD	TBD
	B8		TBD	TBD	TBD
	B18		TBD	TBD	TBD
	B19		TBD	TBD	TBD
	B21	TBD	TBD	TBD	
Idle—LTE	<ul><li>Registered</li><li>Paging cycle=256</li></ul>	USB active	25	26	39
Airplane mode	Radio off	USB active	25	25	36
Sleep					<u>'</u>
Idle—LTE	<ul><li>Registered</li><li>Paging cycle=256</li></ul>	USB-SS	1.7	1.8	6
Idle—LTE eDRX <sup>d</sup>	Period: 40.96 sec	USB-SS	1.5	1.8	4
Airplane mode	Radio off	USB-SS	1	1.3	4
Low Power Mode					
PSM	Non-active		15	20	30
Off	Non-active	Non-active			10
GNSS <sup>e</sup>					
Acquisition (Airplane m	ode, cold start)		23	25	35
Tracking (Registered)			23	25	35

a. Input 3.7V, normal temperature

b. Input 3.4V, 70°C

<sup>c. Bandwidth 10 MHz, UP/DL RB=50, enable throughput, modulation:QPSK
d. eDRX test condition: eDRX setting: at+cedrxs=1,4,"0011", eDRX period = 40.96 sec, PTW = 5.12 sec, DRX cycle = 64 ms, For details on AT commands, see AirPrime RC76xx AT Command Reference.</sup> 

e. GNSS current consumption values are for the GNSS radio only. For total consumption, add the GNSS value to the consumption for the mode being used.

#### 3.3 RF

This section presents the module's WWAN RF interface, and defines the specifications for the LTE interface.

Note: RF sensitivity values presented in this section are for soldered-down modules. Sensitivity values decrease for modules installed in snap-in sockets, which might prevent the module from meeting 3GPP minimum specifications.

AirPrime RC76xx is designed to be compliant with 3GPP Release 13 standards; refer to Network Technology Specifications on page 20.

### 3.3.1 Supported RF Bands

Table 3-12: Supported RF bands

RAT	Band	RC7630	RC7630-1	RC7620	RC7620-1	RC7611	RC7611-1
	Category	4	1	4	1	4	1
	B1	Υ	Υ	Υ	Υ		
	B2					Υ	Υ
	В3	Υ	Υ	Υ	Υ		
	B4					Υ	Υ
	B5	Υ	Υ			Υ	Υ
	В7	Υ	Υ	Υ	Υ		
	B8	Υ	Υ	Υ	Υ		
	B12					Υ	Υ
LTE	B13					Υ	Υ
LTE	B14					Υ	Υ
	B18	Υ	Υ				
	B19	Υ	Υ				
	B20			Υ	Υ		
	B21	Υ	Υ				
	B25					Y	Υ
	B26					Υ	Υ
	B28			Υ	Υ		
	B66					Υ	Υ
	B71					Υ	Υ

RAT	Band	RC7630	RC7630-1	RC7620	RC7620-1	RC7611	RC7611-1
UMTS	B1			Υ	Υ		
OWIS	B8			Υ	Υ		
0014/0000/5005	E-GSM 900	Υ	Υ	Υ	Υ		
GSM/GPRS/EDGE	DCS 1800	Υ	Υ	Υ	Υ		
	GPS						
	GLONASS	Υ <sup>a</sup>	Ya	γa		Y	а
GNSS	Galileo	Ĭ	ī	ī		ī	
	BeiDou						
	QZSS	Υ	Υ				

a. SKU-dependent

#### 3.3.2 LTE RF Interface

This section presents the LTE RF specification for AirPrime RC76xx modules.

#### 3.3.2.1 Tx Output Power

The module's LTE maximum transmitter output power is specified in Table 3-13.

Table 3-13: RC7611 Conducted Tx Max Output Power Tolerances—LTE<sup>a</sup>

RF Band	Operating Condition	Min	Тур	Max	Units	Notes
B2	Normal (25°C)	21	23	24	dBm	Power class 3
B4	Normal (25°C)	21	23	24	dBm	Power class 3
B5	Normal (25°C)	21	23	24	dBm	Power class 3
B12	Normal (25°C)	21	23	24	dBm	Power class 3
B13	Normal (25°C)	21	23	24	dBm	Power class 3
B14	Normal (25°C)	21	23	24	dBm	Power class 3
B25	Normal (25°C)	21	23	24	dBm	Power class 3
B26	Normal (25°C)	21	23	24	dBm	Power class 3
B66	Normal (25°C)	21	23	24	dBm	Power class 3
B71	Normal (25°C)	21	23	24	dBm	Power class 3

a. Stated typical power tolerance satisfies 3GPP TS 36.521-1 requirements for normal (25  $^{\circ}$ C).

Table 3-14: RC7620 Conducted Tx Max Output Power Tolerances—LTE<sup>a</sup>

RF Band	Operating Condition	Min	Тур	Max	Units	Notes
B1	Normal (25°C)	21	23	24	dBm	Power class 3
В3	Normal (25°C)	21	23	24	dBm	Power class 3
B7	Normal (25°C)	21	23	24	dBm	Power class 3
B8	Normal (25°C)	21	23	24	dBm	Power class 3
B20	Normal (25°C)	21	23	24	dBm	Power class 3
B28	Normal (25°C)	21	23	24	dBm	Power class 3

a. Stated typical power tolerance satisfies 3GPP TS 36.521-1 requirements for normal (25°C).

Table 3-15: RC7630 Conducted Tx Max Output Power Tolerances—LTE<sup>a</sup>

RF Band	Operating Condition	Min	Тур	Max	Units	Notes
B1	Normal (25°C)	21	23	24	dBm	Power class 3
В3	Normal (25°C)	21	23	24	dBm	Power class 3
B5	Normal (25°C)	21	23	24	dBm	Power class 3
B7	Normal (25°C)	21	23	24	dBm	Power class 3
B8	Normal (25°C)	21	23	24	dBm	Power class 3
B18	Normal (25°C)	21	23	24	dBm	Power class 3
B19	Normal (25°C)	21	23	24	dBm	Power class 3
B21	Normal (25°C)	21	23	24	dBm	Power class 3

a. Stated typical power tolerance satisfies 3GPP TS 36.521-1 requirements for normal (25°C).

#### 3.3.2.2 Rx Sensitivity

The module's LTE receiver sensitivity is specified in the following tables.

Table 3-16: RC7611 Conducted Rx Sensitivity—LTE Bands<sup>a</sup>

		+25°C (dBr	n)		Class A (d		SIMO	
LTE Bands		Primary (Typical)	Secondary (Typical)	SIMO (Typical)	Primary (Typical)	Secondary (Typical)	SIMO (Typical)	(Worst case) <sup>b</sup>
B2		-98	-98	-100	-97	-97.5	-99.5	-94.3
B4		-98	-97.5	-99.5	-97	-96.5	-98.5	-96.3
B5		-99	-98	-100.5	-98	-97	-99.5	-94.3
B12		-97	-96	-99	-96	-95.5	-98	-93.3
B13	Full RB	-97.5	-95	-99	-96	-94	-98	-93.3
B14	BW: 10 MHz <sup>c</sup>	-96.5	-97	-99.5	-96.5	-96	-98.5	-93.3
B25		-98	-98	-100	-97	-97.5	-99.5	-92.8
B26		-99	-98	-100.5	-98	-97	-99.5	-93.8
B66		-98	-98	-100	-97	-97	-99	-95.8
B71		-98	-97.5	-100	-96.5	-97	-99	-93.5

a. RF sensitivity values are for soldered-down modules.

Table 3-17: RC7620 Conducted Rx Sensitivity—LTE Bands<sup>a</sup>

		+25°C (dBm)			Class A (dBm)			
LTE	Bands	Primary (Typ.)	Secondary (Typ.)	SIMO (Typ.)	Primary (Typ.)	Secondary (Typ.)	SIMO (Typ.)	SIMO (Worst case) <sup>b</sup>
B1		-97.5	-96.5	-100	-96.5	-96	-99	-96.3
В3	=	-97	-97	-100	-96.5	-97	-99	-93.3
B7	Full RB	-95	-96	-99	-94.5	-95	-98	-94.3
В8	BW:10 MHz <sup>c</sup>	-98	-97	-100	-97.5	-96	-99	-93.3
B20		-97	-96	-99	-97	-95	-99	-93.3
B28		-96	-93	-98.5	-95.5	-92	-98	-94.8

a. RF sensitivity values are for soldered-down modules.

b. Per 3GPP specification.

c. Sensitivity values scale with bandwidth: x\_MHz\_Sensitivity = 10\_MHz\_Sensitivity - 10×log(10 MHz/x\_MHz)
Note: Bandwidth support is dependent on firmware version

b. Per 3GPP specification.

c. Sensitivity values scale with bandwidth: x\_MHz\_Sensitivity = 10\_MHz\_Sensitivity - 10×log(10 MHz/x\_MHz)
Note: Bandwidth support is dependent on firmware version

Table 3-18: RC7630 Conducted Rx Sensitivity—LTE Bands<sup>a</sup>

	+25°C (dBm)			Class A (d	Bm)			
LTE	Bands	Primary (Typical)	Secondary (Typical)	SIMO (Typical)	Primary (Typical)	Secondary (Typical)	SIMO (Typical)	SIMO (Worst case) <sup>b</sup>
B1		-98.5	-97.5	-101	-97	-96.5	-100	-96.3
В3		-98.5	-98	-100.5	-97.5	-96.5	-99.5	-93.3
B5		-98.5	-99	-101	-97	-97	-100	-94.3
B7	Full RB BW:	-97	-97	-99	-96	-96	-98	-94.3
B8	10 MHz <sup>c</sup>	-98.5	-99	-101	-97.5	-98	-100	-93.3
B18		-98.5	-99	-101	-97.5	-98	-100	-96.3
B19		-98.5	-99	-101	-97.5	-98	-100	-96.3
B21		-98.5	-100	-101	-97	-99	-100	-96.3

a. RF sensitivity values are for soldered-down modules.
 b. Per 3GPP specification
 c. Sensitivity values scale with bandwidth: x\_MHz\_Sensitivity = 10\_MHz\_Sensitivity - 10×log(10 MHz/x\_MHz)
 Note: Bandwidth support is dependent on firmware version

#### 3.3.3 GSM / GPRS / EDGE RF Interface

This section presents the GSM / GPRS / EDGE RF specifications for AirPrime RC7620 modules.

#### 3.3.3.1 GSM / GPRS / EDGE Tx Output Power

Table 3-19: Conducted Tx Max Output Power Tolerances—GSM / GPRS / **EDGE**<sup>a</sup>

RF Band	Min	Тур	Max	Units	Notes
E GSM 000	31 33 34 dBm		GMSK mode (Class 4; 2 W, 33 dBm)		
E-GSM 900	24.5	27	29.5	dBm	8PSK mode (Class E2; 0.5 W, 27 dBm)
DCS 1800	28	30	31	dBm	GMSK (Class 1; 1W, 30 dBm)
DC3 1000	23.5	26	28.5	dBm	8PSK (Class E2; 0.4W, 26 dBm)

a. Stated power tolerance satisfy 3GPP TS 51.010-1 requirements for normal (25°C) conditions.

#### 3.3.3.2 GSM / GPRS / EDGE Rx Sensitivity

Table 3-20: Conducted Rx Sensitivity—GSM / GPRS / EDGE Bands<sup>a</sup>

	@ +25°C (dBm) <sup>b</sup>	@ Class A (dBm) <sup>c</sup>
E-GSM 900	-109	-108
DCS 1800	-109	-108

a. Stated power tolerance satisfy 3GPP TS 51.010-1 requirements for normal (25°C) and Class A (extreme) conditions.

b. Typical valuec. Typical value, tested at Class A extreme condition

#### 3.3.4 WCDMA RF Interface

This section presents the WCDMA RF specification for AirPrime RC7620 modules.

#### 3.3.4.1 WCDMA Tx Output Power

The module's WCDMA maximum transmitter output power is specified in the following table.

Table 3-21: Conducted Tx Max Output Power Tolerances—WCDMA

RF Band	Min	Typ <sup>a</sup>	Max	Units	Notes
B1	21.5	23	24	dBm	Power class 3 bis
B8	21.5	23	24	dBm	Power class 3 bis

Stated typical power tolerance satisfies 3GPP TS 34.121-1 requirements for normal (25°C) conditions

#### 3.3.4.2 WCDMA Rx Sensitivity

The module's WCDMA receiver sensitivity is specified in the following table.

Table 3-22: Conducted Rx Sensitivity—WCDMA Bands<sup>a,b</sup>

	+25°C		Class A			
Band	Primary (dBm) <sup>c</sup>	Secondary (dBm) <sup>c</sup>	Primary (dBm) <sup>d</sup>	Secondary (dBm) <sup>d</sup>	Standard Limit (dBm)	Notes
B1	-108	-108	-107	-107	-106	CS 0.1% BER 12.2
B8	-109	-109	-109	-109	-103	kbps Reference Measurement Channel

a. Stated sensitivity values satisfy 3GPP TS 34.121-1 V8.10.0 requirements for normal (25°C) and Class A (extreme) conditions.

#### 3.3.5 WWAN Antenna Interface

The following table defines the WWAN antenna interfaces of the AirPrime RC76xx modules.

Table 3-23: WWAN Antenna Interface Pins

Pin #	Signal name	Direction	Function
30	GND		Diversity Antenna Ground
31	RF_DIV	Input	Diversity Antenna Interface
32	GND		Diversity Antenna Ground

b. RF sensitivity values are for soldered-down modules

c Typical value

d. Typical value, tested at Class A extreme temperature.

Table 3-23: WWAN Antenna Interface Pins (Continued)

Pin #	Signal name	Direction	Function	
48	GND		Primary Antenna Ground	
49	RF_MAIN	Input/Output	Primary Antenna Interface	
50	GND		Primary Antenna Ground	
111	GND	Diversity Antenna Ground		
113	GND		Diversity Antenna Ground	
136	GND		Primary Antenna Ground	
139	GND		Primary Antenna Ground	

Note: For the routing of ground and RF signal, see Figure 5-4 and Figure 5-5.

#### 3.3.5.1 WWAN Antenna Recommendations

Table 3-24 defines the key characteristics to consider for antenna selection.

Table 3-24: Antenna Recommendations<sup>a</sup>

Parameter		Recommendations	Notes
Antenna system		External multi-band antenna system	Dual WWAN antennas for diversity (Antenna 1/ Antenna 2) <sup>b</sup>
		617– 798 MHz	
	RC7611	814 – 894 MHz	
		1710 – 2200 MHz	
		703 – 960 MHz	
	RC7620	1710 – 1980 MHz	
Operating bands		2110 – 2170 MHz	Operating bands depend on the module's supported bands/modes.
		2500 – 2690 MHz	
		815 – 960 MHz	
	RC7630	1710 – 2170 MHz	
	KC/030	1447 – 1511 MHz	
		2500 – 2690 MHz	
VSWR		< 2.5:1 (worst case)	<ul><li>On all bands including band edges</li><li>Applies to both antennas</li></ul>

Table 3-24: Antenna Recommendations<sup>a</sup> (Continued)

Parameter	Recommendations	Notes
Total radiated efficiency	> 50% on all bands	<ul> <li>Measured at the RF connector.</li> <li>Applies to both antennas</li> <li>Includes mismatch losses, losses in the matching circuit, and antenna losses, excluding cable loss.</li> <li>Sierra Wireless recommends using antenna efficiency as the primary parameter for evaluating the antenna system.</li> <li>Peak gain is not a good indication of antenna performance when integrated with a host device (the antenna does not provide omnidirectional gain patterns). Peak gain can be affected by antenna size, location, design type, etc.—the antenna gain pattern remains fixed unless one or more of these parameters change.</li> </ul>
Radiation patterns	Nominally omnidirectional radiation pattern in azimuth plane.	
Envelope correlation coefficient between Antenna 1 and Antenna 2  Mean Effective Gain (MEG)	< 0.4 on B5 Rx (869–894 MHz),     B12 Rx (729–746 MHz), B13 Rx     (746–756 MHz), B14 Rx (758–768     MHz), B26 Rx (859–894 MHz) and     B71 Rx (617–652 MHz)      < 0.2 on B2 Rx (1930–1990 MHz),     B4 Rx (2110–2155 MHz), B25 Rx     (1930–1995 MHz) and B66 Rx     (2110–2200 MHz)  ≥ -3 dBi	
Mean Effective Gain Imbalance— Antenna 1 and Antenna 2 (MEG1 / MEG2)	< 6 dB for diversity operation	
Maximum antenna gain	Must not exceed antenna gains due to RF exposure and ERP/EIRP limits, as listed in the module's FCC grant.	
Isolation between Antenna 1 and Antenna 2 (S21)	> 10 dB	<ul> <li>If antennas can be moved, test all positions for both antennas.</li> <li>Unless otherwise specified, this isolation requirement must be maintained for optimum operation.</li> <li>Make sure all other wireless devices (Bluetooth or WLAN antennas, etc.) are turned OFF to avoid interference.</li> </ul>

Table 3-24: Antenna Recommendations<sup>a</sup> (Continued)

Parameter	Recommendations	Notes
Maximum voltage applied to antenna	6.3 VDC	
Power handling	> 1 W on all bands > 2 W RF power on low bands	<ul> <li>Measure power endurance over 4 hours (estimated talk time) using a 2 W CW signal—set the CW test signal frequency to the middle of the PCS Tx band (1880 MHz for PCS).</li> <li>Visually inspect device to ensure there is no damage to the antenna structure and matching components.</li> <li>VSWR/TIS/TRP measurements taken before and after this test must show similar results.</li> </ul>

a. These worst-case VSWR figures for the transmitter bands may not guarantee RSE levels to be within regulatory limits. The device alone meets all regulatory emissions limits when tested into a cabled (conducted)  $50\Omega$  system. With antenna designs with up to 2.5:1 VSWR or worse, the radiated emissions could exceed limits. The antenna system may need to be tuned in order to meet the RSE limits as the complex match between the module and antenna can cause unwanted levels of emissions. Tuning may include antenna pattern changes, phase/delay adjustment, passive component matching.

b. Antenna 1—Primary (RF\_MAIN), Antenna 2—Secondary (RF\_DIV) (Diversity)

#### **3.4 GNSS**

The AirPrime RC76xx includes Global Navigation Satellite System (GNSS) capabilities via the QUALCOMM IZat™ Gen8C Engine (formerly gpsOne), capable of operation in assisted and standalone GNSS modes (GPS/Galileo/GLONASS/BeiDou).

Note: The AirPrime RC76xx modules are not affected by the 6 April 2019 rollover. Software modifications extend the GPS rollover date to 12 December 2032.

#### 3.4.1 Characteristics

The GNSS implementation supports GPS L1, Galileo E1, BeiDou-B1 and GLONASS L1 FDMA operation.

Table 3-25: GNSS Characteristics<sup>a</sup>

Parameter		Value	
	Standalone or MS-based tracking sensitivity	-160 dBm	
Sensitivity <sup>b</sup>	Cold start acquisition sensitivity	-145 dBm	
	MS-assisted acquisition sensitivity	-158 dBm	
Accuracy in open sky (1	Hz tracking)	< 2 m CEP-50	
Satellite channels	Acquisition	118	
available <sup>c</sup>	Simultaneous tracking	40	
Support for predicted orb	its	Yes	
Predicted orbit CEP-50 a	ccuracy	5 m	
	Hot	1 s	
Standalone Time To First Fix (TTFF)	Warm	29 s	
, ,	Cold	32 s	
Altitude (max)		18,288 m (60,000 ft)	
Velocity (max)		1,852 km/h (1150.8 mph)	
Acceleration (max)		20 m/s <sup>2</sup>	
GNSS message protocol	GNSS message protocols		
Recommended signal power for GPS input		Below -120 dBm	
Maximum allowed GPS i	nput	-116 dBm (if noise figure ≤ 3 is achieved)	

- a. Acquisition / tracking sensitivity performance figures in conducted mode assume a 2.5 dB noise figure.
- b. GNSS sensitivity may degrade for modules installed in snap-in sockets.
- c. Resources are dynamically assigned and not constellation-specific.

#### 3.4.2 GNSS Antenna Interface

The GNSS antenna interface is defined in Table 3-26.

Table 3-26: GNSS Antenna Interface Pads

Pad	Name	Direction <sup>a</sup>	Function
37	GND		GNSS Antenna Ground
38	RF_GNSS	Input	GNSS Antenna Interface
39	GND		GNSS Antenna Ground
125	GND		GNSS Antenna Ground
128	GND		GNSS Antenna Ground

a. Signal direction with respect to the module.

Note: For the routing of ground and RF signal, see Figure 5-4 and Figure 5-5.

#### 3.4.3 Antenna Recommendations

Table 3-27 defines the key characteristics to consider for antenna selection.

Table 3-27: GNSS Standalone Antenna Recommendations<sup>a</sup>

Parameter	Recommendations	Notes
Frequency range	<ul> <li>Wide-band GPS, Galileo, GLONASS, and BeiDou: 1559–1606 MHz recommended</li> <li>Narrow-band GPS: 1575.42 MHz ± 2.046 MHz minimum</li> </ul>	
Field of view (FOV) b	<ul> <li>Omni-directional in azimuth</li> <li>-45° to +90° in elevation</li> </ul>	
Polarization (average Gv/Gh)	> 0 dB	Vertical linear polarization is sufficient.
Free space average gain (Gv+Gh) over FOV	> -6 dBi (preferably > -3 dBi)	Gv and Gh are measured and averaged over -45° to +90° in elevation, and ±180° in azimuth.
Gain	<ul> <li>Maximum gain and uniform coverage in the high elevation angle and zenith.</li> <li>Gain in azimuth plane is not desired.</li> </ul>	
Average 3D gain	> -5 dBi	

Table 3-27: GNSS Standalone Antenna Recommendations<sup>a</sup> (Continued)

Parameter	Recommendations	Notes		
Isolation between GNSS and RF Antenna	> 20 dB in all uplink bands			
Typical VSWR	< 2.5:1			
Polarization	Any other than LHCP (left-hand circular polarized) is acceptable.	Type of antenna and polarization (RHCP/ linear) to be implemented is a matter of consideration based on specific end application.		
Maximum voltage applied to antenna	6.3 VDC			
700 MHz harmonic <sup>b,c</sup>	< -56 dBm (input jammer 787.76 MHz at - 25 dBm and measure the harmonic tone at 1575.42 MHz)	This specification is for B13 and B14 coexistence.		
IIP2 <sup>b,c</sup>	> 45 dBm (Input jammers at 824.6 MHz with level -25 dBm and 2400 MHz with level -32 dBm and measure output IM2 at 1575.4 MHz)	Out of band		
IIP3 <sup>b,c</sup>	> 2 dBm (Input jammers at 1712.7 MHz with level -20 dBm and 1850 MHz with level -65 dBm and measure output IM3 at 1575.4 MHz)	Out of band		
Input 1 dB power compression point <sup>b,c</sup>	> -10 dBm			
Out of band rejection for an activ	ve antenna			
663–716 MHz	> 50 dB			
777–798 MHz	> 50 dB			
814–915 MHz	> 40 dB	50 dB is preferred		
925–960 MHz	> 30 dB	50 dB is preferred		
1427–1463 MHz	> 35 dB			
1710–1785 MHz	> 35 dB			
1850–1980 MHz	> 40 dB			
2010–2025 MHz	> 40 dB			
2305–2315 MHz	> 40 dB			
2401–2483 MHz	> 40 dB			
2500–2570 MHz	> 35 dB			

a. All values are preliminary and subject to change.

b. Noise figure: < 2dB, System gain: [14-17dB].



c. For the LNA used by an active antenna

# 3.5 Electrical Specifications

This section provides details of key electrical specifications.

# 3.5.1 Absolute Maximum Ratings

**Warning:** If these parameters are exceeded, even momentarily, damage may occur to the device. In addition, extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

Note: Operation above the maximum specified operating voltage (see Table 3-3 on page 26) is not recommended, and specified typical performance or functional operation of the device is neither implied nor guaranteed.

Table 3-28: Absolute Maximum Ratings

Parameter	Min	Тур	Max	Units				
Power supply voltages								
VBAT_BB	Power Supply Input	0	-	6.0	V			
VBAT_RF	Power Supply Input	0	-	5.5	V			
VDD_Px (low-voltage (1.8V) operation)	Digital pad circuits	-0.5	-	2.3	V			
VDD_Px (high-voltage (2.85V) operation)	Digital pad circuits	-0.5	-	3.35	V			
USB signal pins			-					
USB_D+	High-speed USB data plus	-	-	3.6	V			
USB_D-	High-speed USB data minus	-	-	3.6	V			
USB_VBUS	High-speed USB bus voltage	-	-	5.25	V			
Thermal conditions			-					
TS	Storage temperature	-40		85	°C			
TJ	Junction temperature	-	-	100	°C			
Maximum voltage applied to antenna inte	rface pins		-					
	RF_MAIN	-		6.3	Vdc			
VANT	RF_DIV	-		6.3	Vdc			
	RF_GNSS	-		6.3	Vdc			
ESD ratings		1	ı	1	1			
See EMC and ESD Recommendations on p	age 103.							

#### 3.5.2 Digital I/O Characteristics

The I/O characteristics for supported digital interfaces are described in:

- Table 3-29 GPIOs, UART, ANT\_CNTL, TX\_ON, PCM/I<sup>2</sup>S, SPI, I2C, W\_DISABLE\_N, TP1, WAKE\_ON\_WWAN, and DR\_SYNC signals
- Table 3-30 GPIO8 and GPIO28
- Table 3-31 UIM signals
- Table 3-32 GPIO6, SAFE PWR REMOVE, Clocks

Table 3-29: Digital I/O Characteristics —  $V_{DD\ IO}$  = 1.80 V (nominal)

Param	eter	Notes	Min	Max	Units
$V_{IH}$	High level input voltage	CMOS/Schmitt	$0.65 \times V_{DD\_IO}$	$V_{DD\_IO} + 0.3$	V
$V_{IL}$	Low level input voltage	CMOS/Schmitt	-0.3	0.35 × V <sub>DD_IO</sub>	V
$V_{SHYS}$	Schmitt hysteresis voltage		100	-	mV
V <sub>OH</sub>	High level output voltage	CMOS, at pin-rated drive strength	V <sub>DD_IO</sub> - 0.45	V <sub>DD_IO</sub>	V
V <sub>OL</sub>	Low level output voltage	CMOS, at pin-rated drive strength	0	0.45	V
R <sub>P</sub>	Pull up/down resistance		55	390	kΩ
R <sub>K</sub>	Keeper resistance		30	150	kΩ
I <sub>IH</sub>	Input high leakage current <sup>a</sup>	No pull-down	-	1	μΑ
I <sub>IL</sub>	Input low leakage current <sup>b</sup>	No pull-up	-1	-	μΑ
C <sub>IN</sub>	Input capacitance <sup>c</sup>		-	5	pF
I <sub>PIN</sub>	Current per pin		-	16	mA

- a. Pin voltage = V<sub>DD\_IO</sub>. For keeper pins, pin voltage = V<sub>DD\_IO</sub> 0.45.
  b. Pin voltage = GND and supply = V<sub>DD\_IO</sub>. For keeper pins, pin voltage = 0.45 V and supply = V<sub>DD\_IO</sub>
- c. Input capacitance is guaranteed by design.

Table 3-30: GPIO8 and GPIO28 Digital I/O Characteristics —  $V_{DD\ IO}$  = 1.80 V (nominal)

Param	eter	Notes	Min	Max	Units
$V_{IH}$	High level input voltage	CMOS/Schmitt	$0.65 \times V_{DD\_IO}$	$V_{DD\_IO} + 0.3$	V
V <sub>IL</sub>	Low level input voltage	CMOS/Schmitt	-0.3	0.35 × V <sub>DD_IO</sub>	V
V <sub>SHYS</sub>	Schmitt hysteresis voltage		165	-	mV
V <sub>OH</sub>	High level output voltage	CMOS, at pin-rated drive strength	0.8x V <sub>DD_IO</sub>	V <sub>DD_IO</sub>	V
V <sub>OL</sub>	Low level output voltage	CMOS, at pin-rated drive strength	0	0.2x V <sub>DD_IO</sub>	٧
R <sub>P</sub>	Pull up/down resistance		10	50	kΩ
R <sub>K</sub>	Keeper resistance		10	50	kΩ
I <sub>IH</sub>	Input high leakage current <sup>a</sup>	No pull-down	-	1	μΑ
$I_{\text{IL}}$	Input low leakage current <sup>b</sup>	No pull-up	-1	-	μΑ

Table 3-30: GPIO8 and GPIO28 Digital I/O Characteristics —  $V_{DD\_IO}$  = 1.80 V (nominal)

Param	neter	Notes	Min	Max	Units
I <sub>PIN</sub>	Current per pin		-	16	mA
C <sub>IN</sub>	Input capacitance <sup>c</sup>		-	5	pF

Table 3-31: UIM Characteristics — Dual-voltage  $V_{UIM\_IO}$  = 1.80 V or 2.85 V (nominal)

Param	eter	Notes	Min	Max	Units
Commo	on to UIM dual-voltage pads (1.	8 V / 2.85 V)			
V <sub>IH</sub>	High level input voltage	CMOS/Schmitt	0.7 × V <sub>UIM_IO</sub>	V <sub>UIM_IO</sub> + 0.3	V
V <sub>IL</sub>	Low level input voltage	CMOS/Schmitt	-0.3	0.2 × V <sub>UIM_IO</sub>	V
V <sub>SHYS</sub>	Schmitt hysteresis voltage		100	-	mV
V <sub>OH</sub>	High level output voltage	CMOS, at pin-rated drive strength	0.8 × V <sub>UIM_IO</sub>	V <sub>UIM_IO</sub>	V
V <sub>OL</sub>	Low level output voltage	CMOS, at pin-rated drive strength	0	0.4	V
R <sub>P</sub>	Pull resistance	Pull-up and pull-down	10	100	kΩ
R <sub>K</sub>	Keeper resistance		10	100	kΩ
C <sub>I/O</sub>	I/O capacitance <sup>a</sup>		-	5	pF
Commo	on to UIM pads at 2.85 V only				
I <sub>IH</sub>	Input high leakage current <sup>b</sup>	No pull-down	-	10	μΑ
I <sub>IL</sub>	Input low leakage current <sup>c</sup>	No pull-up	-10	-	μA
Commo	on to UIM pads at 1.8 V only				
I <sub>IH</sub>	Input high leakage current <sup>b</sup>	No pull-down	-	2	μΑ
I <sub>IL</sub>	Input low leakage current <sup>c</sup>	No pull-up	-2	-	μΑ

a. Input capacitance is guaranteed by design.

Table 3-32: GPIO6, SAFE\_PWR\_REMOVE, Clocks —  $V_{DD\ IO}$  = 1.80 V (nominal)

Parame	ter	Notes	Min	Max	Units
V <sub>IH</sub>	High-level input voltage	CMOS/Schmitt	0.65 x V <sub>DD_IO</sub>	V <sub>DD_IO</sub> +0.3	V
V <sub>IL</sub>	Low-level input voltage	CMOS/Schmitt	-0.3	0.35 x V <sub>DD_IO</sub>	V
V <sub>SHYS</sub>	Schmitt hysteresis voltage		15	-	mV
IL	Input leakage current <sup>a</sup>	$V_{DD\_IO}$ = max, $V_{IN}$ = 0 V to $V_{DD\_IO}$	-0.20	+0.20	μΑ
V <sub>OH</sub>	High-level output voltage	I <sub>OUT</sub> = I <sub>OH</sub>	V <sub>DD_IO</sub> - 0.45	V <sub>DD_IO</sub>	V

a. Pin voltage =  $V_{DD\_IO}$ b. Pin voltage = GND and supply =  $V_{DD\_IO}$ 

c. Input capacitance is guaranteed by design.

b. Pin voltage = V<sub>UIM\_IO</sub>

c. Pin voltage = GND and supply =  $V_{UIM\_IO}$ 

Table 3-32: GPIO6, SAFE\_PWR\_REMOVE, Clocks —  $V_{DD\_IO}$  = 1.80 V (nominal) (Continued)

Parameter		Notes	Min	Max	Units
V <sub>OL</sub>	Low-level output voltage	$I_{OUT} = I_{OL}$	0	0.45	٧
I <sub>OH</sub> <sup>c</sup>	High-level output current	V <sub>OUT</sub> = V <sub>OH</sub>	0.15	0.9	mA
I <sub>OL</sub> <sup>c</sup>	Low-level output current	V <sub>OUT</sub> = V <sub>OL</sub>	0.15	0.9	mA
I <sub>OH_XO</sub>	High-level output current	XO digital clock outputs only	6	-	mA
I <sub>OL_XO</sub>	Low-level output current	XO digital clock outputs only	-	-6	mA
C <sub>IN</sub>	Input capacitance <sup>b</sup>		-	5	pF
ı C	Input current	Internal pull-up	0.315	30	mA
I <sub>IN</sub> <sup>c</sup>	Input current	Internal pull-down <sup>d</sup>	-	10	μΑ

<sup>a. The GPIO6 pin complies with the input leakage specification only when configured as a digital input.
b. Input capacitance is guaranteed by design.
c. For GPIO6 only.</sup> 

# 3.5.3 Internal Device Frequencies

Table 3-33 summarizes the frequencies generated within the AirPrime RC76xx. This table is provided for reference only to the device integrator.

Table 3-33: Internal Device Frequencies

Subsystem / Feature	Frequency	Units
Real Time Clock	32.768	kHz
PCM Audio Interface (PCM Master Mode)	4096	kHz
I <sup>2</sup> C Interface	100	kHz
PMIC power supplies switching frequency	1.6	MHz
Fundamental clock	19.2	MHz
PLL	<ul> <li>PLL0: 800.0000</li> <li>PLL1: 614.4000</li> <li>PLL2: 480.0000</li> <li>PLL3: 600.6000</li> <li>PLL4: 576.0000</li> <li>PLL5: 691.2000</li> <li>PLL6: Varies (1.2 GHz max)</li> </ul>	MHz
SPI	38	MHz
USB	480	Mb/s

d. The default status of the internal pull down is 10µA.

# 3.6 Processing

#### 3.6.1 Application Core

The Application Core is based on a Cortex A7 32-bit RISC architecture core. It has the following main characteristics:

- Up to 1.3 GHz operation
- Cache:
  - L1: Instruction (32 kB) and Data (32 kB)
  - L2: 256 kB

The Application Core supports Legato<sup>™</sup>, an open source embedded platform built on ThreadX, which allows the simultaneous safe running of multiple applications.

Refer to Interfaces Specification on page 63 for the list of interfaces supported by this core.

#### 3.6.2 Embedded Memory

The AirPrime RC76xx module includes Flash and RAM embedded memory as detailed in Table 3-34.

Refer to the latest customer release note for any changes regarding embedded memory.

Table 3-34: Embedded Memory Details

Туре	Details	Size
	Total	128 MB
Flash	Reserved for Application processor	8 MB
	Minimum number of write cycles	100, 000
RAM	Total	128 MB
RAIVI	Reserved for Application processor	40 MB

The application processor memory is dedicated to the Legato platform, including:

- ThreadX
- Application framework
- Application

#### 3.6.2.1 Flash Memory

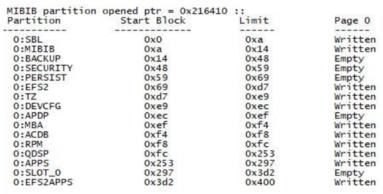
Flash memory is partitioned for use by various elements. Partition APPS can be used by the ThreadX firmware, framework and application. The remaining partitions are reserved for internal use.

Partition: ("sbl") Usage: System bootloader (Internal use) Partition: ("mibib") Usage: Internal use Partition: ("backup") Usage: Internal use Partition: ("security") Usage: Internal use Partition: ("persist") Usage: Internal use Partition: ("efs2") Usage: Internal use Partition: ("tz") Usage: Internal use Partition: ("devcfg") Usage: Internal use Partition: ("sec") Usage: Internal use Partition: ("mba") Usage: Internal use Partition: ("acdb") Usage: Internal use Partition: ("rpm") Usage: Internal use Partition: ("qdsp") Usage: Internal use Partition: ("apps") Usage: ThreadX system Partition: ("slot\_0") Usage: Internal use Partition: ("efs2apps") Usage: Internal use

Figure 3-8: Flash Memory Partitions

Follow these instructions to display partition sizes and to determine whether a customer firmware will fit:

- 1. Connect to the RC module.
- 2. Use Trace32 command. Partition sizes are listed in the 'Start block' and 'Limit' columns.



----- Done -----

3. When building an image, use the swicwe command to display the sizes of the image components to ensure that they can fit in the associated partitions. For example:

/pe	Size (Excluding Header)	Product	Compress	Version
PKG	46239368	9X28	0	INTERNAL_?_SWI9X07H_00.01.01.00_?_?_?_?
BOOT	408820	9X28	0	SWI9X07H_00.01.01.00 000000 jenkins 2019/10/18 11:04:20
BL1	408420	9X28	0	SWI9X07H_00.01.01.00 000000 jenkins 2019/10/18 11:04:20
MODM	41054276	9X28	0	SWI9X07H_00.01.01.00 000000 jenkins 2019/10/18 11:04:20
ZON	934800	9X28	0	SWI9X07H_00.01.01.00 000000 jenkins 2019/10/18 11:04:20
	ype SPKG BOOT BL1 MODM ZON	SPKG 46239368 BOOT 408820 BL1 408420 MODM 41054276	SPKG         46239368         9X28           BOOT         408820         9X28           BL1         408420         9X28           MODM         41054276         9X28	SPKG         46239368         9X28         0           BOOT         408820         9X28         0           BL1         408420         9X28         0           MODM         41054276         9X28         0

#### 3.6.3 Recovery Mechanism

The AirPrime RC76xx has the capability to automatically detect and recover from various corruption scenarios (for example, corruption may occur when power is abruptly removed from the module).

A backup of the configuration stored in the file system is created before the RC76xx leaves the Sierra Wireless factory. The file system backup can be updated at customer factories using **AT!NVBACKUP**. If a file system corruption is detected, the stored backups are checked and the most recent backup is automatically restored.

To avoid the potential for memory corruption, make sure to always follow the proper power off procedure before removing power from the module. (Figure 4-1 on page 64 illustrates the signal timing details for powering off the module.)

#### 3.6.4 Secure Boot / Secure Debug

AirPrime RC76xx modules incorporate the following permanently enabled features to enhance device security:

- Secure Boot—Ensures only firmware images signed by Sierra Wireless can be loaded and run on the RC76xx modules. Specifically, Secure Boot applies to the following firmware components: system boot loader, carrier configuration, and telecom FW.
- Secure Debug—Disables debug features such as RAM dump collection and JTAG access to the module.

For additional details, refer to application notes available on <a href="http://source.sierrawireless.com">http://source.sierrawireless.com</a>.

# 3.7 Mechanical Drawing

The AirPrime RC76xx module's LGA footprint is a 239-pad array of copper pads (see Physical Dimensions and Connection Interface on page 14). The following drawing illustrates the device footprint and dimensions.

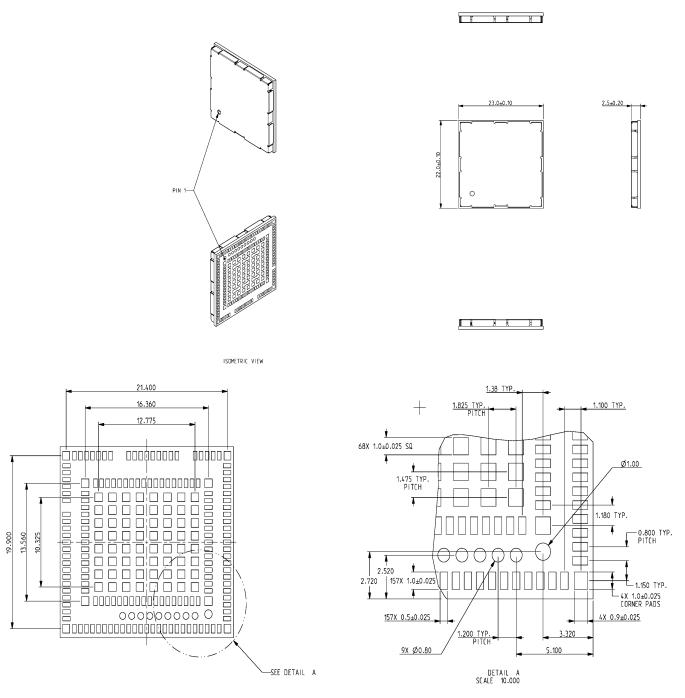


Figure 3-9: Mechanical Drawing

# 3.8 Mechanical Specifications

The following table describes additional mechanical specifications for the AirPrime RC76xx module.

Table 3-35: Mechanical Specifications

Specification	Value	Notes
Clamping force	20 psi	Maximum clamping force on module over entire shield surface.

# >> 4: Interfaces Specification

This section describes the interfaces supported by the AirPrime RC76xx embedded module and provides specific voltage, timing, and circuit recommendations for each interface.

### 4.1 POWER\_ON\_N

The AirPrime RC76xx module requires a low level signal (POWER\_ON\_N) that is used to switch the module ON.

The signal is connected internally to the permanent 1.8V supply regulator inside the module via a pull-up resistor. Once VBAT\_BB is supplied to the module, this 1.8V supply regulator will be enabled and so the POWER\_ON\_N signal is by default at high level.

The module turns on when POWER\_ON\_N is asserted over 200 ms.

Table 4-1 describes the POWER\_ON\_N signal's characteristics.

Table 4-1: POWER\_ON\_N Electrical Characteristics<sup>a</sup>

Parameter	Min	Тур	Max	Units
Input Voltage—Low		-	0.67	V
Internal pull-up resistor	150	200	250	kΩ

a. When floating, voltage will be approximately 800 mV.

#### 4.1.1 Power-up Sequence

#### 4.1.1.1 Power On/Off Timing

Note: The host should not drive any signals to the module until the VGPIO raises up (approximately 100 ms after power ups). Before reaching the "Active" state, signals on the host port must be set to "floating, high impedance, or input pull-down". This setting also applies when the module is in reset mode, during a firmware update, or during a power-off sequence. The host must consider this signal setting when designing the module interface.

Figure 4-1 describes the timing sequence for powering the module on and off.

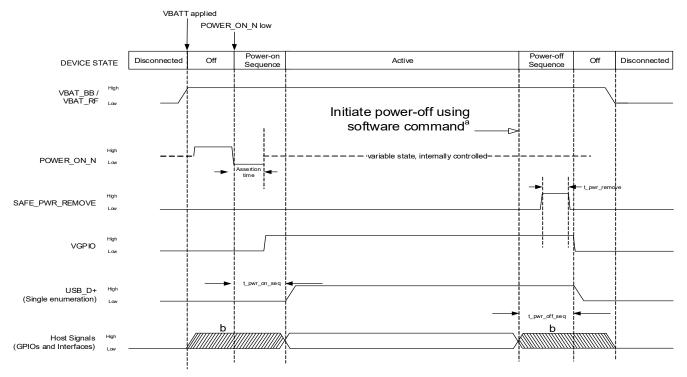


Figure 4-1: Signal Timing (POWER\_ON\_N, and USB Enumeration)

- **a.** After the **AT!POWERDOWN** command, the host should ensure that all of the I/O connected to the module are actually either into HighZ, floating, or input pull-down, before the VGPIO switches off.
- **b.** When the module is not on active status, the host should ensure that all of the I/O connected to the module are actually either into HighZ, floating, or input pull-down.

Table 4-2: POWER_ON_N T	ıımıng	Parameters
-------------------------	--------	------------

Parameter	Typical	Maximum	Units
t_pwr_on_seq	15	24 <sup>a</sup>	S
t_pwr_off_seq	0.4-5.5	6	S
t_pwr_remove	13	-	ms
POWER_ON_N assertion time <sup>b</sup>	200		

- a. Value is based on disabled custom parameter "BOOTQUIETDISABLE". Note that there will be an increase in value if this custom parameter is enabled.
- b. Assertion time is the time required to keep POWER\_ON\_N at LOW level to ensure the module can be powered ON successfully.

Note: When POWER\_ON\_N is asserted over 200 ms, the module will turn on. If POWER\_ON\_N (signal level = low) is kept over 8 s then de-asserted, the module will turn off. If the POWER\_ON\_N pin is always kept asserted (signal level = low, For example: always connected to GND), the module can be turned on or off via controlling the input power. The module will not go into PSM mode when the POWER\_ON\_N pin is kept asserted.

#### 4.1.1.2 USB Enumeration

The unit supports single USB enumeration with the host. Enumeration starts within (maximum) t\_pwr\_on\_seq seconds of power-on.

#### 4.1.2 Software-Initiated Power Down

To power down the module via software:

- 1. Initiate the power down process using AT! POWERDOWN.
- Monitor VGPIO and SAFE\_PWR\_REMOVE.
- **3.** When VGPIO and SAFE\_PWR\_REMOVE are on the low level, remove power.

Note: If the VGPIO cannot be monitored from the design interface, measure the delay time (pulse from SAFE\_PWR\_REMOVE to VGPIO must = 0, refer to Figure 4-1 for details) and include this information in the firmware to ensure that power can be removed safely.

## 4.2 Emergency Power Off

The module can be switched off by controlling the RESET\_IN\_N pin. This must only be used in emergency situations if the system freezes (not responding to commands).

To perform an emergency power off:

- 1. De-assert POWER ON N.
- 2. While POWER\_ON\_N is de-asserted, assert RESET\_IN\_N (logic low) for at least 8 s. This immediately powers down the module.

# 4.3 POWER\_ON\_N, RESET\_IN\_N and AT!POWERDOWN Use Cases

Table 4-3 lists the behavior of the RC76xx depending on POWER\_ON\_N, RESET\_IN\_N and AT! POWERDOWN use cases.

Table 4-3: POWER\_ON\_N, RESET\_IN\_N and AT!POWERDOWN Use Cases

Use Case	Behavior	
DOWED ON N	VBATT is applied then POWER_ON_N is asserted	Turns ON
POWER_ON_N	POWER_ON_N is asserted then VBATT is applied	Turns ON
	POWER_ON_N is left asserted then RESET_IN_N is asserted	Resets
RESET_IN_N <sup>a</sup>	POWER_ON_N is de-asserted then RESET_IN_N is asserted	Resets
	POWER_ON_N is de-asserted then RESET_IN_N is asserted with a long pulse (>8 sec)	Emergency OFF
AT! POWERDOWN	POWER_ON_N is asserted then the power OFF command is sent	Restarts
	POWER_ON_N is de-asserted then the power OFF command is sent	Turns OFF

This pin should only be used for emergencies such as when the module stops responding to AT commands.

#### 4.4 Tx Power Control

The module's Tx power limit may be controlled using the following methods:

- SAR backoff AT commands (see document [1] AirPrime RC76xx AT Command Reference):
  - ! SARSTATEDFLT Set (or report) the default SAR backoff state that the device uses when it powers up. This setting is persistent across power cycles and overrides any PRI setting.
  - ! SARSTATE Set (or report) the current SAR backoff state (override the default state). This change in state is non-persistent across power cycles.
  - ! SARBACKOFF Set (or report) the maximum Tx power limit for a specific band / technology / state combination.
- · Legato commands:
  - · le mrc GetSarBackoffState() Get the current SAR Backoff state.
  - le\_mrc\_SetSarBackoffState() Set the current SAR Backoff state (override the default state). This change is non-persistent across power cycles.
- GPIO control via !SARGPIO command (see [1] AirPrime RC76xx AT Command Reference)—Set an unallocated external GPIO to control SAR.

#### **4.5 USB**

The AirPrime RC76xx implements a high-speed USB 2.0 Interface, which conforms to *Universal Serial Bus Specification, Revision 2.0*.

Table 4-4: USB Pin Descriptions

Pin	Signal Name	Direction	Function
12	USB_D-	Input/Output	Differential data interface negative
13	USB_D+	Input/Output	Differential data interface positive
16	USB_VBUS	Input	USB supply voltage

Table 4-5: USB\_VBUS Characteristic

USB		Value	Units
	Voltage range	4.75 - 5.25 or VBAT_BB	V
USB_VBUS	Maximum Current Drawn	1	mA
	Maximum Input Capacitance (Min ESR = $50 \text{ m}\Omega$ )	10	μF

Note: The USB interface has routing constraints. For details, refer to Figure 5-9.

#### **4.6 UART**

The AirPrime RC76xx provides two UART interfaces:

- UART1 (primary UART) 8-wire interface
- UART2 (secondary UART) 4-wire interface

The UART interfaces are used for data communication between the module and a PC or host processor. These interfaces comply with the RS-232 interface.

Flow control is managed using the UART\_RTS and UART\_CTS signals.

Table 4-6 on page 68 describes the signals used for UART1 and UART2.

Note: UART signals are named with respect to the host device, and directions are listed with respect to the module. For example, UART1\_RX is an output from the module to the host. WIFI coex and 8-wire UART concurrency is not supported.

Table 4-6: UART Pins

Pin	Interface	Name <sup>a</sup>	Directionb	Function	If Unused	Notes
2		UART1_RI <sup>c</sup>	Output	Ring Indicator Signal incoming calls (voice and data), SMS, etc.	Leave open	Do not install external pull-up on this pin, otherwise the module will not boot.
3		UART1_RTS	Input	Ready To Send	Leave open	
4		UART1_CTS	Output	Clear To Send	Leave open	
5		UART1_TX	Input	Transmit Data	Leave open	
6		UART1_RX	Output	Receive Data	Leave open	
7	UART1	UART1_DTR <sup>d</sup>	Input (active low)	Data terminal ready Prevents the RC76xx from entering sleep mode, switches between data mode and command mode, and wakes the module.	Leave open	
8		UART1_DCD	Output	Data Carrier Detect Signal data connection in progress	Leave open	Do not install external pull-up on this pin, otherwise the module will not boot.
9		UART1_DSR	Output	Data Set Ready Signal UART interface is ON	Leave open	Do not install external pull-up on this pin, otherwise the module will not boot.

Table 4-6: UART Pins (Continued)

Pin	Interface	Name <sup>a</sup>	Direction <sup>b</sup>	Function	If Unused	Notes
96		UART2_TX	Input	Transmit data	Leave open	
97	UART2	UART2_RX	Output	Receive data	Leave open	
98	UARTZ	UART2_RTS	Input	Ready To Send, flow control	Leave open	
99		UART2_CTS	Output	Clear To Send, flow control	Leave open	

- a. Signals are named with respect to the host device. For example, UART1\_RX is the signal used by the host to receive data from the module
- b. Signal direction with respect to the module. For example, UART1\_RX is an output from the module to the host.
- c. RI can be used independently and supports the following AT commands: AT+WWAKESET and AT+WRID.
- d. Pin is 'wakeable'. Can be used to trigger the module to wake up from sleep state. See Wakeup Interrupt (Sleep State) on page 75 for details.

#### 4.7 UIM Interface

The AirPrime RC76xx has two physical UIM interfaces:

- UIM1 this interface allows control of 1.8V or 2.85V UIMs. It also supports single
  or external dual SIMs. For usage details, see Figure 4-2 and Figure 4-3.
- UIM2 this interface is used to control an eSIM on selected variants.

Note: UIM1 and UIM2 cannot be activated simultaneously (DSSS).

#### 4.7.1 External UIM1 Interface

Table 4-7 describes the signals used for UIM1.

Table 4-7: UIM1 Interface Pins

Pin	Name	Direction <sup>a</sup>	Function	If Unused
26	UIM1_VCC	Output	Supply output	Leave open
27	UIM1_CLK	Output	Clock	Leave open
28	UIM1_DATA	Input/Output	Data connection	Leave open
29	UIM1_RESET_N	Output	Reset	Leave open
64	UIM1_SIMA_DET <sup>b</sup>	Input	Detect UIM	Leave open
65	UIM1_SIMB_DET/ GPIO4	Input	Detect UIMB	Leave open
46	Ext_SIM_switch	Output	Switch between UIMA and UIMB	Leave open

a. Signal direction with respect to the module. Examples: UIM1\_SIMA\_DET (pin 64) is an input to the module from the host; UIM1\_RESET\_N (pin 29) is an output from the module to the host.
 b. Pin is 'wakeable'. Can be used to trigger the module to wake up from sleep mode. See Wakeup

b. Pin is 'wakeable'. Can be used to trigger the module to wake up from sleep mode. See Wakeup Interrupt (Sleep State) on page 75 for details.

#### 4.7.2 eSIM / UIM2 Interface

Whether an embedded eSIM is provided or not, UIM2 signals are not available externally.

Selection of active SIM between UIM1 (external SIM) and UIM2 (eSIM) is possible using AT commands **AT!UIMS** and **AT!CUSTOM="UIMAUTOSWITCH"**. Refer to document [1] AirPrime RC76xx AT Command Reference for more details regarding these commands.

When UIM2 is deselected, the eSIM component is unpowered.

#### 4.7.3 External SIM Switch Configuration

The UIM1 interface can be used with either a single external SIM, or with two external SIMs, using an external switch. The external switch is controlled by GPIO6 (pin 46), and GPIO4 is used to detect the second external SIM.

An external PU should be provided on the UIM2\_DET.

#### 1 external SIM card

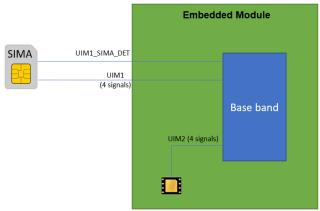


Figure 4-2: Single External SIM Configuration

Note: Figure 4-2 illustrates the recommended implementation of a single external SIM configuration. For a detailed UIM schematic, see Figure 5-7.

# 2 external SIM cards (with 2 dedicated SIM detects)

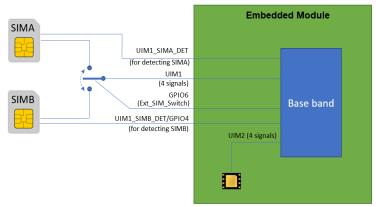


Figure 4-3: Dual External SIM Configuration

Note: Figure 4-3 illustrates the recommended implementation of a dual external SIM configuration. For a detailed external SIM schematic, see Figure 5-8.

Supports two external SIM and signal switching using GPIO6, while SIM B is detected by GPIO4. See GPIO6 and GPIO4 for details.

# 4.8 General Purpose Input/Output (GPIO)

The AirPrime RC76xx defines several GPIOs for customer use, as described in Table 4-8. For electrical specifications, see Table 3-29 on page 54 and Table 3-30 on page 54.

Note: There should not be any voltage applied to the GPIOs when the module is off or resetting..

Table 4-8: GPIO Pin Description

Pin	Signal Name	Edge Wakeable	Default State	Function	If Unused
10	GPIO2 <sup>a</sup>	Yes			
40	GPIO7	Yes			
41	GPIO8				
44	GPIO13	Yes			
46	GPIO6 <sup>c</sup>	Yes			
65	GPIO4 <sup>d</sup>				
101	GPIO35	Yes			
104	GPIO32				
105	GPIO33				
109	GPIO42 <sup>a</sup>	Yes	PDb	General purpose I/O	Leave open
147	GPIO21 <sup>a</sup>	Yes			
148	GPIO22	Yes			
149	GPIO23				
150	GPIO24	Yes			
153	GPIO28 <sup>e</sup>				
154	GPIO29 <sup>e</sup>				
155	GPIO30 <sup>e</sup>				
156	GPIO31 <sup>e</sup>				
159	GPIO25				

Pin is 'wakeable'. Can be used to trigger the module to wake up from sleep mode. See Wakeup Interrupt (Sleep State) on page 75 for details.

b. Internal configuration of all GPIOs—internal input pull-down.

c. See GPIO6.

d. See GPIO4.

e. This pin is available for use when configured using AT+WIOCFG.

#### 4.9 **GPIO4**

GPIO4 can be used for two different functions as described below.

#### 4.9.1 SIM Detect (default function)

GPIO4 can provide a detect function to the external UIM2 to detect the physical presence of a UIM card in the UIM holder. The signal needs an external pull-up resistor on it.

The UIM detect signal transitions:

- When a UIM is inserted—high (logic 0 to logic 1)
- When a UIM is removed—low (logic 1 to logic 0)

To use this pin for SIM detect, enable the feature using:

- 1. AT!CUSTOM="EXTUIMSWITCHEN",1
- 2. AT+KSIMSEL=2
- 3. Reboot the module.

#### 4.9.2 General Purpose Input / Output

To configure this pin as a GPIO:

- 1. Disable external SIM detect feature using AT!UNLOCK="A710".
- 2. Use AT+CUSTOM="UIM2ENABLE", 0.
- 3. Reboot the module.
- 4. Configure GPIO4 using AT+WIOCFG=4,4.
- 5. The default GPIO state is a digital input pull-down function.

#### 4.10 GPIO6

GPIO6 can be used for three different functions as described below. Refer to [1] AirPrime RC76xx AT Command Reference for AT command details to configure GPIO6.

#### 4.10.1 SIM Switching (default function)

To use this pin for fast SIM switching, enable the feature using AT!CUSTOM="EXTUIMSWITCHEN", 1.

## 4.10.2 General Purpose Input / Output

To configure this pin as a GPIO:

- 1. Disable external SIM switch feature using AT!CUSTOM="EXTUIMSWITCHEN", 0.
- 2. Configure GPIO6 using AT+WIOCFG=6, 4.
- 3. Reboot the module.

4. The default GPIO state is a digital input with 10 µA pull-down function.

## 4.10.3 RESET\_OUT\_N

This pin can be used to provide a signal that will hold peripheral devices (such as a USB hub, I<sup>2</sup>C device, etc.) in reset until the power-up sequence is complete.

To configure this pin as Reset:

- 1. Disable external SIM switch feature using AT!CUSTOM="EXTUIMSWITCHEN", 0.
- 2. Configure GPIO6 using AT+WIOCFG=6, 0.

Note: For details, refer to the AirPrime RC76xx AT Command Reference guide.

3. Reboot the module.

When the module is:

- In reset or powering up this pin is held low to put peripheral devices in reset.
   Once the power-on sequence is complete, this pin will be turned high to take the peripherals out from reset.
- In PSM this pin will keep its previous status.

For timing details between RESET\_IN\_N and RESET\_OUT\_N, see Reset Signals (RESET\_IN\_N and RESET\_OUT\_N).

# 4.11 Wakeup Interrupt (Sleep State)

The following pins can be used to wake the device when it is in Sleep state:

- GPIO2
- GPIO21
- GPIO42
- UART1 DTR
- UIM1\_SIMA\_DET

The GPIO pins can be configured as a wakeup source by using the AT+WIOCFG command (see [1] AirPrime RC76xx AT Command Reference).

If the device firmware is monitoring these pins while the device is in sleep mode, any transition on these pins will wake the device.

Note: These signals wake the device when it is in Sleep state. If the device is in PSM, it is woken by configured wakeup triggers—see Wakeup Events (PSM) for details.

# 4.12 Wakeup Events (PSM)

The following signals/sources can be used to wake the device from PSM:

Table 4-9: PSM Wakeup Signals/Sources

Signal Configuration	Signal
Configurable	Timer
Always enabled	POWER_ON_N
Always enable	RESET_IN_N

Note: These signals wake the device only when it is in PSM. If the device is in Sleep state, it can be woken using the signals described in Wakeup Interrupt (Sleep State) on page 75.

For PSM details, see Table 3-5 on page 28.

# 4.13 I<sup>2</sup>C Interface

The AirPrime RC76xx module provides one I<sup>2</sup>C (Inter-Integrated Circuit) dedicated serial port (bus interface) based on [6] I2C Bus Specification, Version 5.0, October 2012.

The interface uses the pins indicated in Table 4-10.

Table 4-10: I<sup>2</sup>C Interface Pins

Pin	Signal Name	Direction	Function	If Unused	Duration Boot or Reset Status
1	I2C1_CLK	Input/Output	I <sup>2</sup> C Clock	Leave open	Internal pull- down
66	I2C1_DATA	Input/Output	I <sup>2</sup> C Data	Leave open	Internal pull- down

This implementation of the I<sup>2</sup>C interface includes the following characteristics:

- Supported voltage 1.8 V
- Standard-mode interface data transfer rates up to 100 kbit/s
- Master mode operation only the module always operates as the master
- I<sup>2</sup>C signals are implemented internally as open drain outputs (per the I<sup>2</sup>C specification) with 2.2 kΩ pull-up resistors to VGPIO (see Figure 4-4 on page 76).

Note: I<sup>2</sup>C slave address 0x1A is reserved for internal use.

For  $I^2C$  bus details, including I2C bus waveform and timing details, refer to the I2C Bus Specification.

## 4.13.1 Application

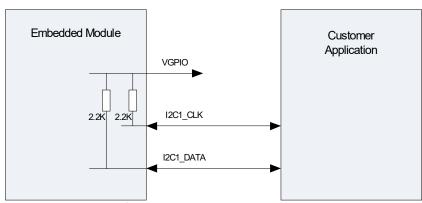


Figure 4-4: Example of I<sup>2</sup>C Bus Application

#### **4.14 VGPIO**

The AirPrime RC76xx utilizes 1.8V logic, provided via the VGPIO (GPIO voltage output) pin.

Table 4-11: VGPIO Reference Pin

Pin	Signal Name	Direction <sup>a</sup>	Function	If Unused
45	VGPIO	Output	GPIO voltage output	Leave open

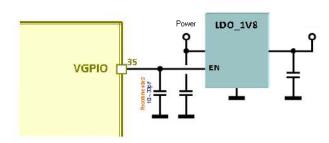
Signal direction with respect to the module—VGPIO (pin 45) is an output from the module to the host.

Table 4-12: VGPIO Electrical Characteristics

Parameter	Min	Тур	Max	Unit	Remarks
Voltage level	1.7	1.8	1.9	٧	Applies to active mode and sleep mode
Current capability	ability 50 mA Power Management support up to output		Power Management support up to 50 mA output		

The VGPIO voltage is available when the module is switched ON, and can be used to:

- Pull up signals such as I/Os
- Supply external digital transistors driving LEDs
- Act as a voltage reference for the ADC interfaces
- Supply external circuitry. Make sure you do not exceed the maximum current capability. Use an external regulator if a higher consumption is required,.



Note: VGPIO is at a high level (1.8V) when the module is in active or sleep mode. VGPIO is off (high impedance), when the module is in PSM or in off mode.

# 4.15 Reset Signals (RESET\_IN\_N and RESET\_OUT\_N)

The AirPrime RC76xx provides an interface to allow an external application to reset the module (RESET\_IN\_N) and reset the peripheral device (RESET\_OUT\_N).

Note: Using RESET\_IN\_N to reset the module could result in memory corruption if used inappropriately. This signal should only be used if the module has become unresponsive and it is not possible to perform a power cycle.

Table 4-13: RESET Pins

Pin	Signal Name	nal Name Direction <sup>a</sup> Function		If Unused
11	RESET_IN_N	Input	External Reset Input	Leave open
46 (GPIO6)	RESET_OUT_N	Output	Peripheral devices reset	Leave open

Signal direction with respect to the module—RESET\_IN\_N (pin 11) is an input to the module from the host.

The RESET\_IN\_N signal is internally pulled-up with  $40k\Omega$ . An open collector transistor or equivalent should be used to ground the signal when necessary to reset the module.

To reset the module, a low level pulse must be applied on the RESET\_IN\_N pin. This will immediately restart the module.

The RESET\_IN\_N signal will reset the registers of the CPU and reset the RAM memory as well, for the next power on.

Table 4-14: Reset Timing

Symbol	Parameter	Min	Тур	Max
Trdet	Duration of RESET_IN_N signal before firmware detects it (debounce timer)	-	32 ms	-
Trlen1	Duration RESET_IN_N asserted	42 ms	-	-
Trlen2	Duration RESET_OUT_N asserted	420 ms	-	-
Trdel1	Delay between minimum Reset duration and internal reset generated	18 ms	-	-
Tduration	Duration time from RESET_IN_N falling edge to RESET_OUT_N	50 ms	-	-

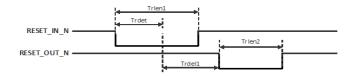


Figure 4-5: Reset timing when RESET\_IN\_N < Trdel1

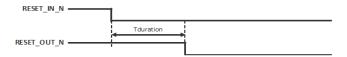


Figure 4-6: Reset timing when RESET\_IN\_N is held low

#### 4.16 ADC

The AirPrime RC76xx provides two general purpose ADC (Analog to Digital Converter) inputs, as described Table 4-15 and Table 4-16.

Table 4-15: ADC Interface Pins

Pin	Signal Name	Direction <sup>a</sup>	Function	If Unused
24	ADC1	Input	Analog to Digital Converter	Leave open or Ground
25	ADC0	Input	Analog to Digital Converter	Leave open or Ground

Signal direction with respect to the module. Example: ADC1 (pin 24) is an input to the module from the host.

**Table 4-16: ADC Interface Characteristics** 

Parameter	Value	Units
Full-scale voltage level	0.1–1.7	V
Resolution	15	bit
Sample rate	2.4	MHz
Voltage error	8 (Typ), 16 (Max)	mV

# 4.17 Digital Audio

The AirPrime RC76xx provides a 4-wire digital audio interface that can be configured as either PCM (Pulse Code Modulation) or I<sup>2</sup>S (Inter-IC Sound).

Table 4-17 on page 80 describes the audio interface signals.

Note: Audio availability is firmware-dependent.

Table 4-17: PCM/I<sup>2</sup>S Interface Signals

Pin	Signal name	Direction <sup>a</sup>	Function	If Unused	
33	PCM_OUT	Output	PCM Data Out The frame "data out" relies on the selected configuration mode.	Leave open	
33	I2S_OUT	Output	I2S Data Out The frame "data out" relies on the selected configuration mode.	Leave open	
3/1	PCM_IN		PCM Data In The frame "data in" relies on the selected configuration mode.		
34			I2S Data In The frame "data in" relies on the selected configuration mode.	Leave open	
	PCM_SYNC	Input/Output in Primary mode	PCM Sync The frame synchronization signal delivers an 16 kHz frequency pulse that synchronizes the frame data in and the frame data out.		
35	35 I2S_WS Output is		I2S Word Select The word select clock indicates which channel is currently being transmitted (low cycle indicates left audio channel, high cycle indicates right audio channel).	Leave open	
36	PCM_CLK Input/Output in Primary mode		PCM Clock The frame bit clock signal controls data transfer with the audio peripheral.		
30	I2S_CLK	Output	I2S Clock The frame bit clock signal controls data transfer with the audio peripheral.	Leave open	

a. Signal direction with respect to the module. Examples: PCM\_IN (pin 34) is an input to the module from the host; PCM\_OUT (pin 33) is an output from the module to the host.

#### 4.17.1 PCM

Table 4-18 defines the PCM interface configuration. Data Format

Table 4-18: PCM Interface Configurations

Element	PCM
Slot configuration	Slot-based
Sync type	Short
Clock (Master)	4096 KHz
Data formats	16-bit linear
Mode	Master

#### 4.17.1.1 Data Format

The PCM data is 16 kHz and 16 bits with the following PDM (Pulse-density modulation) bit format:

- PCM\_DIN SDDD DDDD DDDD DDVV
- PCM\_DOUT SDDD DDDD DDDD DDVV

#### Where:

- S Signed bit
- D Data
- V Volume padding

#### 4.17.1.2 Timing

The following table and drawings illustrate PCM signals timing when operating in PCM mode.

Table 4-19: PCM Mode Timing<sup>a</sup>

Parameter	Description	Min	Тур	Max	Units
t(sync)	PCM_SYNC cycle time	-	62.5	-	μs
t(synch)	PCM_SYNC high time	-	31.3	-	μs
t(syncl)	PCM_SYNC low time	-	31.2	-	μs
t(clk)	PCM_CLK cycle time	-	244	-	ns
t(clkh)	PCM_CLK high time	-	122	-	ns
t(clkl)	PCM_CLK low time	-	122	-	ns
t(susync)	PCM_SYNC setup time high before falling edge of PCM_CLK	-	122	-	ns
t(sudin)	PCM_IN setup time before falling edge of PCM_CLK	60	-	-	ns
t(hdin)	PCM_IN hold time after falling edge of PCM_CLK	10	-	-	ns

Table 4-19: PCM Mode Timing<sup>a</sup> (Continued)

Parameter	<b>Description</b> N		Тур	Max	Units
t(pdout)	Delay from PCM_CLK rising to PCM_OUT valid	-	-	60	ns
t(zdout)	Delay from PCM_CLK falling to PCM_OUT HIGH-Z	-	160	-	ns

a. Maximum PCM clock rate is 4.096 MHz.

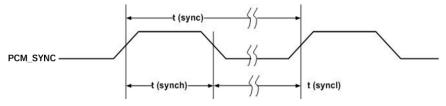


Figure 4-7: PCM\_SYNC Timing Diagram (4.096 MHz clock)

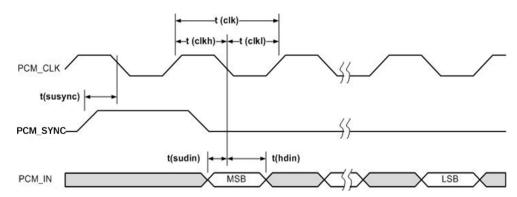


Figure 4-8: PCM Codec to Device Timing Diagram

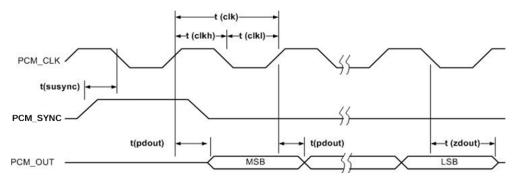


Figure 4-9: Device to PCM Codec Timing Diagram

## 4.17.2 I<sup>2</sup>S

The I<sup>2</sup>S interface can be used to transfer serial digital audio to or from an external stereo DAC/ADC and supports the following features:

- Mode: Master (Slave mode is not supported)
- Sampling rate: 16 kHz
- Bits per frame: 16

#### Bit clock: 512 kHz

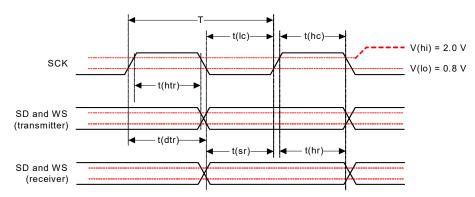


Figure 4-10: I<sup>2</sup>S Transmitter Timing

Table 4-20: I<sup>2</sup>S Interface Timing<sup>a</sup>

Parameter	Description	Min	Тур	Max	Units
	Frequency	-	-	12.288	MHz
Т	Clock period	81.380	-	-	ns
t(hc)	Clock high	0.45×T	-	0.55×T	ns
t(lc)	Clock low	0.45×T	-	0.55×T	ns
t(sr)	SD and WS input setup time	16.276	-	-	ns
t(hr)	SD and WS input hold time	0	-	-	ns
t(dtr)	SD and WS output delay	-	-	65.100	ns
t(htr)	SD and WS output hold time	0	-	-	ns

a. Load capacitance is 10-40 pF

# **4.18 SPI Bus**

The AirPrime RC76xx module provides one 4-wire serial peripheral interfaces (SPI1).

The following features are available on the SPI bus:

- Mode: Master (Slave mode is not supported)
- SPI speed from 960 kbps to 25 Mbps in master mode operation
- 4-wire interface
- 4 to 32 bits data length
- 38 MHz clock frequency

Table 4-21 on page 84 describes the SPI interface pins.

Pin	Signal Name	Direction <sup>a</sup>	Description	Reset State	I/O Type
51	SPI1_MRDY	Output	SPI Master Ready		
52	SPI1_MISO	Input	SPI Master Input/Slave Output (output from slave)	Internal	
53	SPI1_CLK	Output	SPI serial clock (output from Master)	Pull-Down	1V8
54	SPI1_MOSI	Output	SPI Master Output/Slave Input (output from master)		

Table 4-21: SPI Pin Descriptions

# 4.18.1 Configuration

Table 4-22: SPI Configuration

Operation	Max Speed	SPI-Mode	Duplex	4-wire Type
Master	25 Mb/s	0,1,2,3	Full	<ul><li>SCLK (SPI1_CLK)</li><li>MOSI (SPI1_MOSI)</li><li>MISO (SPI1_MISO)</li><li>SS (SPI1_MRDY)</li></ul>

#### 4.18.2 Waveforms

The following figure shows waveforms for SPI transfer using a 4-wire configuration.

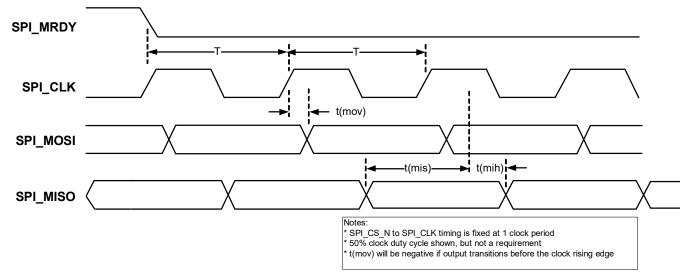


Figure 4-11: 4-Wire Configuration SPI Transfer

Signal direction with respect to module. Examples: SPI1\_MISO (pin 52) is an input to the module from the host; SPI1\_CLK (pin 53) is an output from the module to the host.

tames the second terms of							
Paramete	r	Min	Тур	Max	Unit		
SPI clock frequency		-	-	38	MHz		
T <sup>a</sup>	SPI clock period	20.0	-	-	ns		
t(ch)	Clock high	9.0	-	-	ns		
t(cl)	Clock low	9.0	-	-	ns		
t(mov)	Master output valid	-5.0	-	-5.0	ns		
t(mis)	Master input setup	5.0	-	-	ns		
t(mih)	Master input hold	1.0	_	_	ns		

Table 4-23: SPI Master Timing Characteristics (@38 MHz)

# 4.18.3 Application

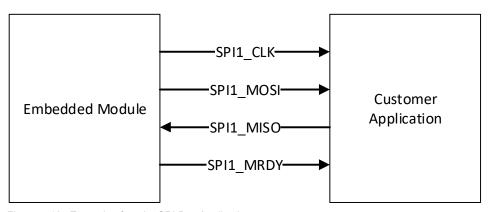


Figure 4-12: Example of 4-wire SPI Bus Application

#### 4.19 Clock

The AirPrime RC76xx supports two digital clock interfaces that are connected directly from the PMIC.

Table 4-24 describes the clock interface pins.

**Table 4-24: Clock Interface Pin Descriptions** 

Pin	Signal Name	I/O	I/O Type	Description	If Unused
22	SYS_CLK	Output	1.8V	19.2 MHz digital clock output	Leave open
23	SLEEP_CLK	Output	1.8V	32.768 kHz digital clock output	Leave open

a. Minimum clock period includes 1% jitter of the maximum frequency

# 4.20 TP1 (Boot Pin)

The TP1 pin (boot pin) can be used for two primary purposes:

- The pin can be used to force the module to enter boot-loader mode on power-up Connect the pin to a control mechanism (for example, a button, switch, or jumper) on the host platform, and use this mechanism to assert (drive low) the TP1 pin on power-up. The boot loader monitors the TP1 pin and when it detects a low signal, prevents normal power-up and prepares to download firmware via the DM port.
  - When the module has restarted and entered boot-loader mode, make sure to deassert the TP1 pin. When the firmware download finishes, the module reboots automatically and the de-asserted pin allows the module to boot normally.
- If not connected to a control mechanism, at minimum the pin should be connected to a test point on the host platform, for use by Sierra Wireless in RMA debugging.

Note: Firmware downloads also occur using software tools available on <a href="http://source.sierrawireless.com">http://source.sierrawireless.com</a> or over the air using an AirVantage server.

Table 4-25: TP1 Pin Description

Pin	Name	Direction	Function	If Unused
47	TP1	Input	Device recovery (boot load)	Mandatory test point

# 4.21 Temperature Monitoring

The AirPrime RC76xx provides internal temperature monitoring of the module's baseband thermistor, as detailed below in Figure 4-13 and Table 4-26.

The temperature state can be queried directly, and unsolicited notifications of temperature state transitions can be received by using:

- AT! PATEMP Display the current temperature state (normal, hi or low warning, hi or low critical).
- AT+WUSLMSK Enable unsolicited notifications for ! PATEMP, to be received over the AT port whenever the state changes.

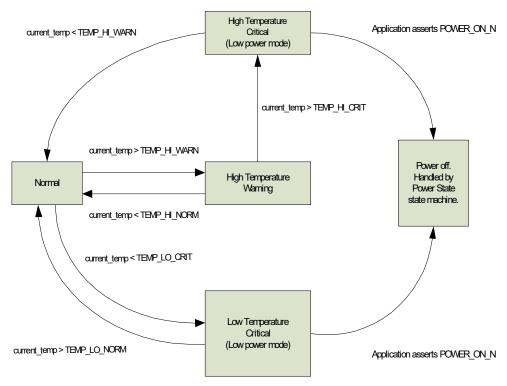


Figure 4-13: Temperature Monitoring State Machine

**Table 4-26: Temperature Monitoring States** 

State	Description	Threshold	Default Temp Value (C) <sup>a</sup>	Functionality
Normal	PA thermistor is between	TEMP_HI_NORM	+100	Class A
Nomiai	PA thermistor is between	TEMP_LO_NORM	-40	Class B
High Temperature Warning	PA thermistor has exceeded	TEMP_HI_WARN	+105	Class B
High Temperature Critical	PA thermistor has exceeded	TEMP_HI_CRIT	+110	Low Power Mode
Low Temperature Critical	PA thermistor has descended past	TEMP_LO_CRIT	-45	Low Power Mode

a. Junction (PA thermistor) temperature

To restore full operation, the PA thermistor's temperature reading must be within the normal or high temperature warning state thresholds.

#### 4.22 Test Pins

Sierra Wireless requires test points on the customer application for Sierra Wireless RMA and debug service.

Table 4-27: Test Pin Descriptions

Pin	Name	Function	If Unused
236	J1	Test point	Mandatory test point
237	J2	Test point	Mandatory test point
238	J3	Test point	Mandatory test point
239	J4	Test point	Mandatory test point
240	J5	Test point	Mandatory test point
241	J6	Test point	Mandatory test point
242	J7	Test point	Mandatory test point
243	J8	Test point	Mandatory test point
244	J9	Test point	Mandatory test point

#### 4.23 Antenna Control

Note: Antenna control signals support is optional.

The AirPrime RC76xx provides four output signals that can be used for host designs that incorporate tunable antennas.

Note: It is the responsibility of developers of host designs to evaluate the performance of tunable antennas that use these signals for neighbor cell measurements, Inter-RAT handovers, etc. Sierra Wireless does not guarantee ANT\_CNTLx signal timing.

Note: These pins can be configured for use as GPIOs using +WIOCFG.

Table 4-28: Antenna Control Signals

Pin	Name	Direction <sup>a</sup>	Function	If Unused
153	ANT_CNTL0	Output		Leave open
154	ANT_CNTL1	Output	Customer-defined external switch control for	Leave open
155	ANT_CNTL2	Output	tunable antennas	Leave open
156	ANT_CNTL3	Output		Leave open

Signal direction with respect to module. Examples: ANT\_CNTL0 (pin 153) is an output from the module to the host.

To tune the antenna:

- 1. Enable band selection, which is required to tune the antennas for specific bands: AT!CUSTOM="BANDSELEN", 1
  - Note that this setting is persistent unless disabled by issuing AT!CUSTOM="BANDSELEN", 0.

#### 4.24 Indication Interfaces

The AirPrime RC76xx provides several indication interfaces that deliver notifications when specific events occur. These interfaces include:

- Tx Activity Indicator (TX\_ON) on page 89
- WWAN\_LED\_N on page 90
- WAKE ON WWAN on page 90
- Ring Indicator on page 91
- SAFE\_PWR\_REMOVE on page 92

### 4.24.1 Tx Activity Indicator (TX\_ON)

The AirPrime RC76xx provides a digital output signal to indicate the occurrence of Tx activity.

Table 4-29: Tx Activity Indicator States

Pin	Signal Name	Direction <sup>a</sup>	I/O Type	Module State	Signal State
60	TX_ON	Output	1.8V	During Tx activity	High
				No Tx	Low

a. Signal direction with respect to module—TX\_ON (pin 60) is an output from the module to the

Table 4-30: Tx Activity Indicator Characteristics

Parameter	Min.	Max.
T <sub>advance</sub>	64.8 ms (LTE) 20 ms (3G) / 150 us (2G)	-
T <sub>delay</sub>	-	33.8 ms(LTE) 800 ms (3G) / 50 us (2G)

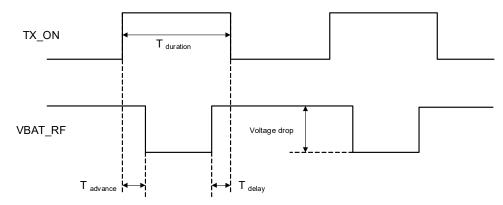


Figure 4-14: TX\_ON State During Transmission

## 4.24.2 WWAN\_LED\_N

The AirPrime RC76xx provides an LED control input signal pad.

Table 4-31: LED Interface Pin

Pin	Signal Name	Direction <sup>a</sup>	Voltage / Current	Function	If Unused
106	WWAN_LED_N	Input	<ul> <li>Voltage (max)=Typical input range: 0.3 to VBAT_BB</li> <li>Maximum current sink capability=40 mA</li> </ul>	LED driver control	Leave open

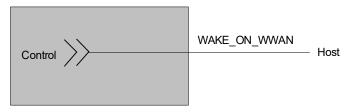
a. Signal direction with respect to module—WWAN\_LED\_N (pin 106) is an input from the host to the module.

# 4.24.3 WAKE\_ON\_WWAN

Note: Host support for WAKE\_ON\_WWAN signal is optional.

The AirPrime RC76xx drives WAKE\_ON\_WWAN high to wake the host when specific events occur.

See Figure 4-15 on page 90 for a recommended implementation.



Embedded Module

Figure 4-15: Recommended WAKE\_ON\_WWAN Connection

Note: Pin status is in internal pull-down when the module boots or resets.

## 4.24.4 Ring Indicator

The ring indicator (UART1\_RI) may be used to notify an external application of several events such as an incoming call, timer expiration, or incoming SMS. The AirPrime RC76xx pulses the signal low when an event occurs. It can be used independently from the UART1 interface.

Table 4-32: Ring Duration Time

Parameter	Time
Pulse width	50 ms

Note: The pulse width duration is based on the current FW setting and can be configured using the AT command: AT+WRID.

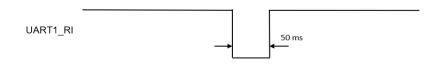


Figure 4-16: UART1\_RI

Table 4-33: UART1\_RI Pin

Pin	Name	Direction <sup>a</sup>	Function	If unused
2	UART1_RI	Output	<ul> <li>Ring Indicator</li> <li>Signal incoming calls (voice and data), SMS, etc.</li> </ul>	Leave open

Signal direction with respect to the module—UART1\_RI (pin 2) is an output from the module to the host.

Important: Do not install an external pull-up on this pin, otherwise the module will not boot.

#### Note:

- Pin status is in internal pull-down when the module boots or resets.
- RI supports events which toggle the RI signal. This pin can be configured using the AT+WWAKESET AT command.

#### 4.24.5 SAFE PWR REMOVE

The SAFE\_PWR\_REMOVE signal is provided by AirPrime RC76xx to indicate to the host device that the main power supply (VBATT) can be safely turned off after a positive pulse.

Table 4-34: SAFE\_PWR\_REMOVE Duration Time

Parameter	Time
Pulse width	13.26 ms
Duration time from the falling edge of SAFE_PWR_REMOVE signal to VGPIO off	

#### Note:

- All host interfaces connected to the module must be disabled (high Z or pull-down) before turning off VBATT. This prevents leakages and bad power on sequences.
- Consider the VGPIO discharge time (depends on the load on the host equipment) before switching off VBATT.



Figure 4-17: SAFE\_PWR\_REMOVE

# 4.25 DR\_SYNC

The AirPrime RC76xx provides DR\_SYNC, an output used for GPS dead reckoning synchronization.

The module pulses the DR\_SYNC signal once every integer GPS second. While position fixes are occurring, the DR\_SYNC pulse is aligned precisely with the GPS time. When a position fix cannot be made (for example, when a vehicle has entered a tunnel), the module continues to pulse the DR\_SYNC signal every second while the level of uncertainty of the GPS time is low. When the uncertainty level is high, the module stops pulsing the signal.

Table 4-35: DR\_SYNC Pin Details

Pin	Signal Name	Direction <sup>a</sup>	Function	If Unused
42	DR_SYNC	Output	GPS dead reckoning sync signal	Leave open

 Signal direction with respect to the module—DR\_SYNC (pin 42) is an output from the module to the host

Note: Pin status is in internal pull-down when the module boots or resets.

# 4.26 W\_DISABLE\_N—Wireless Disable

Note: Host support for wireless disable signals is optional.

The host device uses W\_DISABLE\_N (pin 151) to enable / disable the WWAN or radio modem. When disabled, the modem cannot transmit or receive information.

Letting this signal float high allows the module to operate normally. The pin has an internal pull-up resistor. See Figure 4-18 for a recommended implementation.

When integrating with your host device, keep the following in mind:

- The signal is an input to the module and should be driven LOW only for its active state (controlling the power state); otherwise it should be floating or (High impedance). It should never be driven to a logic high level. The module has an internal pull-up resistor to an internal 1.8V rail, so if the signal is floating or (high impedance), then the radio is on.
- If the host never needs to assert this power state control to the module, leave this signal unconnected from the host interface.

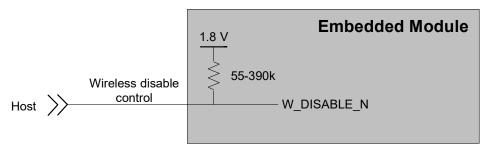


Figure 4-18: Recommended Wireless Disable Connection

# >> 5: Routing Constraints and Recommendations

This section describes general routing constraints and recommendations for the AirPrime RC76xx module.

Note: This is a non-exhaustive list of suggested design guidelines. The developer is responsible for deciding whether to implement these guidelines.

#### 5.1 General Rules and Recommendations

Clock and other high-frequency digital signals (e.g. serial buses) should be routed as far as possible from the module's analog signals.

If the application design makes it possible, all analog signals should be separated from digital signals by a ground trace on the PCB.

**Tip:** Avoid routing any signals under the module on the application board.

# 5.2 Power Supply

When designing the power supply, make sure that VBAT\_BB/VBAT\_RF meet the requirements listed in Power Supply Ratings on page 24.

Careful attention should be paid to the following:

- Power supply noise PFM systems should be avoided; Low ripple, linear regulation or PWM converters are preferred for low noise.
- High switching load capability to deliver high current peaks in a short time (for TDMA frames—RC7620 and RC7620-1 only). For details about the input capacitor, see Power Supply
- Power supply and power tracks design must support peak currents with an acceptable voltage drop that guarantees the minimum required VBATT value.
- Voltage applied on VBATT signal pads must never exceed the voltage range defined in Power Supply Ratings on page 24, otherwise the module's power amplifier and GPS chipset may be severely damaged.
- A weakly-designed (not robust) power supply could affect EMC performance, the radiated spurious emission (RSE), and the phase error and frequency error.

#### 5.3 Antenna

Sierra Wireless strongly recommends working with an antenna manufacturer either to develop an antenna adapted to the application, or to adapt an existing solution to the application. Refer to Table 3-24 on page 46

For information on routing constraints for the RF circuit, see RF Routing Recommendations on page 99.

# **5.3.1 OTA Considerations when Developing Products that Include an Integrated Antenna**

Developing a product with an integrated antenna is challenging considering RF design and performances; difficulty increases with the level of integration. Smaller product size implies:

- The smaller the antenna, the more challenging to reach the expected antenna efficiency.
- Large RF TX signal level radiated by the antenna can be captured by nonlinear devices and create, by rectification, a high level of unwanted harmonics.
- As much as the distance between the antenna and electronic devices (including
  the module and other application related hardware) decreases, coupling to clocks
  and DC/DC switchers harmonics and wide band noise sources generated by high
  speed digital signals increases. Such a coupling may create receiver desensitization from the resulting noise generated at the receiver frequency bands.

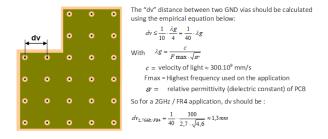
It is essential to take into account appropriate design rules when developing new products and to evaluate OTA performances at an early stage of product integration:

- TRP (Total Radiated Power): To verify the antenna efficiency at TX frequency bands and compliance to spurious emission requirements.
- TIS (Total Isotropic Sensitivity): To verify the antenna efficiency at RX frequency bands and evaluate the presence of noise generated into supported frequency bands subject to cause receiver desensitization.

# 5.4 PCB Layout Recommendations

### 5.4.1 General Design Rules

- Application board should be designed in such a way that provides a plain GND connection on the whole surface located under the module area. A matrix of high density vias should be implemented to connect the top layer (in contact to the module LGA ground pads) to other GND layers. Such implementation aims to reduce noise interference, spurious radiation and improve heat dissipation spreading heat through the PCB surface and layers.
- To reduce coupling between antenna and other signals and improve EMC, the top and bottom layers of the PCB should be covered by solid GND plan as much as possible.
- Good PCB grounding is essential; use ground planes that are as wide as possible and link the different GND planes from each layers using regularly spaced via holes. The maximum recommended distance between two consecutive vias.



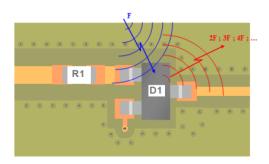
Particularly, via should be present all around the PCB edge to block any unwanted EMI emitted from the internal layers. Usually power planes are not recommended. We recommend a distributed power supply instead.



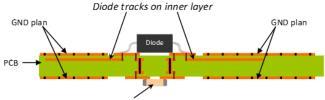
- Sensitive signals should be shielded by routing them into inner layers (to prevent them from radiating) and sensitive components can be shielded. The top and bottom ground plans connected together with vias ensures all sensitive traces are shielded well. This significantly reduces coupling between antenna and other signals and improves EMI and EMC performances.
- When it is not possible to route a signal trace into inner layers, top and bottom layers can be used for short distance connections (i.e. connections between adjacent pads).
- It is good practice during the design phase to anticipate and reserve area for shield cans.
- The module's power supply needs decoupling capacitors to filter out noise to
  prevent it from reaching the module. It could cause instabilities in the RF output in
  the transmitter, resulting in undesired interference and spurious radiations. In the
  receiver, it increases packet error and reduces sensitivity.
- Place a decoupling capacitor (10–33pF is recommended) as close to the power supply pin of the module as possible.
- Use as many vias as possible to build a ground fence around the RF stripline and microstrip line to isolate it from other signals.
- In some specific cases, like impedance controlled lines and RF connection pads and antenna pads, sufficient keep out distance between RF signals and GND should be implemented to prevent impedance mismatch from parasitic capacitance load.

# **5.4.2 Specific Design Rules to Support TRP Performances**

 Prevent neighboring components from being interfered by TX radiated RF energy to prevent them from generating harmonics through non-linear behavior such as saturation or rectification. The mandatory maximum radiated harmonics level for R&TTE/PTCRB certification is below -30dBm and can be very easily failed with inappropriate design.



 When possible, add 10-47pF in parallel of each fast rectifier diode to prevent generating harmonics (due to the TX signal detection).



Add a 22...47pF capacitor in parallel with the diode to avoid harmonics generation

 With an antenna located close to circuitry using active devices, shielding may be needed to reach enough isolation.

# 5.4.3 Specific Design Rules to Support TIS Performance

- High speed digital signal (such as DC/DC converters, system clock, CPU and Memory bus, USB and other high speed interfaces) should be routed on inner layers and located as far as possible from RF signals and antenna.
- Good practice for interferences prevention is to add decoupling capacitors (10–33pF recommended) every 10mm on all top and bottom power lines longer than 10mm.
- With an antenna located close to circuitry using active devices or noisy signals, shielding may be needed to reach enough isolation.

# 5.5 PCB Specifications for the Application Board

Digital and sensitive signals (such as audio, UIM, clocks, high speed interface) should be routed on the inner layers and separated from each other by GND tracks regularly punctured with vias (or microvias). Routing sensitive signals close to noisy signals could result in noise being coupled.

The clocks (SYS\_CLK and SLEEP\_CLK) should use a 50 Ohm controlled impedance trace and the length must be as short as possible.

## 5.6 Recommended PCB Land Pattern

Refer to document [3] AirPrime RC76xx Customer Process Guidelines, available at http://source.sierrawireless.com.

# **5.7 Routing Constraints**

### 5.7.1 Power Supply

If the following design recommendations are not followed, phase error (peak) and power loss could occur.

Note: The recommended output current capability for the power supply on Table 3-3 on page 25 includes margin. The trace widths of the power supplies (VBAT\_BB and VBAT\_RF) should be as wide as possible to minimize voltage drops and reduce electromagnetic interference risks.

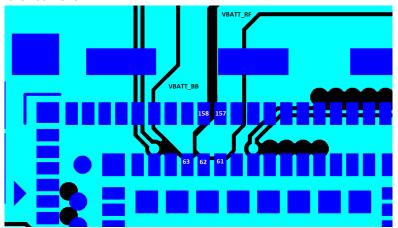


Figure 5-1: Power Supply Routing Example

Note: Figure 5-1 shows separate traces for VBAT\_BB and VBAT\_RF. If VBAT\_BB and VBAT\_RF share a single power supply, these traces should be connected.

Note: For optimal decoupling, place the capacitors on the underside of the board, directly under the pins.

- Input capacitors (2×47 μF) are required close to the module.
- Attention should be paid to the ground trace or the ground plane on the application board for the power supply that supplies the module. The ground trace or ground plane, as well as the VBATT trace, must be able to support current peaks.
- If the ground trace between the module and the power supply is a copper plane, make sure it is a solid plane.
- Design routing to make sure total line impedance does not exceed 10 m $\Omega$  @ 217 Hz.

Note: 2G GSM communications use intermittent burst signals with a period of 4.615 ms (217 Hz)

#### 5.7.1.1 Ground Plane Connection

The AirPrime RC76xx requires a solid, central ground plane (with solder mask defined pads) located directly under the module. This will:

- Ensure high current signal returns
- Provide heat dissipation under higher operating temperatures

The ground plane should be connected (with vias) to the reference ground layer of the application board.

Do not use a separate GND for the antennas. Connections to GND from the AirPrime RC76xx module should be flooded plane using thermal reliefs to ensure reliable solder joints.

#### 5.7.2 UIM Interface

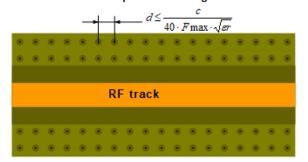
- Tracks between the module and the UIM socket should be as short as possible and routed on inner layers. Maximum recommended length is 10 cm.
- The ESD must be placed near the UIM holder
- ESD protection is mandatory on the UIM lines unless:
  - An external eSIM is being used, or
  - There is no physical access to the UIM.
- The decoupling capacitor(s) should be placed as close as possible to the UIM card connector for the UIM1\_VCC signal.

#### 5.7.3 RF Routing Recommendations

For radiofrequency signals, the following recommendations shall be taken into consideration on PCB layout:

- For each antenna interface (RF\_MAIN, RF\_DIV, RF\_GNSS), the related GND pads should be considered as an integrated part of the radio input/output (refer to Figure 5-4 example). Reference ground of the RF traces shall be a solid integrated plane.
- The use of a CBCPW (Conductor-Backed Coplanar Waveguide) is strongly recommended for lower insertion loss, better impedance matching stability and no additional loss due to the use of vias required by the Stripline structure.
- The CBCPW must be surrounded by GND planes evenly punched by GND vias:

#### Conductor-Backed Coplanar Wavequide:



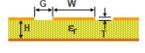


Figure 5-2: Conductor-Backed Coplanar Waveguide (CBCPW) design

- The distance between two adjacent vias should be ≤ the quarter wavelength / 10 of the highest frequency carrier.
- The CBCPW design for RF trace must be used for better isolation, and the coplanar clearance (G, below) from the trace to the ground should be at least the

trace width (W) and at least twice the height (H). This reduces the parasitic capacitance, which potentially alters the trace impedance and increases the losses.

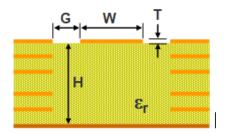


Figure 5-3: Coplanar clearance example

Note: The figure above shows several internal ground layers cut out, which may not be necessary for every application.

 As far as possible and in order to avoid impedance breaks, choose a track width at least equal size of the component pad connected to it.

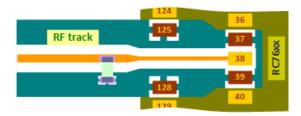


Figure 5-4: Track width and component pad

- Because a part of the RF track is routed under the module, the RF track width shall be slightly reduced before going under the module for considering the metallic mass of the module. Thus, under the module, the structure of the RF line becomes a stripline.
- Anticipate a copper keep-out under the RF pads to reduce stray capacitance losses.

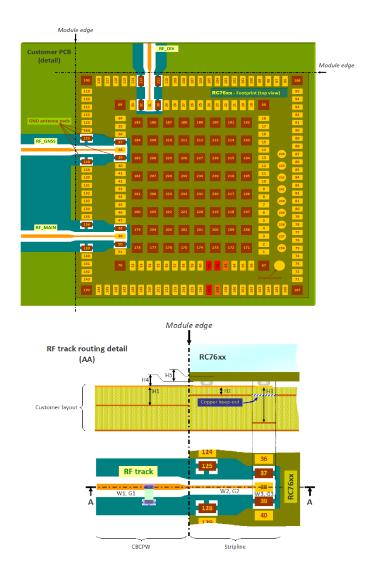


Figure 5-5: RF tracks routing

- All RF traces must be well isolated to other "noise" circuits such as USB, PCle, external XO, DC power supply, etc.
- Edge mount RF connectors are strongly suggested for better impedance matching.



 Different layers routing design with vias transition is not recommended as they will introduce more RF losses. • Do not use right angle RF tracks. A 90° mitered bend is recommended:



Figure 5-6: RF tracks - Example of optimally 90° mitered bend routing

#### 5.7.4 USB Interface

When the USB interface is externally accessible, ESD protection is required on the USB\_VBUS, USB\_D+, and USB\_D- signals.

#### HS-USB guidelines:

- Up to 480 Mbps data rate.
- 90  $\Omega$  differential,  $\pm$  10% trace impedance.
- Differential data pair matching < 3.8 mm (150 mils).</li>
- Other comments and guidelines:
  - · External components should be located near the USB connector.
  - Relatively fast edge rates, so they should be routed away from sensitive circuits and signals (RF, system clock).
  - VBUS trace width must be sized depending on the length of VBUS and the expected current.
  - Loading on the USB DP/DM lines could cause USB receiver sensitivity issues. Perform USB electrical tests (eye diagram and receiver sensitivity) to ensure proper USB functionality.
  - It is not recommended to install series switches on the USB lines.
  - Trace width and trace spacing for DP and DM based on impedance calculator. Avoid discontinuity. The trace width should be equal from source to destination. Keep impedance constant.
  - Avoid having multiple vias. Vias are a source of discontinuity, which can cause signal reflection.
  - Avoid crossing different power plane if possible for USB signals. This caused an unpredictable return path current and cause a signal quality issue.
  - Avoid stubs. A common routing mistake is to create a stub by connecting a component on the DP or DM traces.
  - · Adding test point on the USB trace causes degradation of signal quality.
  - The USB power supplies should have wider traces and not narrow traces, which cause IR drop. This affects the jitter performance of the USB signal.

## 5.8 Thermal Considerations

When transmitting, the AirPrime RC76xx can generate significant amounts of heat (due to the internal Power Amplifier) that must be dissipated in the host device for safety and performance reasons.

The amount of thermal dissipation required depends on the following factors:

- Supply voltage Maximum power dissipation for these modules can be up to 3 W at voltage supply limits.
- Usage Typical power dissipation values depend on the location within the host, amount of data transferred, etc.

To enhance heat dissipation:

- Maximize airflow over / around the module
- Locate the module away from other components that generate heat
- Ensure the module is connected to a solid ground plane

#### 5.9 EMC and ESD Recommendations

EMC tests must be performed on the application as soon as possible to detect any potential problems.

When designing, special attention should be paid to:

- Possible spurious emissions radiated by the application to the RF receiver in the receiver band
- ESD protection Typically, ESD protection is mandatory for externally accessible signals, including:
  - VBAT RF/VBAT BB
  - UIM (if accessible from outside)
  - Serial link
  - USB
  - Antennas
- Length of the UIM interface lines (preferably <10 cm)</li>
- Ground plane: Sierra Wireless recommends a common ground plane for analog/ digital/RF grounds

Note: The AirPrime RC76xx does not include any protection against over-voltage.

The host device must provide adequate ESD protection on digital circuits and antenna ports as detailed in the following table.

Note: The level of protection required depends on your application.

Table 5-1: ESD Specifications<sup>a</sup>

Category	Connection	Specification
Operational	<ul><li>RF ports</li><li>UIM connector</li><li>USB connector</li><li>UART connector</li></ul>	IEC-61000-4-2 - Level (Electrostatic Discharge Immunity Test)  ± 6kV Contact  ± 8kV Air
Non-operational	Host connector interface	<ul> <li>Unless otherwise specified:</li> <li>JESD22-A114 ± 1kV Human Body Model</li> <li>JESD22-A115 ± 100V Machine Model</li> <li>JESD22-C101C ± 500V Charged Device Model</li> </ul>

a. ESD protection is highly recommended at the point where the UIM contacts are exposed, and for any other signals that would be subjected to ESD by the user.

# 5.10 Mechanical Integration

Attention should be paid to:

- Antenna cable integration (bending, length, position, etc)
- Pads of the AirPrime RC76xx to be soldered to the ground plane
- Ensuring proper board layout
- Providing sufficient space around the module for heat dissipation

# 5.11 Signal Reference Schematics

#### 5.11.1 UIM Holder

Figure 5-7 illustrates the recommended implementation of a UIM holder.

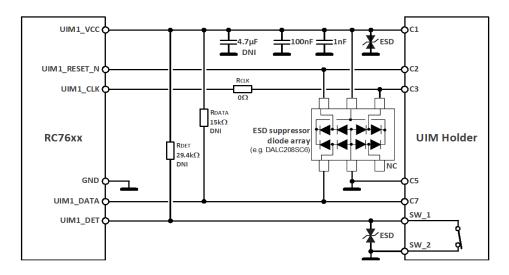


Figure 5-7: Recommended Single UIM Holder Implementation

The UIM1 Detect signal (UIM1\_SIMA\_DET) is used to detect the physical presence of a UIM card in the UIM holder. The signal has a 470 k $\Omega$  pull-up internal to the module. It should be set to GND when a UIM is not present. The UIM Detect signal transitions:

- When a UIM is inserted high (logic 0 to logic 1)
- When a UIM is removed low (logic 1 to logic 0)

The capacitor and the two resistors, RCLK and RDATA, should be added as placeholders to compensate for potential layout issues. UIM1\_DATA trace should be routed away from the UIM1\_CLK trace. Keep the distance between the module and the UIM holder as short as possible.

All signals near the UIM holder must be ESD-protected.

An ESD device specifically designed for UIM cards is recommended for the UIM1 VCC, RESET\_N, CLK, and DATA signals (for example, STMicroelectronics DALC208SC6). For UIM1\_SIMA\_DET a low leakage ESD suppressor should be selected.

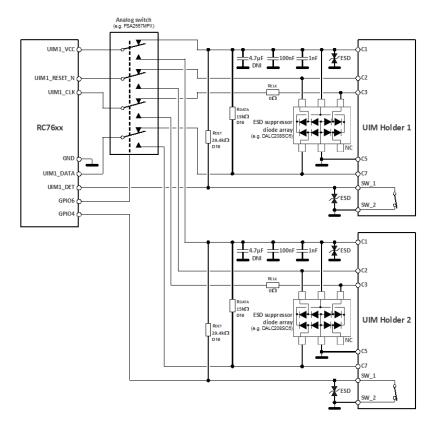


Figure 5-8: External SIM schematic

#### 5.11.2 USB

#### **USB** Interface

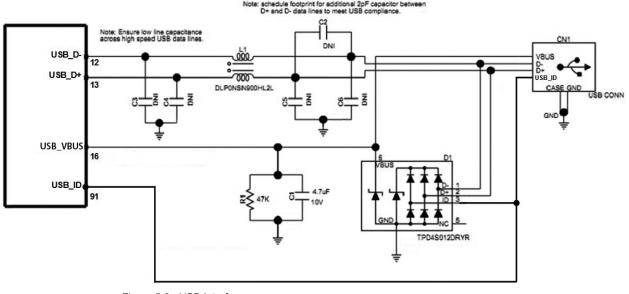


Figure 5-9: USB Interface

# >> 6: Software and Tools

# **6.1 Support Tools**

The AirPrime RC76xx is compatible with Sierra Wireless' SwiLogPlus trace tool that allows users to send error logs to Sierra Wireless.

# 6.2 SED (Smart Error Detection)

The AirPrime RC76xx uses a form of SED to track premature module resets. In such cases, the module automatically forces a pause in boot-and-hold mode at power-on to accept an expected firmware download to resolve the problem.

- 1. Module tracks consecutive resets within 30 seconds of power-on.
- **2.** After a sixth consecutive reset, the module waits in boot-and-hold mode (up to 30 seconds) for a firmware download to resolve the power-cycle problem.

A RAM dump tool that can be used to help isolate the cause of premature resets is available from Sierra Wireless. Contact your Sierra Wireless account representative for assistance.

# 6.3 Firmware Upgrade

Firmware upgrades are downloaded to the embedded module over the USB interface or over the air via Sierra Wireless' AVMS (AirVantage Management System). Contact your Sierra Wireless account representative for assistance.

# 6.4 Operating System Upgrade

The AirPrime RC76xx module's operating system is stored in flash memory and can be easily upgraded.

**Tip:** To follow regular changes in the 3GPP standard and to offer a state-of-the-art operating system, Sierra Wireless recommends that the application designed around an embedded module (or embedded module based product) should allow easy operating system upgrades on the embedded module via the recommended firmware download protocol. Therefore, the application shall either allow a direct access to the embedded module USB interface through an external connector or implement any mechanism allowing the embedded module operating system to be downloaded.

# 6.5 Product Marking

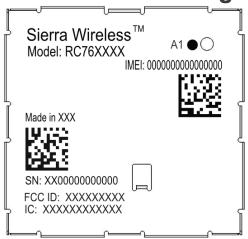


Figure 6-1: Unit Product Marking—Laser-etched, Typical Representation

Note: The figure above is not to scale. Contents will vary by SKU.

The product marking is laser-etched and may contain:

- Product identification (Model name, serial number)
- IMEI or MEID number and barcode
- Fabrication country
- Required regulatory markings (CE logo, Japan approval mark, FCC ID, IC certification number, etc., as appropriate)
- Pin 1 indicator

Note: The AirPrime RC76xx supports OEM partner specific product marking requirements.

# >> 7: Debug and Assembly Considerations

# 7.1 Testing Assistance Provided by Sierra Wireless

Sierra Wireless offers optional professional services based assistance to OEMs with regulatory approvals.

## 7.2 Integration Requirements

When integrating the AirPrime RC76xx, the following items must be addressed:

- Mounting Effect on temperature, shock, and vibration performance
- Power supply Impact on battery drain and possible RF interference
- Antenna location and type Impact on RF performance
- Regulatory approvals As described in Approval on page 118
- Service provisioning Manufacturing process

Sierra Wireless provides guidelines for successful module integration with the document suite and offers integration support services as necessary.

## 7.3 IOT/Operator

Interoperability and Operator/Carrier testing of the finished system is the responsibility of the OEM. The test process will be determined with the chosen network operator(s) and will be dependent upon your business relationship with them, as well as the product's application and sales channel strategy.

Sierra Wireless offers assistance to OEMs with the testing process, if required.

## 7.4 Module Testing Recommendations

When testing your integration design:

- Test to your worst case operating environment conditions (temperature and voltage)
- Test using worst case operation (transmitter on 100% duty cycle, maximum power)
- Monitor the module's junction temperature using AT!PATEMP. This command
  polls a thermistor located near the module's power amplifier (typically the hottest
  spot on the module).

Note: Make sure that your system design provides sufficient cooling for the integrated module. The RF shield temperature should not be exposed to an ambient temperature greater than 85°C to prevent damage to the module's components.

#### 7.5 Serial Link Access

Direct access to the UART1/UART2 serial link is very useful for:

- Testability operations
- Accessing the module's console for debugging

Refer to the following figure for a level shifter implementation that allows UART1 serial link access. (A UART2 level shifter would use the corresponding UART2 pins — UART2\_TX (pin 96), UART2\_RX (pin 97), UART2\_RTS (pin 98), UART2\_CTS (pin 99).)

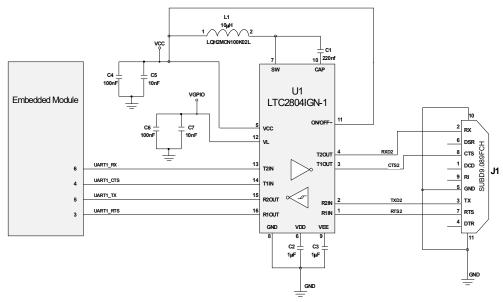


Figure 7-1: Level Shifter Implementation for UART1 Serial Link Access

## 7.6 RF Output Accessibility

During the integration phase of the AirPrime RC76xx, it can be helpful to connect the module to a simulator to check critical RF TX parameters and power behavior for supported RATs.

Although the module has been certified, some parameters may have degraded if some basic precautions have not been followed (poor power supply, for example). This may not affect the functionality of the product, but the product may not comply with 3GPP specifications.

The following TX parameters can be checked using a Radio Communication tester:

- Phase & Frequency Error
- Output Power and Burst Time
- Output Spectrum (Modulation and Switching)

The following are available typical Radio Communication testers:

Rohde & Schwarz: CMU200, CMW500

• Keysight (formerly Agilent): 8960

• Anritsu: MD8475

Because of the high prices associated with Radio Communication testers and the necessary RF know-how to perform simulations, customers can check their applications in the Sierra Wireless laboratories. Contact the Sierra Wireless support team for more information.

# >> 8: Reliability Specification

AirPrime RC76xx modules are tested against the Sierra Wireless Industrial Reliability Specification defined below.

## 8.1 Reliability Compliance

AirPrime RC76xx modules connected on a reliability test board are compliant with the requirements in Table 8-1.

**Table 8-1: Standards Conformity** 

Abbreviation	Definition	
IEC	International Electrotechnical Commission	
ISO	International Organization for Standardization	

# 8.2 Reliability Prediction Model

#### 8.2.1 Life Stress Test

The following tests the AirPrime RC76xx module's product performance.

Table 8-2: Life Stress Test

Designation	Condition
Performance Test	Standard: N/A
PT3T & PTRT	Special conditions:  Temperature: Class A: -30°C to +70°C Class B: -40°C to +85°C Rate of temperature change: 3 ± 0.6°C/min Recovery time: 3 hours
	Operating conditions: Powered
	Duration: 14 days

#### 8.2.2 Environmental Resistance Stress Tests

The following tests the AirPrime RC76xx module's resistance to extreme temperature.

**Table 8-3: Environmental Resistance Stress Tests** 

Designation	Condition	
Cold Test Active	Standard: IEC 680068-2-1, Test ad	
	Special conditions:  Temperature: -40°C  Temperature variation: 1°C/min  Operating conditions: Powered ON with a power cycle of 1 minute ON and 2 minutes OFF	
	Duration: 3 days	
Resistance to Heat Test	Standard: IEC 680068-2-2, Test Bb	
RH	Special conditions:  Temperature: +85°C  Temperature variation: 1°C/min	
	Operating conditions: Powered ON with a power cycle of 15 minutes ON and 15 minutes OFF	
	Duration: 50 days	

#### **8.2.3 Corrosive Resistance Stress Tests**

The following tests the AirPrime RC76xx module's resistance to corrosive atmosphere.

**Table 8-4: Corrosive Resistance Stress Tests** 

Designation	Condition	
Humidity Test	Standard: IEC 60068-2-3, Test Ca	
HUT	Special conditions:  Temperature: +65°C  RH: 95%  Temperature variation: 3 ± 0.6°C/min  Operating conditions: Powered ON with a power cycle of 15 minutes ON and 15 minutes OFF	
	Duration: 10 days	

Table 8-4: Corrosive Resistance Stress Tests (Continued)

Designation	Condition	
Component Solder Wettability CSW	Standard: JESD22-B102, Method 1/Condition C, Solderability Test Method	
NIPHONE SERVER	Special conditions:  • Test method: Dip and Look Test with Steam preconditioning 8 h ± 15 min. Dip for 5 +0/-0.5 seconds	
Tes /	Operating conditions: Unpowered	
	Duration: 1 day	
Moist Heat Cyclic Test	Standard: IEC 60068-2-30, Test Db	
MHCT	Special conditions:  • Upper temperature: +40 ± 2°C  • Lower temperature: +23 ± 5°C  • RH:  • At upper temperature: 93%  • At lower temperature: 95%  • Number of cycles: 21 (1 cycle/24 hours)  • Temperature variation: 3 ± 0.6°C/min  Operating conditions: Powered ON for 15 minutes during each 3 hours ramp up and 3 hours ramp down (in middle) for every cycle	
	Duration: 21 days	

# 8.2.4 Thermal Resistance Cycle Stress Tests

The following tests the AirPrime RC76xx module's resistance to extreme temperature cycling.

Table 8-5: Thermal Resistance Cycle Stress Tests

Designation	Condition	
Thermal Shock Test	Standard: IEC 60068-2-14, Test Na	
Toki	Special conditions:	
	Temperature: -30°C to +80°C	
	Temperature variation: 6–30 s	
	Number of cycles: 600	
	Dwell time: 10 minutes	
	Operating conditions: Unpowered	
	Duration: 9 days	

Table 8-5: Thermal Resistance Cycle Stress Tests (Continued)

Designation	Condition
Temperature Change	Standard: IEC 60068-2-14, Test Nb
Temperature Change TCH	Special conditions: Temperature: -40°C to +90°C Temperature variation: 3 ± 0.6°C/min Number of cycles: 400 Dwell time: 10 minutes  Operating conditions: Unpowered
	Duration: 29 days

### 8.2.5 Mechanical Resistance Stress Tests

The following tests the AirPrime RC76xx module's resistance to vibrations and mechanical shocks.

Table 8-6: Mechanical Resistance Stress Tests

Designation	Condition	
Sinusoidal Vibration Test SVT	Standard: IEC 60068-2-6, Test Fc	
	<ul> <li>Special conditions:</li> <li>Frequency range: 16 Hz to 1000 Hz</li> <li>Displacement: 0.35 mm (peak–peak)</li> <li>Acceleration: <ul> <li>5 g from 16 to 62 Hz</li> <li>3 g from 62 to 200 Hz</li> <li>1 g from 200 to 1000 Hz</li> </ul> </li> <li>Sweep rate: 1 octave/minute</li> <li>Number of sweeps: 20 sweeps/axis</li> <li>Sweep direction: ± X, ± Y, ± Z</li> </ul> <li>Operating conditions: Unpowered</li> Duration: 2 days	

Table 8-6: Mechanical Resistance Stress Tests (Continued)

Designation	Condition	
Random Vibration Test	Standard: IEC 60068-2-64, Test Fh	
RVT	<ul> <li>Special conditions:</li> <li>Frequency range: 10 Hz to 2000 Hz</li> <li>Power Spectral Density in [(m/s²)²/Hz]</li> <li>0.1 g²/Hz at 10 Hz</li> <li>0.01 g²/Hz at 250 Hz</li> <li>0.005 g²/Hz at 1000 Hz</li> <li>0.005 g²/Hz at 2000 Hz</li> <li>Peak factor: 3</li> <li>Duration per axis: 1 hr/axis</li> </ul>	
	Operating conditions: Unpowered	
	Duration: 1 day	
Mechanical Shock Test MST	Standard: IEC 60068-2-27, Test Ea  Special conditions:  Shock Test 1:  Wave form: Half sine  Peak acceleration: 30 g  Duration: 11 ms  Number of shocks: 8  Direction: ± X, ± Y, ± Z  Shock Test 2:  Wave form: Half sine  Peak acceleration: 100 g  Duration: 6 ms  Number of shocks: 3  Direction: ± X, ± Y, ± Z	
	Operating conditions: Unpowered	
	Duration: 72 hours	

# 8.2.6 Handling Resistance Stress Tests

The following tests the AirPrime RC76xx module's resistance to handling malfunctions and damage.

**Table 8-7: Handling Resistance Stress Tests** 

Designation	Condition	
ESDC Test	Standard: JESD22-A114, JESD22-A115, JESD22-C101	
	Special conditions:  HBM (Human Body Model): 1 KV (Class 1C)  MM (Machine Model): 100 V  CDM (Charged Device Model): 500 V (Class IV)	
	Operating conditions: Powered	
	Duration: 3 days	
Free Fall Test	Standard: IEC 60068-2-32, Test Ed	
FFT 1	Special conditions:  Number of drops: 2 drops per unit Height: 1 m	
	Operating conditions: Unpowered	
	Duration: 6 hours	

# >> 9: Approval

## 9.1 Disposing of the Product

This electronic product is subject to the EU Directive 2012/19/EU for Waste Electrical and Electronic Equipment (WEEE). As such, this product must not be disposed of at a municipal waste collection point. Please refer to local regulations for directions on how to dispose of this product in an environmental friendly manner.

## 9.2 Important Notice

Due to the nature of wireless communications, transmission and reception of data can never be guaranteed. Data may be delayed, corrupted (i.e., have errors) or be totally lost. Although significant delays or losses of data are rare when wireless devices such as the Sierra Wireless modem are used in a normal manner with a well-constructed network, the Sierra Wireless modem should not be used in situations where failure to transmit or receive data could result in damage of any kind to the user or any other party, including but not limited to personal injury, death, or loss of property. Sierra Wireless accepts no responsibility for damages of any kind resulting from delays or errors in data transmitted or received using the Sierra Wireless modem, or for failure of the Sierra Wireless modem to transmit or receive such data.

## 9.3 Safety and Hazards

Do not operate your AirPrime RC76xx embedded module:

- In areas where blasting is in progress
- Where explosive atmospheres may be present including refueling points, fuel depots, and chemical plants
- Near medical equipment, life support equipment, or any equipment which may be susceptible to any form of radio interference.

In such areas, the AirPrime RC76xx **MUST BE IN AIRPLANE MODE OR POWERED OFF**. Otherwise, the module can transmit signals that could interfere with this equipment.

In an aircraft, the AirPrime RC76xx **MUST BE IN AIRPLANE MODE OR POWERED OFF**. Otherwise, the module can transmit signals that could interfere with various onboard systems and may be dangerous to the operation of the aircraft or disrupt the cellular network. Use of a cellular phone in an aircraft is illegal in some jurisdictions. Failure to observe this instruction may lead to suspension or denial of cellular telephone services to the offender, or legal action or both.

Some airlines may permit the use of cellular phones while the aircraft is on the ground and the door is open. The module may be used normally at this time.

# 9.4 Compliance Acceptance and Certification

Final regulatory and operator certification requires regulatory agency testing and approval with the fully integrated UE host device incorporating the AirPrime RC76xx module.

The OEM host device and, in particular, the OEM antenna design and implementation will affect the final product functionality, RF performance, and certification test results.

Note: Tests that require features not supported by the AirPrime RC76xx (as defined by this document) are not supported.

## 9.5 Certification Compliance

# 9.5.1 Important Compliance Information for North American Users

The AirPrime RC7611 and RC7611-1 modules have been granted modular approval for mobile applications. Integrators may use these modules in their final products without additional FCC/IC certification if they meet the following conditions. Otherwise, additional FCC/ICC approvals must be obtained.

- 1. The end product must use the RF trace design approved with the AirPrime RC7611 or RC7611-1 module. The Gerber file of the trace design can be obtained from Sierra Wireless upon request.
- At least 20 cm separation distance between the antenna and the user's body must be maintained at all times.
- 3. To comply with FCC regulations limiting both maximum RF output power and human exposure to RF radiation, the maximum antenna gain including cable loss in a mobile-only exposure condition must not exceed the limits stipulated in Table 9-1.

Table 9-1: Antenna Gain Specifications

LTE Band	Frequency (MHz)	Maximum Antenna Gain (dBi)
2	1850–1910	6
4	1710–1755	6
5	824–849	6
12	699–716	6
13	777–787	6
14	788–798	6
25	1850–1915	6

Table 9-1: Antenna Gain Specifications (Continued)

LTE Band	Frequency (MHz)	Maximum Antenna Gain (dBi)
26	814–849	6
66	1710–1780	6
71	663–698	6

- 4. The AirPrime RC7611 and RC7611-1 may transmit simultaneously with other collocated radio transmitters within a host device, provided the following conditions are met:
  - Each collocated radio transmitter has been certified by FCC/IC for mobile application.
  - At least 20 cm separation distance between the antennas of the collocated transmitters and the user's body must be maintained at all times.
  - The radiated power of a collocated transmitter must not exceed the EIRP limit stipulated in Table 9-2.

**Table 9-2: Collocated Radio Transmitter Specifications** 

Device	Technology	Frequency (MHz)	EIRP Limit (dBm)
	WLAN	2400–2500	25
	VVLAIN	5150–5850	27
Collocated	WiMAX	2300–2400	25
transmitters <sup>a</sup>		2500–2700	25
		3300–3800	25
	ВТ	2400–2500	15

- a. Valid collocated transmitter combinations: WLAN+BT; WiMAX+BT. (WLAN+WiMAX+BT is not permitted.)
- **5.** A label must be affixed to the outside of the end product into which the AirPrime RC7611 or RC7611-1 is incorporated, with a statement similar to the following:

#### This device contains FCC ID: N7NRC76B / IC: 2417C-RC76B

**6.** A user manual with the end product must clearly indicate the operating requirements and conditions that must be observed to ensure compliance with current FCC/IC RF exposure guidelines.

The end product with an embedded RC7611 may also need to pass the FCC Part 15 unintentional emission testing requirements and be properly authorized per FCC Part 15.

Note: If this module is intended for use in a portable device, you are responsible for separate approval to satisfy the SAR requirements of FCC Part 2.1093 and IC RSS-102.

#### 9.5.1.1 Industry Canada Statement

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions:

- (1) this device may not cause interference, and
- (2) this device must accept any interference, including interference that may cause undesired operation of the device.

This module is intended for OEM integrator. The OEM integrator is responsible for the compliance to all the rules that apply to the product into which this certified RF module is integrated. Additional testing and certification may be necessary when multiple modules are used.

This equipment complies with IC RSS-102 radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20 cm between the radiator and your body.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes :

- (1) l'appareil ne doit pas produire de brouillage, et
- (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

L'intégrateur OEM doit être conscient de ne pas fournir des informations à l'utilisateur final quant à la façon d'installer ou de supprimer ce module RF dans le manuel de l'utilisateur du produit final qui intègre ce module. Le manuel de l'utilisateur final doit inclure toutes les informations réglementaires requises et avertissements comme indiqué dans ce manuel.

Cet équipement est conforme aux limites d'exposition aux rayonnements IC établies pour un environnement non contrôlé. Cet équipement doit être installé et utilisé avec un minimum de 20 cm de distance entre la source de rayonnement et votre corps.

#### 9.5.2 Japan Radio and Telecom Approval

The end device embedding the AirPrime RC7630 or RC7630-1 should affix the certification indication on its surface following the recommendations below:

- The diameter of the Japan Approval mark must be 3 mm or bigger.
- The size, font, and color of the Radio Certification Type number is not regulated but should be easily distinguished.

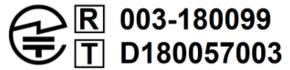


Figure 9-1: Sample Japan Certification Indication

# >> 10: Pinout

The system interface of the AirPrime RC76xx is through the LGA pattern on the bottom of the PCB.

AirPrime RC76xx pins are divided into three functional categories:

- Core functions and associated pins Cover all the mandatory features for M2M connectivity and will be available by default across all CF3 family of modules.
   These Core functions are always available and always at the same physical pin locations. A customer platform using only these functions and associated pins is guaranteed to be forward and/or backward compatible with the next generation of CF3 modules.
- Extension functions and associated pins Bring additional capabilities to the customer. Whenever an Extension function is available on a module, it is always at the same pin location.
- Custom functions and associated pins These are module-specific and make use of specific chipset functions and I/Os.

**Warning:** Custom features should be used with caution as there is no guarantee that the custom functions available on a given module will be available on other CF3 modules.

Pins marked as "Leave open" or "Reserved" should not be used or connected.

## **10.1 Pin Configuration**

Figure 10-1 illustrates the pin configuration of the AirPrime RC76xx module.

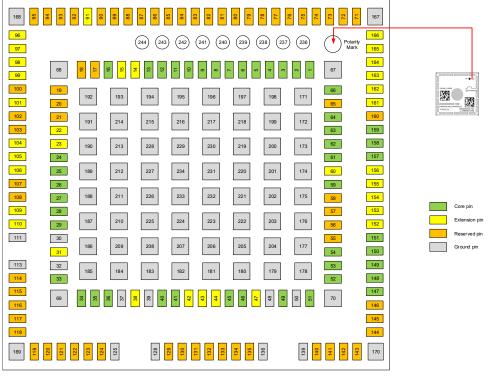


Figure 10-1: Pin Configuration (Top View, Through Module)

# **10.2 Pin Description**

Table 10-1 on page 123 lists detailed information for the LGA pins.

Note: Some pin numbers (112, 126, 127, 137, 138, 235) do not appear in this table because there are no corresponding pads on the module's PCB.

Table 10-1: Pin Definitions

Pin	Signal Name	Group	I/Oª	Voltage	PU/ PD <sup>b</sup>	Active	If Unused	Function	Туре
1	I2C1_CLK	I2C	I/O	1.8V	PU		Leave open	I <sup>2</sup> C clock	Core
2	UART1 RI <sup>c,d</sup>	UART1	0	1.8V		L	Leave open	UART1 Ring indicator	Core
		Note: Do not i	nstall exter	mal pull-up c	n this p	in, otherw	ise the module	will not boot.	
3	UART1_RTS <sup>c</sup>	UART1	I	1.8V		L	Leave open	UART1 Request to send	Core
4	UART1_CTS <sup>c</sup>	UART1	0	1.8V		L	Leave open	UART1 Clear to send	Core
5	UART1_TX <sup>c</sup>	UART1	1	1.8V			Leave open	UART1 Transmit data	Core
6	UART1_RX <sup>c</sup>	UART1	0	1.8V			Leave open	UART1 Receive data	Core
7	UART1_DTR <sup>c,e</sup>	UART1	1	1.8V		L	Leave open	UART1 Data terminal ready	Core
8	UART1_DCD <sup>c,d</sup>	UART1	0	1.8V		L	Leave open	UART1 Data carrier detect	Core
	_	Note: Do not install external pull-up on this pin, otherwise the module will not boot.							
9	UART1 DSR <sup>c,d</sup>	UART1	0	1.8V		L	Leave open	UART1 Data set ready	Core
	_	Note: Do not i	nstall exter	nal pull-up c	n this p	in, otherw	ise the module	will not boot.	
10	GPIO2 <sup>e</sup>	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Core
11	RESET_IN_N	Control signal	1	1.8V	PU	L	Leave open	Input reset signal	Core
12	USB_D-	USB	I/O				Leave open	USB Data negative	Core
13	USB_D+	USB	I/O				Leave open	USB Data positive	Core
14	Reserved	No Connection					See footnote <sup>f</sup>		Extension
15	Reserved	No Connection					See footnote <sup>f</sup>		Extension

Table 10-1: Pin Definitions (Continued)

Pin	Signal Name	Group	I/O <sup>a</sup>	Voltage	PU/ PD <sup>b</sup>	Active	If Unused	Function	Туре
16	USB_VBUS	USB	I	5V or VBAT_BB			Optional connection (If USB interface is required then connect to USB_VBUS or, if unavailable, VBAT_BB; otherwise, leave open.)	USB power supply	Core
17– 20	Reserved	No Connection					See footnote <sup>f</sup>		Extension
21	Reserved	No Connection					See footnote <sup>f</sup>		Extension
22	SYS_CLK	Clock	0	1.8V			Leave open	19.2 MHz digital clock output	Extension
23	SLEEP_CLK	Clock	0	1.8V			Leave open	32.768 kHz digital clock output	Extension
24	ADC1	ADC	Al	0.1V - 1.7V			Leave open	Analog to digital conversion	Core
25	ADC0	ADC	Al	0.1V - 1.7V			Leave open	Analog to digital conversion	Core
26	UIM1_VCC	UIM1	Power Output	1.8V / 2.85V			Mandatory connection	1.8V / 2.85V UIM1 Power supply	Core
27	UIM1_CLK	UIM1	0	1.8V / 2.85V			Mandatory connection	UIM1 Clock	Core
28	UIM1_DATA	UIM1	I/O	1.8V / 2.85V			Mandatory connection	UIM1 Data	Core
29	UIM1_RESET_N	UIM1	0	1.8V / 2.85V		L	Mandatory connection	UIM1 Reset	Core
30	GND	Ground	0V	0V			Mandatory connection	Diversity antenna ground	Extension
31	RF_DIV	RF	Al				Mandatory connection	Diversity antenna	Extension
32	GND	Ground	0V	0V			Mandatory connection	Diversity antenna ground	Extension
22	PCM_OUT	PCM	0	1.8V			Leave open	PCM data out	Coro
33	I2S_OUT	I2S	0	1.8V			Leave open	I2S data out	Core
34	PCM_IN	PCM	1	1.8V			Leave open	PCM data in	Coro
34	12S_IN	I2S	1	1.8V			Leave open	I2S data in	Core
35	PCM_SYNC	PCM	0	1.8V			Leave open	PCM sync	Core
	I2S_WS	I2S	0	1.8V			Leave open	I2S word select	33.3

Table 10-1: Pin Definitions (Continued)

Pin	Signal Name	Group	I/O <sup>a</sup>	Voltage	PU/ PD <sup>b</sup>	Active	If Unused	Function	Туре
36	PCM_CLK	PCM	0	1.8V			Leave open	PCM clock	Core
30	I2S_CLK	12S	0	1.8V			Leave open	I2S clock	Core
37	GND	Ground	0V	0V			Mandatory connection	GNSS antenna ground	Core
38	RF_GNSS	RF	Al				Leave open	RF GNSS input	Extension
39	GND	Ground	0V	0V			Mandatory connection	GNSS antenna ground	Core
40	GPIO7	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Core
41	GPIO8	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Core
42	DR_SYNC	GPS	0	1.8V			Leave open	GPS dead reckoning sync	Extension
43	EXT_GPS_LNA_EN	GPS	0	1.8V		Н	Leave open	External GNSS LNA enable	Extension
44	GPIO13	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Extension
45	VGPIO	Voltage reference	Power Output	1.8V			Leave open	GPIO voltage output	Core
	Ext_SIM_switch <sup>f</sup>	UIM1	I	1.8V	PD		Leave open	External SIM switch	Core
46	GPIO6	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Core
	RESET_OUT_N	Control Signal	0	1.8V	PD		Leave open	Reset output signal	Core
47	TP1 (Boot pin)	Control Signal	1	1.8V		L	Mandatory test point	Test point 1  O— Download mode  Open— Normal mode	Extension
48	GND	Ground	0V	0V			Mandatory connection	Main antenna ground	Core
49	RF_MAIN	RF	AI, AO				Mandatory connection	Main RF antenna	Core
50	GND	Ground	0V	0V			Mandatory connection	Main antenna ground	Core
51	SPI1_MRDY	SPI1	0	1.8V			Leave open	SPI Master Ready	Core
52	SPI1_MISO	SPI1	1	1.8V			Leave open	SPI Master Input/Slave Output (output from slave)	Core

Table 10-1: Pin Definitions (Continued)

Pin	Signal Name	Group	I/O <sup>a</sup>	Voltage	PU/ PD <sup>b</sup>	Active	If Unused	Function	Type
53	SPI1_CLK	SPI1	0	1.8V			Leave open	SPI serial clock (output from Master)	Core
54	SPI1_MOSI	SPI1	0	1.8V			Leave open	SPI Master Output/Slave Input (output from master)	Core
55	Reserved	No Connection					See footnote <sup>f</sup>		Core
56	Reserved	No Connection					See footnote <sup>f</sup>		Core
57	Reserved	No Connection					See footnote <sup>f</sup>		Core
58	Reserved	No Connection					See footnote <sup>f</sup>		Core
59	POWER_ON_N	Control Signal	1	1.8V	PU	L	Mandatory connection	Power On control signal	Core
60	TX_ON	Indication	0	1.8V		Н	Leave open	Tx activity indicator	Extension
61	VBAT_RF	Power	Power Input	3.4V (min) 3.7V (typ) 4.3V (max)			Mandatory connection	RF power supply (see Power Supply Ratings on page 24)	Core
62	VBAT_RF	Power	Power Input	3.4V (min) 3.7V (typ) 4.3V (max)			Mandatory connection	RF power supply (see Power Supply Ratings on page 24)	Core
63	VBAT_BB	Power	Power Input	3.4V (min) 3.7V (typ) 4.3V (max)			Mandatory connection	Baseband power supply (see Power Supply Ratings on page 24)	Core
64	UIM1_SIMA_DET <sup>g</sup>	UIM1	I	1.8V	PU		Mandatory connection	Detect UIM1 insertion/ removal. (Pin must be open to detect the UIM, or grounded if no UIM is present.)	Core
65	UIM1_SIMB_DET / GPIO4 <sup>h</sup>	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Extension
66	I2C1_Data	I2C	I/O	1.8V	PU		Leave open	I <sup>2</sup> C data	Core
67– 70	GND	Ground	0V	0V			Mandatory connection	Ground	Core
71– 90	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
91	Reserved	No Connection					See footnote <sup>f</sup>		Reserved

Table 10-1: Pin Definitions (Continued)

Pin	Signal Name	Group	I/O <sup>a</sup>	Voltage	PU/ PD <sup>b</sup>	Active	If Unused	Function	Туре
92	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
93	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
94	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
95	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
96	UART2_TX <sup>c</sup>	UART2	1	1.8V			Leave open	UART2 Transmit data	Extension
97	UART2_RX <sup>c</sup>	UART2	0	1.8V			Leave open	UART2 Receive data	Extension
98	UART2_RTS <sup>c</sup>	UART2	I	1.8V			Leave open	UART2 Request To Send	Extension
99	UART2_CTS <sup>c</sup>	UART2	0	1.8V			Leave open	UART2 Clear To Send	Extension
100	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
101	GPIO35	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Extension
102	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
103	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
104	GPIO32	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Extension
105	GPIO33	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Extension
106	WWAN_LED_N	Indication	1	VBAT_BB <sup>j</sup>		L	Leave open		Extension
107	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
108	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
109	GPIO42 <sup>e</sup>	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Extension
110	WAKE_ON_WWAN	Indication	0	1.8V		Н	Leave open	Driven high to wake the host when specific events occur.	Extension
111	GND	Ground	0V	0V			Mandatory connection	Diversity antenna ground	Core
113	GND	Ground	0V	0V			Mandatory connection	Diversity antenna ground	Core
114– 124	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
125	GND	Ground	0V	0V			Mandatory connection	GNSS antenna ground	Core

Table 10-1: Pin Definitions (Continued)

Pin	Signal Name	Group	I/O <sup>a</sup>	Voltage	PU/ PD <sup>b</sup>	Active	If Unused	Function	Туре
128	GND	Ground	0V	0V			Mandatory connection	GNSS antenna ground	Core
129– 135	Reserved	No Connection					See footnote <sup>f</sup> .		Reserved
136	GND	Ground	0V	0V			Mandatory connection	Main antenna ground	Core
139	GND	Ground	0V	0V			Mandatory connection	Main antenna ground	Core
140– 146	Reserved	No Connection					See footnote <sup>f</sup> .		Reserved
147	GPIO21 <sup>e</sup>	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Core
148	GPIO22	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Core
149	GPIO23	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Core
150	GPIO24	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Core
151	W_DISABLE_N	Control Signal	1	1.8V		L	Leave open	Wireless disable (main RF radio)	Core
152	SAFE_PWR_REMOVE	Indication	0	1.8V		Н	Leave open	Indicate to host that Main DC power can be removed	Extension
153	ANT_CNTL0	Antenna control	0	1.8V			Leave open		Extension
155	GPIO28 <sup>k</sup>	GPIO	I/O	1.8V			Leave open	General purpose I/O	Extension
454	ANT_CNTL1	Antenna control	0	1.8V			Leave open		Extension
154	GPIO29 <sup>k</sup>	GPIO	I/O	1.8V			Leave open	General purpose I/O	Extension
455	ANT_CNTL2	Antenna control	0	1.8V			Leave open		Extension
155	GPIO30 <sup>k</sup>	GPIO	I/O	1.8V			Leave open	General purpose I/O	Extension
150	ANT_CNTL3	Antenna control	0	1.8V			Leave open		Extension
156	GPIO31 <sup>k</sup>	GPIO	I/O	1.8V			Leave open	General purpose I/O	Extension
157	VBAT_RF	Power	Power Input	3.4V (min) 3.7V (typ) 4.3V (max)			Optional connection	RF power supply (see Power Supply Ratings on page 24)	Core

Table 10-1: Pin Definitions (Continued)

Pin	Signal Name	Group	I/O <sup>a</sup>	Voltage	PU/ PD <sup>b</sup>	Active	If Unused	Function	Туре
158	VBAT_BB	Power	Power Input	3.4V (min) 3.7V (typ) 4.3V (max)			Optional connection	Baseband power supply (see Power Supply Ratings on page 24)	Core
159	GPIO25	GPIO	I/O	1.8V	PD		Leave open	General purpose I/O	Core
160	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
161	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
162	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
163	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
164	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
165	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
166	Reserved	No Connection					See footnote <sup>f</sup>		Reserved
167– 234	GND	Ground	0V	0V			Mandatory connection	Ground	Core
236	J1 <sup>l</sup>			1.8V		L	Mandatory test point	Test point	Extension
237	J2 <sup>l</sup>			1.8V			Mandatory test point	Test point	Extension
238	13 <sub>l</sub>			1.8V			Mandatory test point	Test point	Extension
239	J4 <sup>l</sup>			1.8V			Mandatory test point	Test point	Extension
240	J5 <sup>l</sup>			1.8V		L	Mandatory test point	Test point	Extension
241	J6 <sup>l</sup>			1.8V			Mandatory test point	Test point	Extension
242	J7 <sup>l</sup>			1.8V			Mandatory test point	Test point	Extension
243	18 <sub>l</sub>			1.8V			Mandatory test point	Test point	Extension
244	J9 <sup>l</sup>			1.8V			Mandatory test point	Test point	Extension

a. Signal direction with respect to the module. Examples: PCM\_OUT (pin 33) is an output from the module to the host; PCM\_IN (pin 34) is an input to the module from the host.

b. NP—No Pull; PD—Pull Down; PU—Pull Up

c. (UART signals only) Signals are named with respect to the host device. For example, UART1\_RX is the signal used by the host to receive data from the module.

d. Do not install external pull-up on this pin, otherwise the module will not boot.

- e. Pin is 'wakeable'. Can be used to trigger the module to wake up from Sleep mode. See Wakeup Interrupt (Sleep State) on page 75 for
- f. Pins are connected internally, but are reserved for future use. Leave them unconnected to ensure compatibility with other Sierra Wireless CF3 modules.

- g. Refer to GPIO6 on page 73 for functional details.

  h. Refer to GPIO4 on page 73 for functional details.

  j. Maximum rating is VBAT\_BB, with maximum current sink capability of 40 mA.

  k. This pin is available for use when configured using AT+WIOCFG.
- I. Accessibility restricted to soldered-down modules. Not available for socket-mounted modules.

Table 10-2: RF Pin Information

Signal name	Pin #	Description
RF_DIV	31	Diversity input
RF_GNSS <sup>a</sup>	38	RF GNSS input
RF_MAIN	49	Main RF port (input/output)

a. Support is SKU-dependent.

Table 10-3: Supply Pin Information

Signal name	Pin #	Description
VBAT_RF	61, 62, 157	RF power supply
VBAT_BB	63, 158	Baseband power supply
USB_VBUS	16	Connected to USB_VBUS (5V) or (if unavailable) VBAT_BB

# >> 11: Customization

Subject to commercial terms, Sierra Wireless can supply custom-configured modems to facilitate a carrier's network and performance requirements. Sierra Wireless also offers a standard configuration for each country.

Custom configurations are entered into a selector spreadsheet that Sierra supplies. A unique part number is assigned to each custom configuration to facilitate customer ordering.

Table 11-1: Customizable Features

Name	Description	Default
Display of IMSI	Display of International Mobile Subscriber Identity via AT+CIMI command	Display enabled
UART baud rate	Default UART speed	115200 bps
UART enabled	Defines whether UART port is enabled by default or not	UART disabled

# >> 12: Testing

## 12.1 Certification Testing

Note: Typically, certification testing of your device with the integrated module is required one time only.

The AirPrime RC76xx module has been certified as described in Compliance Acceptance and Certification on page 119.

When you produce a host device with a Sierra Wireless AirPrime embedded module, you must obtain certifications for the final product from appropriate regulatory bodies in the jurisdictions where it will be distributed.

The following are *some* of the regulatory bodies from which you may require certification — it is your responsibility to make sure that you obtain all necessary certifications for your product from these or other groups:

- FCC (Federal Communications Commission www.fcc.gov)
- GCF (Global Certification Forum www.globalcertificationforum.org) outside of North America
- PTCRB (PCS Type Certification Review Board www.ptcrb.com) in North America

## **12.2 Production Testing**

Note: Production testing typically continues for the life of the product.

Production testing ensures that, for each assembled device, the module is installed correctly (I/O signals are passed between the host and module), and the antenna is connected and performing to specifications (RF tests).

Typical items to test include:

- Host connectivity
- Baseband (host/module connectors)
- RF assembly (Tx and/or Rx, as appropriate)
- Network availability
- · Host/device configuration issues

Note: The number and types of tests to perform are **your** decision—the tests listed in this section are guidelines only. Make sure that the tests you perform exercise functionality to the degree that **your** situation requires.

Use an appropriate test station and use AT commands to control the integrated module.

Note: Your test location must be protected from ESD to avoid interference with the module and antenna(s), assuming that your test computer is in a disassembled state.

Also, consider using an RF shielding box—local government regulations may prohibit unauthorized transmissions.

Note: The tests described in this chapter are done using a Linux O/S (e.g. Ubuntu 12.04).

#### 12.3 Functional Production Test

This section presents a suggested procedure for performing a basic manual functional test on a laboratory bench using an AirPrime RC76xx module and a hardware development kit. When you have become familiar with the testing method, use it to develop your own automated production testing procedures.

#### 12.3.1 Suggested Production Tests

Consider the following tests when you design your production test procedures for devices with the module installed.

- Visual check of the module's connectors and RF assemblies
- Module is operational
- USB connection is functional
- LED is functional
- Power on/off
- · Firmware revision check
- Rx tests on main and auxiliary paths
- Tx test

#### 12.3.2 Production Test Procedure

The following is a suggested test plan — you must decide which tests are appropriate for your product. You may wish to add additional tests that more fully exercise the capabilities of your product.

Using an appropriate test station, and referring to the appropriate AT command references:

- Visually inspect the module for obvious defects (such as tainted or damaged shields) before installing it in the test station.
- **2.** Ensure that the module is powered off (no voltage on VBAT\_BB/VBAT\_RF) before beginning your tests.
- 3. Determine whether any USB devices are currently connected to the computer:
  - a. Open a shell window and enter the command Is /dev/tty/USB\*.
  - **b.** Record the ttyUSB*n* values that are returned; these are the currently connected USB devices. If the command returns "no such file or directory", there are no devices currently connected.
- **4.** Provide power to the module (voltage on VBAT\_BB/VBAT\_RF).

- 5. Test POWER\_ON\_N Turn on the module by driving POWER\_ON\_N low, as shown in Figure 4-1 on page 64.
- **6.** Test USB functionality Check for USB enumeration.

Enter the command Is /dev/tty/USB\* and then record and compare the results with those from Step 3. If there are any new ttyUSBn devices, then the modem has enumerated successfully. (The AT port is usually the *last* new device.)

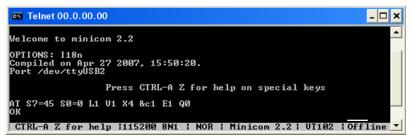
7. Make sure your modem is connected and running, and then establish contact with the module:

Use a terminal emulation/communications program such as minicom to connect over the device handle for AT commands (see listings in Step 6):

a. Start minicom:

- First use of the modem: From the command line, type minicom -s. (The '-s' switch shows the configuration menu.)
- Subsequent uses: From the command line, type minicom. (The '-s' switch is assumed.)

The minicom configuration details appear and the message OK appears when the connection is established.



- 8. Display the firmware version using ATI.
- 9. Unlock the extended AT command set with AT!ENTERCND="<password>".

Note: Use AT! ENTERCND? to check command syntax which is SKU-dependent.

**10.** Test the LED — Visually confirm that the LED turns on and off using:

```
AT!LEDTEST=0,1 (LED on)
AT!LEDTEST=0,0 (LED off)
```

- **11.** Put the module in diagnostic/factory test mode using **AT!DAFTMACT**:
- 12. Communicate with the SIM using AT+CPIN or AT+CIMI.
- 13. Test RF transmission, if desired.
  - For LTE, see LTE RF Transmission Path Test on page 137.
  - For UMTS, see UMTS (WCDMA/GSM) RF Transmission Path Test on page 135
- **14.** Test RF reception, if desired.
  - For LTE, see LTE RF Receive Path Test on page 142.
  - For UMTS, see See UMTS (WCDMA/GSM) RF Receive Path Test on page 140.
- **15.** Test standalone GNSS functionality. See GNSS RF Receive Path Test on page 144.

Note: If the command "minicom" is not found, then use a different program, or download minicom and repeat this step. See Downloading and Configuring minicom for Linux Systems on page 135 for details.

16. Remove power from the module.

# 12.3.2.1 Downloading and Configuring minicom for Linux Systems

Note: This procedure is for Ubuntu systems. If you are using a different Linux distribution, use the appropriate commands for your system to download minicom.

To download and configure minicom in a Ubuntu system:

- 1. Download and install minicom by entering sudo apt-get install minicom.
- 2. When prompted, enter your user password to begin the download and installation. When minicom is installed, the shell prompt appears.
- Configure minicom to communicate with your modem. Start minicom with command minicom -s.
- **4.** Use the down-arrow key to select the **Serial port setup** option.
- Refer to Step 6 on page 134 to identify the device file handle (/dev/ttyUSBn) used for AT commands.
- **6.** Indicate the file handle to use for AT commands Enter A and then replace the serial device string with the AT file handle.
- **7.** Press Enter twice.
- 8. Use the down-arrow key to select Save setup as dfl.
- 9. Select Exit.

Note: To install minicom, you must have root

access, or be included in

the sudoers list.

# 12.4 UMTS (WCDMA/GSM) RF Transmission Path Test

**Important:** As of the publication date of this document, the test procedure described is to be considered preliminary, pending implementation of some commands in a future firmware upgrade.

Note: This procedure is performed in Step 13 of the Production Test Procedure on page 133

The suggested test procedure that follows uses the parameters in the following tables.

Table 12-1: Test Settings—RC7620 UMTS Transmission Path

	Band	Frequency (MHz)	Band ID	Tx Channel <sup>a</sup>
2100 MHz	B1	1950.0	9	9750
900 MHz	B8	897.6	29	2788

a. Channel values shown are at the center of the corresponding bands.

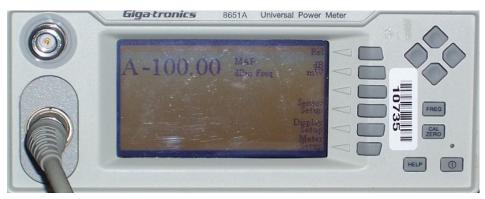
Table 12-2: Test Settings—RC7620 2G Transmission Path

В	and	Frequency (MHz)	Band ID	Tx Channel <sup>a</sup>
900 MHz	E-GSM 900	897.4	10	37
1800 MHz	DCS 1800	1747.8	11	700

a. Channel values shown are at the center of the corresponding bands

Note: This procedure describes steps using the "Power Meter: Gigatronics 8651a (with option 12 and Power Sensor 80701A). To test the DUT's transmitter path:

**1.** Set up the power meter:



- **a.** Make sure the meter has been given sufficient time to warm up, if necessary, to enable it to take accurate measurements.
- **b.** Zero-calibrate the meter.
- c. Enable MAP mode.
- 2. Prepare the DUT using the following AT commands:
  - **a.** AT!ENTERCND="<password>" (Unlock extended AT command set.)
  - **b. AT!DAFTMACT** (Enter test mode.)
  - **c.** AT!DASBAND=<bandValue> (Set frequency band, e.g. 34 for LTE B1.)
  - d. AT!DALSTXBW=3 (Set Tx bandwidth to 10 MHz.)
  - e. AT!DALSRXBW=3 (Set Rx bandwidth to 10 MHz.)
  - f. AT!DASCHAN=<channel> (Set modem channel, e.g. 18300 for LTE B1.)
  - g. AT!DALSTXMOD=0 (Set Tx modulation type to QPSK.)
  - h. AT!DALSWAVEFORM=1,12,0,19 (Set the Tx waveform characteristics. Make sure to set the correct resource block allocation (2nd parameter) appropriately. For example, 12 is used to produce max power—refer to 3GPP 36.521 table for Maximum Power Reduction (MPR) for Power Class 3 for more information.)
  - i. AT!DALSNSVAL=1 (Set the LTE NS (Net Sig) value.)
  - **j. AT!DASTXON** (Turn on the transmitter. Note that the trans- mitter will put out the last power level that was programmed.)
  - **k.** AT!DALSTXPWR=1,10 (Begin transmitting at requested power level.)

- Take the measurement.
- m. Repeat Step k with different power levels if desired.
- n. AT!DALSTXPWR=0,0 (Reduce Tx power to 0, so next time trans- mitter is turned on, it will come on with 0 dBm power.)
- **o.** AT!DASTXOFF (Turn off the transmitter.)
- 3. Test limits—Run ten or more good DUTs through this test procedure to obtain a nominal output power value.
  - Apply a tolerance of  $\pm$  5 to 6 dB to each measurement (assuming a good setup design).
  - Monitor these limits during mass-production ramp-up to determine if further adjustments are needed.

Note: The module has a nominal output power of  $\pm 23$  dBm  $\pm 1$  dB in LTE mode. However, the value measured by the power meter is significantly influenced (beyond the stated  $\pm 1$  dB output power tolerance) by the test setup (host RF cabling loss, antenna efficiency and pattern, test antenna efficiency and pattern, and choice of shield box). When doing the same test over the air in an RF chamber, values are likely to be significantly lower.

#### 12.5 LTE RF Transmission Path Test

**Important:** As of the publication date of this document, the test procedure described is to be considered preliminary, pending implementation of some commands in a future firmware upgrade.

Note: This procedure segment is performed in Step 13 of the Production Test Procedure on page 133.

The suggested test procedure that follows uses the parameters in the following tables.

Table 12-3: Test Settings—RC7611 LTE Transmission Path

Band		Frequency (MHz)	Band ID	Channel <sup>a</sup>
1900 MHz	B2	1880.0	43	18900
1700 MHz	B4	1732.4	42	20175
850 MHz	B5	836.5	45	20525
700 MHz	B12	707.5	50	23095
700 MHz	B13	782.0	36	23230
700 MHz	B14	793.0	51	23330
1900 MHz	B25	1882.5	61	26365
850 MHz	B26	831.5	62	26865

Table 12-3: Test Settings—RC7611 LTE Transmission Path (Continued)

Band		Frequency (MHz)	Band ID	Channel <sup>a</sup>
1700 MHz	B66	1745.0	83	132322
600 MHz	B71	680.5	97	133297

a. Channel value used by the !DASCHAN command (!DASCHAN uses uplink (Tx) channel at the center of the corresponding band, for both Tx and Rx testing)

Table 12-4: Test Settings—RC7620 LTE Transmission Path

Band		Frequency (MHz)	Band ID	Channel <sup>a</sup>
2100 MHz	B1	1950.0	34	18300
1800 MHz	B3	1747.5	44	19575
2600 MHz	B7	2535.0	35	21100
900 MHz	B8	897.5	47	21625
800 MHz	B20	847.0	56	24300
700 MHz	B28	725.5	64	27435

a. Channel value used by the !DASCHAN command (!DASCHAN uses uplink (Tx) channel at the center of the corresponding band, for both Tx and Rx testing.)

To test the DUT's transmitter path:

1. Set up the power meter:

A-100,00 MAP

Sensor

- **a.** Make sure the meter has been given sufficient time to warm up, if necessary, to enable it to take accurate measurements.
- b. Zero-calibrate the meter.
- c. Enable MAP mode.
- **2.** Prepare the DUT using the following AT commands (adjusting the band, channel, bandwidth, modulation, RB allocation, NS, and power level as necessary):
  - **a.** AT!ENTERCND="<password>" (Unlock extended AT command set.)
  - **b.** AT! DAFTMACT (Enter test mode.)

Note: This procedure describes steps using the "Power Meter: Gigatronics 8651A" (with Option 12 and Power Sensor 80701A). c. AT!DASBAND=<bandValue> (Set frequency band (e.g. 34 for LTE B1.))

See table Table 12-3 on page 137 for appropriate <bandValue> values.

d. AT!DALSTXBW=3 (Set Tx bandwidth to 10 MHz.)
e. AT!DALSRXBW=3 (Set Rx bandwidth to 10 MHz.)
f. AT!DASCHAN=<channel> (Set modem channel (e.g. 18300 for LTE B1).)

See tables Table 12-3 on page 137 for appropriate <channel> values.

g. AT!DALSTXMOD=0 (Set Tx modulation type to QPSK.)

h. AT!DALSWAVEFORM=1,12,0,19 (Set the Tx waveform characteristics.

Make sure to set the correct resource block allocation (2nd parameter) appropriately. For example, 12 is used to produce max power — refer to

3GPP 36.521 table for Maximum Power Reduction (MPR) for Power Class 3 for

more information.)

i. AT!DALSNSVAL=1 (Set the LTE NS (Net Sig) value.)

j. AT!DASTXON (Turn on the transmitter. Note that the

transmitter will put out the last power

level that was programmed.)

k. AT!DALSTXPWR=1,10 (Begin transmitting at requested power

level.)

I. Take the measurement.

**m.** Repeat Step k with different power levels if desired.

n. AT!DALSTXPWR=0,0 (Reduce Tx power to 0, so next time

transmitter is turned on, it will come on

with 0 dBm power.)

**o.** AT!DASTXOFF (Turn off the transmitter.)

- 3. Test limits Run ten or more good DUTs through this test procedure to obtain a nominal output power value.
  - Apply a tolerance of  $\pm 5$  to 6 dB to each measurement (assuming a good setup design).
  - Monitor these limits during mass-production ramp-up to determine if further adjustments are needed.

Note: The module has a nominal output power of  $\pm 23$  dBm  $\pm 1$  dB in LTE mode. However, the value measured by the power meter is significantly influenced (beyond the stated  $\pm 1$  dB output power tolerance) by the test setup (host RF cabling loss, antenna efficiency and pattern, test antenna efficiency and pattern, and choice of shield box).

Note: When doing the same test over the air in an RF chamber, values are likely to be significantly lower.

# 12.6 UMTS (WCDMA/GSM) RF Receive Path Test

Note: This procedure segment is performed in Step 14 of the Production Test Procedure on page 133.

The suggested test procedure that follows uses the parameters in the following tables.

Table 12-5: Test Settings—RC7620 UMTS Receive Path

Band		Frequency <sup>a</sup> (MHz)	Band ID	Rx Channel <sup>b</sup>
2100 MHz	B1	2141.2	9	9750
900 MHz	B8	943.8	29	2788

- a. Receive frequencies shown are 1.2 MHz offset from center.
- b. Channel values shown are at the center of the corresponding bands.

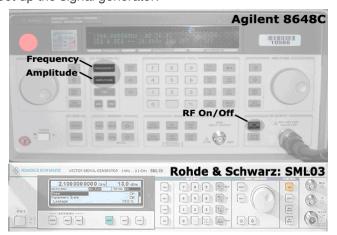
Table 12-6: Test Settings—RC7620 2G Receive Path

Band		Frequency <sup>a</sup> (MHz)	Band ID	Rx Channel <sup>b</sup>
900 MHz	E-GSM 900	942.467	10	37
1800 MHz	DCS 1800	1842.867	11	700

- a. Receive frequencies shown are 67 KHz offset from center.
- b. Channel values shown are at the center of the corresponding bands.

To test the DUT's receive path:

1. Set up the signal generator:



Note: This procedure describes steps using the Agilent 8648C signal generator—the Rohde & Schwarz SML03 is shown for reference only.

- a. Set the amplitude to:
  - -80 dBm (WCDMA mode)
  - · -60 dBm (GSM mode)
- b. Set the frequency for the band being tested. See Table 12-5 and Table 12-6 for frequency values.
- 2. Set up the DUT:
  - a. AT!ENTERCND="<password>" (Unlock extended AT command set.)b. AT!DAFTMACT (Put modem into factory test mode.)
  - c. AT!DASBAND=<band> (Set frequency band.)

See Table 12-5 and Table 12-6 for <band> values

- d. AT!DASCHAN=<channel> (Set modem channel)
  - See Table 12-5 and Table 12-6 for <channel> values
- e. AT!DASLNAGAIN=0 (Set the LNA to maximum gain.)
- **f.** AT!DAWGAVGAGC=9400,0 (WCDMA mode: For PCS1900, channel 9400 as an example.)
- g. GSM mode:
  - i. AT!DAGSRXBURST=0 (Set to receive bursted mode.)
  - ii. AT!DAGGAVGRSSI=190,0 (For channel 190, for example)
- 3. Test limits Run ten or more good DUTs through this test procedure to obtain a nominal received power value.
  - Apply a tolerance of  $\pm 5$  to 6 dB to each measurement (assuming a good setup design).
  - Make sure the measurement is made at a high enough level that it is not influenced by DUT-generated and ambient noise.
  - The Signal Generator power level can be adjusted and new limits found if the radiated test needs greater signal strength.
  - Monitor these limits during mass-production ramp-up to determine if further adjustments are needed.

Note: The value measured from the DUT is significantly influenced by the test setup and DUT design (host RF cabling loss, antenna efficiency and pattern, test antenna efficiency and pattern, and choice of shield box).

- 4. Test diversity paths:
  - a. Set up the signal generator as in Step a.
  - **b.** Set up the DUT:
    - i. AT!ENTERCND="<password>" Unlock extended AT command set.)
    - **ii. AT!DAFTMACT** Put modem into factory test mode.)
    - iii. AT!DASBAND=<band> (Set frequency band.)
      - · See Table 12-5 and Table 12-6for <band> values
    - iv. AT!DAWSSCHAIN=1 (Enable the secondary chain.)
    - v. AT!DASCHAN=<channel>(Set modem channel)
      - See Table 12-5 and Table 12-6 for <channel> values
    - vi. AT!DASLNAGAIN=0 (Set the LNA to maximum gain.)

vii. AT!DAWGAVGAGC=9400,0,1 (The '1' indicates tge diversity path used.)

c. Test the limits as in Step 3.

#### 12.7 LTE RF Receive Path Test

Note: This procedure segment is performed in Step 14 of the Production Test Procedure on page 133.

The suggested test procedure that follows uses the parameters in the following tables

Table 12-7: Test Settings — RC7611 LTE Receive Path

Band		Frequency <sup>a</sup> (MHz)	Band ID	Channel <sup>b</sup>
1900 MHz	B2	1962.00	43	18900
1700 MHz	B4	2134.50	42	20175
850 MHz	B5	883.50	45	20525
700 MHz	B12	739.50	50	23095
780 MHz	B13	753.00	36	23230
700 MHz	B14	763.0	51	23330
1900 MHz	B25	1964.5	61	26365
850 MHz	B26	878.5	62	26865
1700 MHz	B66	2157	83	132322
600 MHz	B71	635.5	97	133297

a. Receive frequencies shown are 2 MHz offset from center

Table 12-8: Test Settings — RC7620 LTE Receive Path

Band		Frequency <sup>a</sup> (MHz)	Band ID	Channel <sup>b</sup>
2100 MHz	B1	2142.00	34	18300
1800 MHz	В3	1844.5	44	19575
2600 MHz	B7	2657.00	35	21100
900 MHz	B8	944.5	47	21625
800 MHz	B20	808.00	56	24300
700 MHz	B28	782.5	64	27435

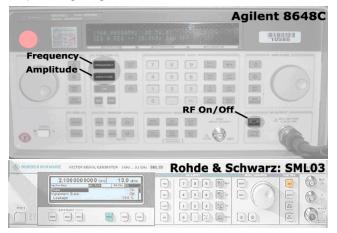
a. Receive frequencies shown are 2 MHz offset from center

b. Channel value used by the !DASCHAN command (!DASCHAN uses uplink (Tx) channel at the center of the corresponding band, for both Tx and Rx testing)

b. Channel values shown are at the center of the corresponding bands.

To test the DUT's receive path (or diversity path, while connected to the diversity antenna):

Note: This procedure describes steps using the Agilent 8648C signal generator—the Rohde & Schwarz SML03 is shown for reference only. **1.** Set up the signal generator:



- a. Set the amplitude to -70 dBm
- **b.** Set the frequency for the band being tested. See Table 12-7 on page 142 for frequency values.
- 2. Set up the DUT:

a. AT!ENTERCND="<password>" (Unlock extended AT command set.)
 b. AT!DAFTMACT (Put modem into factory test mode.)
 c. AT!DASBAND=<band> (Set frequency band.)

See tables Table 12-7 on page 142 for <band> values

d. AT!DALSRXBW=2 (Set Rx LTE bandwidth to 5MHz.)e. AT!DALSTXBW=2 (Set Tx LTE bandwidth to 5MHz.)

f. AT!DASCHAN=<channel> (Set modem channel)

See tables Table 12-7 on page 142 for <channel> values

g. AT!DALGAVGAGC=<channel>,0 (Get averaged Rx AGC)

See tables Table 12-7 on page 142 for <channel> values

- 3. Test limits Run ten or more good DUTs through this test procedure to obtain a nominal received power value.
  - Apply a tolerance of  $\pm 5$  to 6 dB to each measurement (assuming a good setup design).
  - Make sure the measurement is made at a high enough level that it is not influenced by DUT-generated and ambient noise.
  - The Signal Generator power level can be adjusted and new limits found if the radiated test needs greater signal strength.
  - Monitor these limits during mass-production ramp-up to determine if further adjustments are needed.

Note: The value measured from the DUT is significantly influenced by the test setup and DUT design (host RF cabling loss, antenna efficiency and pattern, test antenna efficiency and pattern, and choice of shield box).

#### 12.8 GNSS RF Receive Path Test

The GNSS receive path uses the dedicated GNSS connector.

To test the GNSS receive path:

- 1. Inject a carrier signal at -110dBm, frequency 1575.52 MHz into the GNSS Rx path at the connector. (Note that this frequency is 100 kHz higher than the actual GPS L1 center frequency.)
- 2. Test the signal carrier-to-noise level at the GNSS receiver:

a. AT!ENTERCND="<password>" (Unlock extended AT command set.)
b. AT!DAFTMACT (Put modem into factory test mode.)
c. AT!DACGPSTESTMODE=1 (Start CGPS diagnostic task.)
d. AT!DACGPSSTANDALONE=1 (Enter standalone RF mode.)
e. AT!DACGPSMASKON (Enable log mask.)

**f.** AT!DACGPSCTON (Return signal-to-noise and frequency measurements.)

- **g.** Repeat AT! DACGPSCTON five to ten times to ensure the measurements are repeatable and stable.
- **3.** Leave the RF connection to the embedded module intact, and turn off the signal generator.
- 4. Take several more !DACGPSCTON readings. This will demonstrate a 'bad' signal in order to set limits for testing, if needed. This frequency offset should fall outside of the guidelines in the note below, which indicates that the CtoN result is invalid.
- **5.** (Optional) Turn the signal generator on again, and reduce the level to -120dBm. Take more !DACGPSCTON readings and use these as a reference for what a marginal/poor signal would be.

Note: The response to AT! DACGPSCTON for a good connection should show CtoN within 58 +/-5dB and Freq (frequency offset) within 100000 Hz +/- 5000 Hz.

# >> 13: References

For more details, several references can be consulted, as detailed below.

## 13.1 Web Site Support

Check http://source.sierrawireless.com for the latest documentation available.

### 13.2 Reference Documents

- [1] AirPrime RC76xx AT Command Reference
  - Reference number: 41113566
- [2] AirPrime RC76xx Scalability Guide
  - Reference number: 41113646
- [3] AirPrime RC76xx Customer Process Guidelines
  - Reference number: 41113573
- [4] legato.io for Legato API details
- [5] Inter-Chip USB Supplement to the USB 2.0 Specification Revision 1.0
- [6] I<sup>2</sup>C Bus Specification, Version 5.0, October 2012 Reference: Phillips Semiconductor document number 9398 393 40011

# >> 14: Abbreviations

Table 14-1: Acronyms and Definitions

Acronym or Term	Definition		
3GPP	3rd Generation Partnership Project		
8PSK	Octagonal Phase Shift Keying		
ADC	Analog to Digital Converter		
AF	Audio-Frequency		
API	Application Programming Interface		
AT	Attention (prefix for modem commands)		
BeiDou	BeiDou Navigation Satellite System  A Chinese system that uses a series of satellites in geostationary and middle earth orbits to provide navigational data.		
BER	Bit Error Rate—A measure of receive sensitivity		
BLER	Block Error Rate		
Bluetooth	Wireless protocol for data exchange over short distances		
CEP CEP-##	Circular Error Probability—Measure of GPS horizontal accuracy indicating the radius of a circle around the actual position that contains 50% of GPS measurements.  CEP-##—Radius of circle containing ##% of GPS measurements (e.g. CEP-90 indicates 90% of measurements contained within circle)		
CF3	Common Flexible Form Factor		
CLK	Clock		
CMOS	Complementary Metal Oxide Semiconductor		
CPU	Central Processing Unit		
CQI	Channel Quality Indication		
CS	Circuit-Switched		
	Coding Scheme		
CTS	Clear To Send		
CW	Continuous waveform		
DAC	Digital to Analog Converter		
dB	Decibel = 10 x log <sub>10</sub> (P1/P2)  P1 is calculated power; P2 is reference power  Decibel = 20 x log <sub>10</sub> (V1/V2)  V1 is calculated voltage, V2 is reference voltage		
dBm	A logarithmic (base 10) measure of relative power (dB for decibels); relative to milliwatts (m). A dBm value will be 30 units (1000 times) larger (less negative) than a dBW value, because of the difference in scale (milliwatts vs. watts).		

Table 14-1: Acronyms and Definitions (Continued)

Acronym or Term	Definition
DC	Direct Current
DCD	Data Carrier Detect
DCS	Digital Cellular System A cellular communication infrastructure that uses the 1.8 GHz radio spectrum.
DL	Downlink (network to mobile)
DRX	Discontinuous Reception
DSR	Data Set Ready
DSSS	Dual SIM Single Standby
DTR	Data Terminal Ready
eDRX	Extended Discontinuous Reception
E-GSM	Extended GSM
EDGE	Enhance Data rates for GSM Evolution
EFR	Enhanced Full Rate
EGPRS	Enhance GPRS
EIRP	Effective (or Equivalent) Isotropic Radiated Power
EMC	Electromagnetic Compatibility
EN	Enable
ERP	Effective Radiated Power
ESD	Electrostatic Discharges
eSIM	Embedded SIM
ETSI	European Telecommunications Standards Institute
FCC	Federal Communications Commission  The U.S. federal agency that is responsible for interstate and foreign communications. The FCC regulates commercial and private radio spectrum management, sets rates for communications services, determines standards for equipment, and controls broadcast licensing. Consult www.fcc.gov.
FDD	Frequency Division Duplex
FDMA	Frequency Division Multiple Access
firmware	Software stored in ROM or EEPROM; essential programs that remain even when the system is turned off. Firmware is easier to change than hardware but more permanent than software stored on disk.
FOV	Field Of View
FR	Full Rate

Table 14-1: Acronyms and Definitions (Continued)

Acronym or Term	Definition		
FSN	Factory Serial Number—A unique serial number assigned to the module during manufacturing.		
Galileo	A European system that uses a series of satellites in middle earth orbit to provide navigational data.		
GCF	Global Certification Forum		
GLONASS	Global Navigation Satellite System—A Russian system that uses a series of 24 satellites in middle circular orbit to provide navigational data.		
GMSK	Gaussian Minimum Shift Keying modulation		
GND	Ground		
GNSS	Global Navigation Satellite Systems (GPS, GLONASS, BeiDou, and Galileo)		
GPIO	General Purpose Input Output		
GPRS	General Packet Radio Service		
GPS	Global Positioning System  An American system that uses a series of 24 satellites in middle circular orbit to provide navigational data.		
GSM	Global System for Mobile communications		
Hi Z	High impedance (Z)		
Host	The device into which an embedded module is integrated		
HR	Half Rate		
HSDPA	High Speed Downlink Packet Access		
HSUPA	High Speed Uplink Packet Access		
Hz	Hertz = 1 cycle/second		
I/O	Input/Output		
IC	Industry Canada		
IC	Integrated Circuit		
I-eDRX	Idle mode eDRX		
IMEI	International Mobile Equipment Identity		
IMS	IP Multimedia Subsystem—Architectural framework for delivering IP multimedia services.		
inrush current	Peak current drawn when a device is connected or powered on		
IOT	Interoperability Testing		
IS	Interim Standard. After receiving industry consensus, the TIA forwards the standard to ANSI for approval.		

Table 14-1: Acronyms and Definitions (Continued)

Acronym or Term	Definition
ISIM	IMS Subscriber Identity Module.
LED	Light Emitting Diode. A semiconductor diode that emits visible or infrared light.
LGA	Land Grid Array
LHCP	Left-Hand Circular Polarized
LNA	Low noise Amplifier
LTE	Long Term Evolution—a high-performance air interface for cellular mobile communication systems.
MAX	Maximum
MCS	Modulation and Coding Scheme
MHz	Megahertz = 10e6 Hz
MIC	Microphone
MIMO	Multiple Input Multiple Output—wireless antenna technology that uses multiple antennas at both transmitter and receiver side. This improves performance.
MIN	Minimum
MO	Mobile Originated
MT	Mobile Terminated
N/A	Not Applicable
NMEA	National Marine Electronics Association
NOM	Nominal
OEM	Original Equipment Manufacturer—a company that manufactures a product and sells it to a reseller.
ОТА	Over the Air Technology
PA	Power Amplifier
packet	A short, fixed-length block of data, including a header, that is transmitted as a unit in a communications network.
PBCCH	Packet Broadcast Control Channel
PC	Personal Computer
PCB	Printed Circuit Board
PCL	Power Control Level
PCS	Personal Communication System A cellular communication infrastructure that uses the 1.9 GHz radio spectrum.
PDN	Packet Data Network

Table 14-1: Acronyms and Definitions (Continued)

Acronym or Term	Definition
PFM	Power Frequency Modulation
PLL	Phase Lock Loop
PMIC	Power Management Integrated Circuit
PSM	Power Saving Mode
PSS	Primary synchronization signal
PST	Product Support Tools
PTCRB	PCS Type Certification Review Board
PWM	Pulse Width Modulation
QAM	Quadrature Amplitude Modulation. This form of modulation uses amplitude, frequency, and phase to transfer data on the carrier wave.
QPSK	Quadrature Phase-Shift Keying
R2C	Ready-To-Connect
RAM	Random Access Memory
RAT	Radio Access Technology
RF	Radio Frequency
RHCP	Right Hand Circular Polarization
RI	Ring Indicator
RSE	Radiated Spurious Emissions
RSSI	Received Signal Strength Indication
RST	Reset
RTC	Real Time Clock
RTS	Request To Send
RX	Receive
SCLK	Serial Clock
SED	Smart Error Detection
Sensitivity (Audio)	Measure of lowest power signal that the receiver can measure.
Sensitivity (RF)	Measure of lowest power signal at the receiver input that can provide a prescribed BER/BLER/SNR value at the receiver output.
SIM	Subscriber Identity Module.
SIMO	Single Input Multiple Output—Wireless antenna technology that uses multiple antennas at the receiver side and one antenna at the source (transmitter).

Table 14-1: Acronyms and Definitions (Continued)

Acronym or Term	Definition
SKU	Stock Keeping Unit—identifies an inventory item: a unique code, consisting of numbers or letters and numbers, assigned to a product by a retailer for purposes of identification and inventory control.
SMS	Short Message Service
SNR	Signal-to-Noise Ratio
SPI	Serial Peripheral Interface
SPK	Speaker
SW	Software
TBC	To Be Confirmed
TBD	To Be Determined
TDD	Time Division Duplex
TIA/EIA	Telecommunications Industry Association / Electronics Industry Association. A standards setting trade organization, whose members provide communications and information technology products, systems, distribution services and professional services in the United States and around the world. Consult www.tiaonline.org.
TIS	Total Isotropic Sensitivity
TP	Test Point
TRP	Total Radiated Power
TX	Transmit
TYP	Typical
UART	Universal Asynchronous Receiver-Transmitter
UE	User Equipment
UICC	Universal Integrated Circuit Card
UIM	User Identity Module. Generic term used in this document to refer to UICC, where the application on the UICC (USIM, ISIM, CSIM, etc.) varies depending on the provider of the card.
UL	Uplink (mobile to network)
UMTS	Universal Mobile Telecommunications System
USB	Universal Serial Bus
USB-SS	USB Selective Suspend/USB not enumerated
USIM	Universal Subscriber Identity Module (UMTS)
USSD	Unstructured Supplementary Services Data
UTRA	UMTS Terrestrial Radio Access
VBATT	VBATT is a virtual signal that represents both VBAT_BB and VBAT_RF

Table 14-1: Acronyms and Definitions (Continued)

Acronym or Term	Definition
VBAT_BB	Baseband power supply
VBAT_RF	RF power supply
VCC	Supply voltage
VSWR	Voltage Standing Wave Ratio
WCDMA	Wideband Code Division Multiple Access (also referred to as UMTS)
WLAN	Wireless Local Area Network
WWAN	Wireless Wide Area Network
ZIF	Zero Intermediate Frequency